

# XE164

16-Bit Single-Chip  
Real Time Signal Controller

# 16bit

Microcontrollers



Never stop thinking

**Edition 2008-08**

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# XE164

16-Bit Single-Chip

Real Time Signal Controller

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## **XE164**

### **Revision History: V2.1, 2008-08**

Previous Version(s):

V2.0, 2008-03, Preliminary

V0.1, 2007-09, Preliminary

| <b>Page</b>   | <b>Subjects (major changes since last revision)</b> |
|---------------|---|
| several       | Maximum frequency changed to 80 MHz                 |
| <b>8</b>      | Specification of 6 ADC0 channels corrected          |
| <b>14f</b>    | Missing ADC0 channels added                         |
| <b>28</b>     | Voltage domain for XTAL1/XTAL2 corrected to M       |
| <b>68</b>     | Coupling factors corrected                          |
| <b>73, 75</b> | Improved leakage parameters                         |
| <b>74, 76</b> | Pin leakage formula corrected                       |
| <b>81</b>     | Improved ADC error values                           |
| <b>94f</b>    | Improved definition of external clock parameters    |
| <b>107</b>    | JTAG clock speed corrected                          |

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|          |   |            |
|----------|---|------------|
| <b>1</b> | <b>Summary of Features</b>                        | <b>4</b>   |
| <b>2</b> | <b>General Device Information</b>                 | <b>9</b>   |
| 2.1      | Pin Configuration and Definition                  | 10         |
| <b>3</b> | <b>Functional Description</b>                     | <b>31</b>  |
| 3.1      | Memory Subsystem and Organization                 | 32         |
| 3.2      | External Bus Controller                           | 35         |
| 3.3      | Central Processing Unit (CPU)                     | 36         |
| 3.4      | Interrupt System                                  | 38         |
| 3.5      | On-Chip Debug Support (OCDS)                      | 44         |
| 3.6      | Capture/Compare Unit (CAPCOM2)                    | 45         |
| 3.7      | Capture/Compare Units CCU6x                       | 48         |
| 3.8      | General Purpose Timer (GPT12E) Unit               | 50         |
| 3.9      | Real Time Clock                                   | 54         |
| 3.10     | A/D Converters                                    | 56         |
| 3.11     | Universal Serial Interface Channel Modules (USIC) | 57         |
| 3.12     | MultiCAN Module                                   | 59         |
| 3.13     | Watchdog Timer                                    | 61         |
| 3.14     | Clock Generation                                  | 61         |
| 3.15     | Parallel Ports                                    | 62         |
| 3.16     | Instruction Set Summary                           | 64         |
| <b>4</b> | <b>Electrical Parameters</b>                      | <b>67</b>  |
| 4.1      | General Parameters                                | 67         |
| 4.2      | DC Parameters                                     | 71         |
| 4.2.1    | DC Parameters for Upper Voltage Area              | 73         |
| 4.2.2    | DC Parameters for Lower Voltage Area              | 75         |
| 4.2.3    | Power Consumption                                 | 77         |
| 4.3      | Analog/Digital Converter Parameters               | 81         |
| 4.4      | System Parameters                                 | 84         |
| 4.5      | Flash Memory Parameters                           | 86         |
| 4.6      | AC Parameters                                     | 88         |
| 4.6.1    | Testing Waveforms                                 | 88         |
| 4.6.2    | Definition of Internal Timing                     | 89         |
| 4.6.3    | External Clock Input Parameters                   | 94         |
| 4.6.4    | External Bus Timing                               | 96         |
| 4.6.5    | Synchronous Serial Interface Timing               | 104        |
| 4.6.6    | JTAG Interface Timing                             | 107        |
| <b>5</b> | <b>Package and Reliability</b>                    | <b>109</b> |
| 5.1      | Packaging   | 109        |
| 5.2      | Thermal Considerations                            | 111        |

## **1 Summary of Features**

For a quick overview and easy reference, the features of the XE164 are summarized here.

- High-performance CPU with five-stage pipeline
  - 12.5 ns instruction cycle at 80 MHz CPU clock (single-cycle execution)
  - One-cycle 32-bit addition and subtraction with 40-bit result
  - One-cycle multiplication ( $16 \times 16$  bit)
  - Background division ( $32 / 16$  bit) in 21 cycles
  - One-cycle multiply-and-accumulate (MAC) instructions
  - Enhanced Boolean bit manipulation facilities
  - Zero-cycle jump execution
  - Additional instructions to support HLL and operating systems
  - Register-based design with multiple variable register banks
  - Fast context switching support with two additional local register banks
  - 16 Mbytes total linear address space for code and data
  - 1024 Bytes on-chip special function register area (C166 Family compatible)
- Interrupt system with 16 priority levels for up to 83 sources
  - Selectable external inputs for interrupt generation and wake-up
  - Fastest sample-rate 12.5 ns
- Eight-channel interrupt-driven single-cycle data transfer with Peripheral Event Controller (PEC), 24-bit pointers cover total address space
- Clock generation from internal or external clock sources, using on-chip PLL or prescaler
- On-chip memory modules
  - 1 Kbyte on-chip stand-by RAM (SBRAM)
  - 2 Kbytes on-chip dual-port RAM (DPRAM)
  - Up to 16 Kbytes on-chip data SRAM (DSRAM)
  - Up to 64 Kbytes on-chip program/data SRAM (PSRAM)
  - Up to 768 Kbytes on-chip program memory (Flash memory)
- On-Chip Peripheral Modules
  - Two Synchronizable A/D Converters with up to 16 channels, 10-bit resolution, conversion time below 1  $\mu$ s, optional data preprocessing (data reduction, range check)
  - 16-channel general purpose capture/compare unit (CAPCOM2)
  - Up to three capture/compare units for flexible PWM signal generation (CCU6x)
  - Multi-functional general purpose timer unit with 5 timers

**Summary of Features**

- Up to 6 serial interface channels to be used as UART, LIN, high-speed synchronous channel (SPI/QSPI), IIC bus interface (10-bit addressing, 400 kbit/s), IIS interface
- On-chip MultiCAN interface (Rev. 2.0B active) with up to 128 message objects (Full CAN/Basic CAN) on up to 4 CAN nodes and gateway functionality
- On-chip real time clock
- Up to 12 Mbytes external address space for code and data
  - Programmable external bus characteristics for different address ranges
  - Multiplexed or demultiplexed external address/data buses
  - Selectable address bus width
  - 16-bit or 8-bit data bus width
  - Four programmable chip-select signals
- Single power supply from 3.0 V to 5.5 V
- Programmable watchdog timer and oscillator watchdog
- Up to 75 general purpose I/O lines
- On-chip bootstrap loaders
- Supported by a full range of development tools including C compilers, macro-assembler packages, emulators, evaluation boards, HLL debuggers, simulators, logic analyzer disassemblers, programming boards
- On-chip debug support via JTAG interface
- 100-pin Green LQFP package, 0.5 mm (19.7 mil) pitch

**Ordering Information**

The ordering code for an Infineon microcontroller provides an exact reference to a specific product. This ordering code identifies:

- the derivative itself, i.e. its function set, the temperature range, and the supply voltage
- the package and the type of delivery.

For ordering codes for the XE164 please contact your sales representative or local distributor.

This document describes several derivatives of the XE164 group. **Table 1** lists these derivatives and summarizes the differences. As this document refers to all of these derivatives, some descriptions may not apply to a specific product.

For simplicity the term **XE164** is used for all derivatives throughout this document.

**Summary of Features**

**Table 1 XE164 Derivative Synopsis**

| <b>Derivative<sup>1)</sup></b> | <b>Temp. Range</b> | <b>Program Memory<sup>2)</sup></b> | <b>PSRAM<sup>3)</sup></b> | <b>CCU6 Mod.</b> | <b>ADC<sup>4)</sup> Chan.</b> | <b>Interfaces<sup>4)</sup></b> |
|--------------------------------|--------------------|------------------------------------|---------------------------|------------------|-------------------------------|--------------------------------|
| SAF-XE164F-96FxxL              | -40 °C to 85 °C    | 768 Kbytes Flash                   | 64 Kbytes                 | 0, 1, 2          | 11 + 5                        | 4 CAN Nodes, 6 Serial Chan.    |
| SAF-XE164F-72F66L              | -40 °C to 85 °C    | 576 Kbytes Flash                   | 32 Kbytes                 | 0, 1, 2          | 11 + 5                        | 4 CAN Nodes, 6 Serial Chan.    |
| SAF-XE164F-48F66L              | -40 °C to 85 °C    | 384 Kbytes Flash                   | 16 Kbytes                 | 0, 1, 2          | 11 + 5                        | 4 CAN Nodes, 6 Serial Chan.    |
| SAF-XE164F-24F66L              | -40 °C to 85 °C    | 192 Kbytes Flash                   | 10 Kbytes                 | 0, 1, 2          | 11 + 5                        | 4 CAN Nodes, 6 Serial Chan.    |
| SAF-XE164G-96F66L              | -40 °C to 85 °C    | 768 Kbytes Flash                   | 64 Kbytes                 | 0, 1             | 6 + 5                         | 2 CAN Nodes, 4 Serial Chan.    |
| SAF-XE164G-72F66L              | -40 °C to 85 °C    | 576 Kbytes Flash                   | 32 Kbytes                 | 0, 1             | 6 + 5                         | 2 CAN Nodes, 4 Serial Chan.    |
| SAF-XE164G-48F66L              | -40 °C to 85 °C    | 384 Kbytes Flash                   | 16 Kbytes                 | 0, 1             | 6 + 5                         | 2 CAN Nodes, 4 Serial Chan.    |
| SAF-XE164G-24F66L              | -40 °C to 85 °C    | 192 Kbytes Flash                   | 10 Kbytes                 | 0, 1             | 6 + 5                         | 2 CAN Nodes, 4 Serial Chan.    |
| SAF-XE164H-96F66L              | -40 °C to 85 °C    | 768 Kbytes Flash                   | 64 Kbytes                 | 0, 1, 2          | 11 + 5                        | No CAN Node, 6 Serial Chan.    |
| SAF-XE164H-72F66L              | -40 °C to 85 °C    | 576 Kbytes Flash                   | 32 Kbytes                 | 0, 1, 2          | 11 + 5                        | No CAN Node, 6 Serial Chan.    |
| SAF-XE164H-48F66L              | -40 °C to 85 °C    | 384 Kbytes Flash                   | 16 Kbytes                 | 0, 1, 2          | 11 + 5                        | No CAN Node, 6 Serial Chan.    |
| SAF-XE164H-24F66L              | -40 °C to 85 °C    | 192 Kbytes Flash                   | 10 Kbytes                 | 0, 1, 2          | 11 + 5                        | No CAN Node, 6 Serial Chan.    |
| SAF-XE164K-96F66L              | -40 °C to 85 °C    | 768 Kbytes Flash                   | 64 Kbytes                 | 0, 1             | 6 + 5                         | No CAN Node, 4 Serial Chan.    |
| SAF-XE164K-72F66L              | -40 °C to 85 °C    | 576 Kbytes Flash                   | 32 Kbytes                 | 0, 1             | 6 + 5                         | No CAN Node, 4 Serial Chan.    |
| SAF-XE164K-48F66L              | -40 °C to 85 °C    | 384 Kbytes Flash                   | 16 Kbytes                 | 0, 1             | 6 + 5                         | No CAN Node, 4 Serial Chan.    |
| SAF-XE164K-24F66L              | -40 °C to 85 °C    | 192 Kbytes Flash                   | 10 Kbytes                 | 0, 1             | 6 + 5                         | No CAN Node, 4 Serial Chan.    |

1) This Data Sheet is valid for devices starting with and including design step AC.



## **Summary of Features**

- 2) Specific information about the on-chip Flash memory in [Table 2](#).
- 3) All derivatives additionally provide 1 Kbyte SBRAM, 2 Kbytes DPRAM, and 16 Kbytes DSRAM (12 Kbytes for devices with 192 Kbytes of Flash).
- 4) Specific information about the available channels in [Table 3](#).  
Analog input channels are listed for each Analog/Digital Converter module separately (ADC0 + ADC1).

## Summary of Features

The XE164 types are offered with several Flash memory sizes. [Table 2](#) describes the location of the available memory areas for each Flash memory size.

**Table 2      Flash Memory Allocation**

| Total Flash Size | Flash Area A <sup>1)</sup>                       | Flash Area B                                     | Flash Area C                                     |
|------------------|--|--|--|
| 768 Kbytes       | C0'0000 <sub>H</sub> ...<br>C0'FFFF <sub>H</sub> | C1'0000 <sub>H</sub> ...<br>CB'FFFF <sub>H</sub> | n.a.   |
| 576 Kbytes       | C0'0000 <sub>H</sub> ...<br>C0'FFFF <sub>H</sub> | C1'0000 <sub>H</sub> ...<br>C8'FFFF <sub>H</sub> | n.a.   |
| 384 Kbytes       | C0'0000 <sub>H</sub> ...<br>C0'FFFF <sub>H</sub> | C1'0000 <sub>H</sub> ...<br>C5'FFFF <sub>H</sub> | n.a.   |
| 192 Kbytes       | C0'0000 <sub>H</sub> ...<br>C0'FFFF <sub>H</sub> | C1'0000 <sub>H</sub> ...<br>C1'FFFF <sub>H</sub> | C4'0000 <sub>H</sub> ...<br>C4'FFFF <sub>H</sub> |

1) The uppermost 4-Kbyte sector of the first Flash segment is reserved for internal use (C0'F000<sub>H</sub> to C0'FFFF<sub>H</sub>).

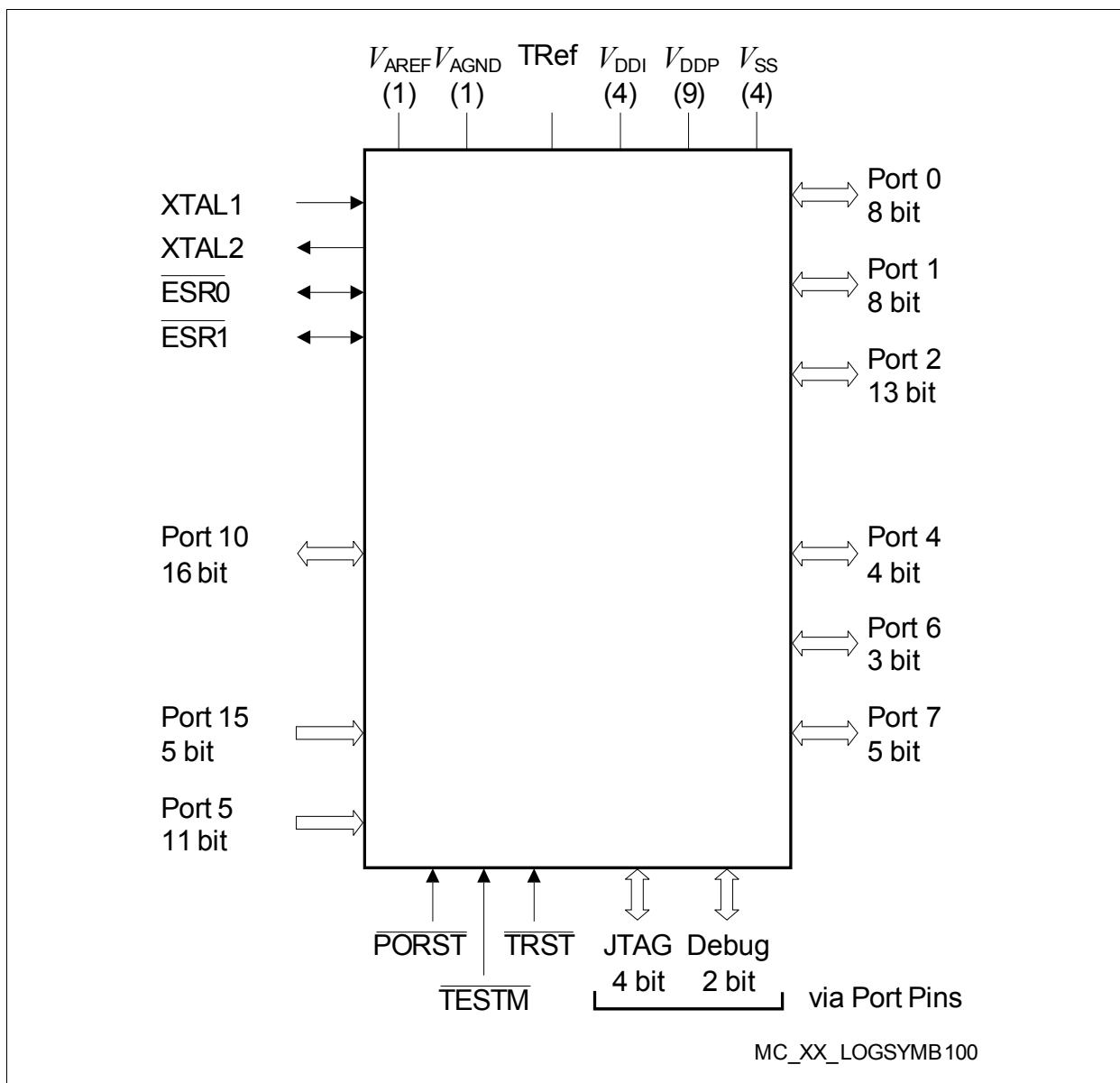
The XE164 types are offered with different interface options. [Table 3](#) lists the available channels for each option.

**Table 3      Interface Channel Association**

| Total Number      | Available Channels                         |
|-------------------|--|
| 11 ADC0 channels  | CH0, CH2 ... CH5, CH8 ... CH11, CH13, CH15 |
| 6 ADC0 channels   | CH0, CH2, CH3, CH4, CH5, CH8               |
| 5 ADC1 channels   | CH0, CH2, CH4, CH5, CH6                    |
| 4 CAN nodes       | CAN0, CAN1, CAN2, CAN3                     |
| 2 CAN nodes       | CAN0, CAN1                                 |
| 6 serial channels | U0C0, U0C1, U1C0, U1C1, U2C0, U2C1         |
| 4 serial channels | U0C0, U0C1, U1C0, U1C1                     |

## 2 General Device Information

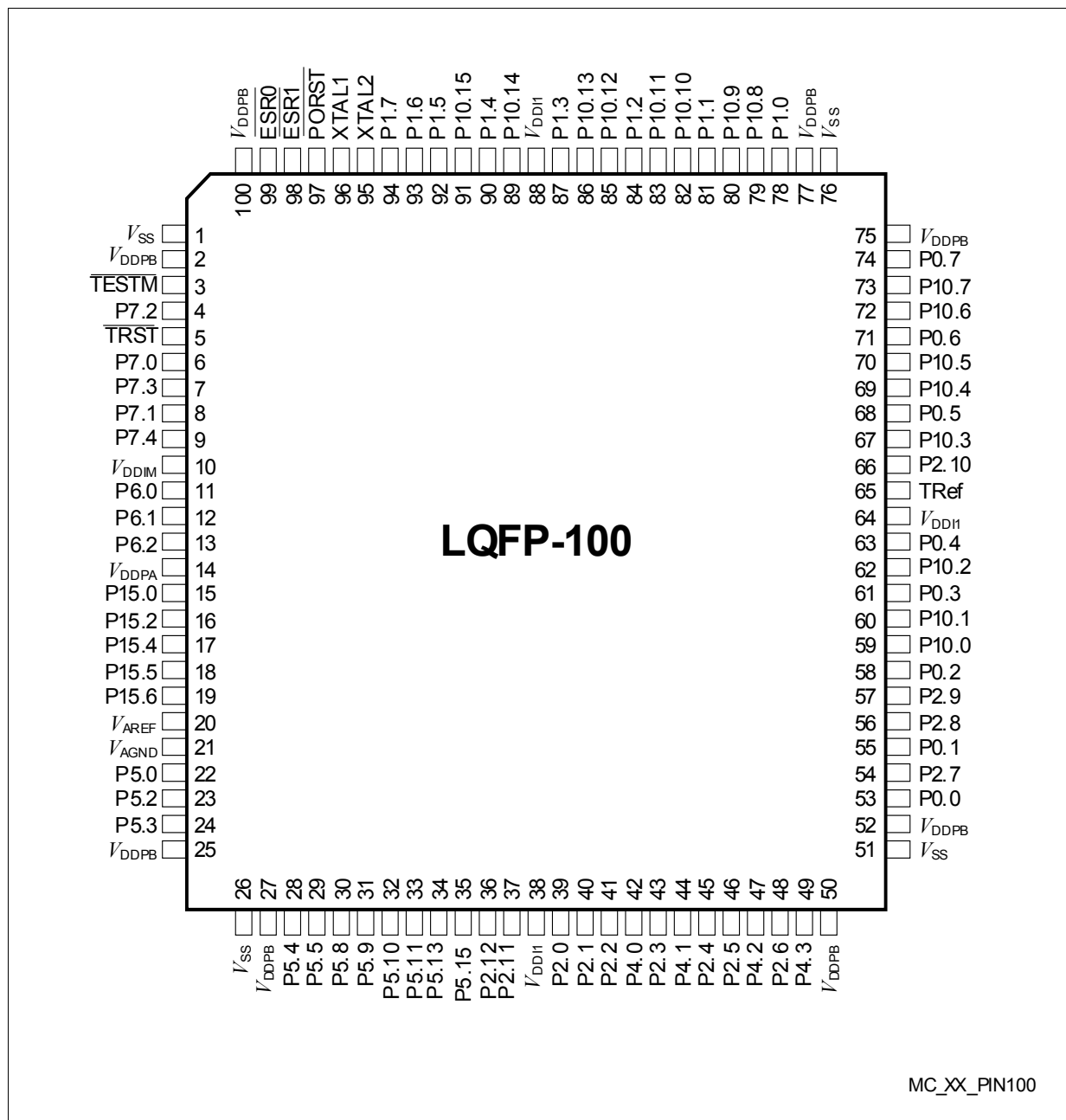
The XE164 series of real time signal controllers is a part of the Infineon XE166 Family of full-feature single-chip CMOS microcontrollers. These devices extend the functionality and performance of the C166 Family in terms of instructions (MAC unit), peripherals, and speed. They combine high CPU performance (up to 80 million instructions per second) with extended peripheral functionality and enhanced IO capabilities. Optimized peripherals can be adapted flexibly to meet the application requirements. These derivatives utilize clock generation via PLL and internal or external clock sources. On-chip memory modules include program Flash, program RAM, and data RAM.



**Figure 1**      **Logic Symbol**

## 2.1 Pin Configuration and Definition

The pins of the XE164 are described in detail in [Table 4](#), which includes all alternate functions. For further explanations please refer to the footnotes at the end of the table. [Figure 2](#) summarizes all pins, showing their locations on the four sides of the package.



**Figure 2** Pin Configuration (top view)

### Notes to Pin Definitions

1. **Ctrl.:** The output signal for a port pin is selected by bitfield PC in the associated register Px\_IOCry. Output O0 is selected by setting the respective bitfield PC to 1x00<sub>B</sub>, output O1 is selected by 1x01<sub>B</sub>, etc.  
Output signal OH is controlled by hardware.
2. **Type:** Indicates the pad type used (St=standard pad, Sp=special pad, DP=double pad, In=input pad, PS=power supply) and its power supply domain (A, B, M, 1).

**Table 4 Pin Definitions and Functions**

| Pin | Symbol                    | Ctrl.  | Type | Function   |
|-----|---------------------------|--------|------|--|
| 3   | $\overline{\text{TESTM}}$ | I      | In/B | <b>Testmode Enable</b><br>Enables factory test modes, must be held HIGH for normal operation (connect to $V_{\text{DDPB}}$ ).<br>An internal pullup device will hold this pin high when nothing is driving it.   |
| 4   | P7.2                      | O0 / I | St/B | <b>Bit 2 of Port 7, General Purpose Input/Output</b>   |
|     | EMUX0                     | O1     | St/B | <b>External Analog MUX Control Output 0 (ADC1)</b>   |
|     | CCU62_<br>CCPOS0A         | I      | St/B | <b>CCU62 Position Input 0</b>  |
|     | TDI_C                     | I      | St/B | <b>JTAG Test Data Input</b>  |
| 5   | $\overline{\text{TRST}}$  | I      | In/B | <b>Test-System Reset Input</b><br>For normal system operation, pin $\overline{\text{TRST}}$ should be held low. A high level at this pin at the rising edge of $\overline{\text{PORST}}$ activates the XE164's debug system. In this case, pin $\overline{\text{TRST}}$ must be driven low once to reset the debug system.<br>An internal pulldown device will hold this pin low when nothing is driving it. |
| 6   | P7.0                      | O0 / I | St/B | <b>Bit 0 of Port 7, General Purpose Input/Output</b>   |
|     | T3OUT                     | O1     | St/B | <b>GPT1 Timer T3 Toggle Latch Output</b>   |
|     | T6OUT                     | O2     | St/B | <b>GPT2 Timer T6 Toggle Latch Output</b>   |
|     | TDO_A                     | OH     | St/B | <b>JTAG Test Data Output</b>   |
|     | ESR2_1                    | I      | St/B | <b>ESR2 Trigger Input 1</b>  |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol                       | Ctrl.  | Type | Function   |
|-----|------------------------------|--------|------|--|
| 7   | P7.3                         | O0 / I | St/B | <b>Bit 3 of Port 7, General Purpose Input/Output</b> |
|     | EMUX1                        | O1     | St/B | <b>External Analog MUX Control Output 1 (ADC1)</b>   |
|     | U0C1_DOUT                    | O2     | St/B | <b>USIC0 Channel 1 Shift Data Output</b>             |
|     | U0C0_DOUT                    | O3     | St/B | <b>USIC0 Channel 0 Shift Data Output</b>             |
|     | CCU62_<br>CCPOS1A            | I      | St/B | <b>CCU62 Position Input 1</b>                        |
|     | TMS_C                        | I      | St/B | <b>JTAG Test Mode Selection Input</b>                |
|     | U0C1_DX0F                    | I      | St/B | <b>USIC0 Channel 1 Shift Data Input</b>              |
| 8   | P7.1                         | O0 / I | St/B | <b>Bit 1 of Port 7, General Purpose Input/Output</b> |
|     | EXTCLK                       | O1     | St/B | <b>Programmable Clock Signal Output</b>              |
|     | CCU62_<br>CTRAPA             | I      | St/B | <b>CCU62 Emergency Trap Input</b>                    |
|     | $\overline{\text{BRKIN\_C}}$ | I      | St/B | <b>OCDS Break Signal Input</b>                       |
| 9   | P7.4                         | O0 / I | St/B | <b>Bit 4 of Port 7, General Purpose Input/Output</b> |
|     | EMUX2                        | O1     | St/B | <b>External Analog MUX Control Output 2 (ADC1)</b>   |
|     | U0C1_DOUT                    | O2     | St/B | <b>USIC0 Channel 1 Shift Data Output</b>             |
|     | U0C1_<br>SCLKOUT             | O3     | St/B | <b>USIC0 Channel 1 Shift Clock Output</b>            |
|     | CCU62_<br>CCPOS2A            | I      | St/B | <b>CCU62 Position Input 2</b>                        |
|     | TCK_C                        | I      | St/B | <b>JTAG Clock Input</b>                              |
|     | U0C0_DX0D                    | I      | St/B | <b>USIC0 Channel 0 Shift Data Input</b>              |
|     | U0C1_DX1E                    | I      | St/B | <b>USIC0 Channel 1 Shift Clock Input</b>             |
| 11  | P6.0                         | O0 / I | St/A | <b>Bit 0 of Port 6, General Purpose Input/Output</b> |
|     | EMUX0                        | O1     | St/A | <b>External Analog MUX Control Output 0 (ADC0)</b>   |
|     | $\overline{\text{BRKOUT}}$   | O3     | St/A | <b>OCDS Break Signal Output</b>                      |
|     | ADCx_<br>REQGTyC             | I      | St/A | <b>External Request Gate Input for ADC0/1</b>        |
|     | U1C1_DX0E                    | I      | St/A | <b>USIC1 Channel 1 Shift Data Input</b>              |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol           | Ctrl.  | Type | Function   |
|-----|------------------|--------|------|--|
| 12  | P6.1             | O0 / I | St/A | <b>Bit 1 of Port 6, General Purpose Input/Output</b> |
|     | EMUX1            | O1     | St/A | <b>External Analog MUX Control Output 1 (ADC0)</b>   |
|     | T3OUT            | O2     | St/A | <b>GPT1 Timer T3 Toggle Latch Output</b>             |
|     | U1C1_DOUT        | O3     | St/A | <b>USIC1 Channel 1 Shift Data Output</b>             |
|     | ADCx_<br>REQTRyC | I      | St/A | <b>External Request Trigger Input for ADC0/1</b>     |
| 13  | P6.2             | O0 / I | St/A | <b>Bit 2 of Port 6, General Purpose Input/Output</b> |
|     | EMUX2            | O1     | St/A | <b>External Analog MUX Control Output 2 (ADC0)</b>   |
|     | T6OUT            | O2     | St/A | <b>GPT2 Timer T6 Toggle Latch Output</b>             |
|     | U1C1_<br>SCLKOUT | O3     | St/A | <b>USIC1 Channel 1 Shift Clock Output</b>            |
|     | U1C1_DX1C        | I      | St/A | <b>USIC1 Channel 1 Shift Clock Input</b>             |
| 15  | P15.0            | I      | In/A | <b>Bit 0 of Port 15, General Purpose Input</b>       |
|     | ADC1_CH0         | I      | In/A | <b>Analog Input Channel 0 for ADC1</b>               |
| 16  | P15.2            | I      | In/A | <b>Bit 2 of Port 15, General Purpose Input</b>       |
|     | ADC1_CH2         | I      | In/A | <b>Analog Input Channel 2 for ADC1</b>               |
|     | T5IN             | I      | In/A | <b>GPT2 Timer T5 Count/Gate Input</b>                |
| 17  | P15.4            | I      | In/A | <b>Bit 4 of Port 15, General Purpose Input</b>       |
|     | ADC1_CH4         | I      | In/A | <b>Analog Input Channel 4 for ADC1</b>               |
|     | T6IN             | I      | In/A | <b>GPT2 Timer T6 Count/Gate Input</b>                |
| 18  | P15.5            | I      | In/A | <b>Bit 5 of Port 15, General Purpose Input</b>       |
|     | ADC1_CH5         | I      | In/A | <b>Analog Input Channel 5 for ADC1</b>               |
|     | T6EUD            | I      | In/A | <b>GPT2 Timer T6 External Up/Down Control Input</b>  |
| 19  | P15.6            | I      | In/A | <b>Bit 6 of Port 15, General Purpose Input</b>       |
|     | ADC1_CH6         | I      | In/A | <b>Analog Input Channel 6 for ADC1</b>               |
| 20  | $V_{AREF}$       | -      | PS/A | <b>Reference Voltage for A/D Converters ADC0/1</b>   |
| 21  | $V_{AGND}$       | -      | PS/A | <b>Reference Ground for A/D Converters ADC0/1</b>    |
| 22  | P5.0             | I      | In/A | <b>Bit 0 of Port 5, General Purpose Input</b>        |
|     | ADC0_CH0         | I      | In/A | <b>Analog Input Channel 0 for ADC0</b>               |

**Table 4 Pin Definitions and Functions (cont'd)**

| <b>Pin</b> | <b>Symbol</b> | <b>Ctrl.</b> | <b>Type</b> | <b>Function</b>                                     |
|------------|---------------|--------------|-------------|---|
| 23         | P5.2          | I            | In/A        | <b>Bit 2 of Port 5, General Purpose Input</b>       |
|            | ADC0_CH2      | I            | In/A        | <b>Analog Input Channel 2 for ADC0</b>              |
|            | TDI_A         | I            | In/A        | <b>JTAG Test Data Input</b>                         |
| 24         | P5.3          | I            | In/A        | <b>Bit 3 of Port 5, General Purpose Input</b>       |
|            | ADC0_CH3      | I            | In/A        | <b>Analog Input Channel 3 for ADC0</b>              |
|            | T3IN          | I            | In/A        | <b>GPT1 Timer T3 Count/Gate Input</b>               |
| 28         | P5.4          | I            | In/A        | <b>Bit 4 of Port 5, General Purpose Input</b>       |
|            | ADC0_CH4      | I            | In/A        | <b>Analog Input Channel 4 for ADC0</b>              |
|            | T3EUD         | I            | In/A        | <b>GPT1 Timer T3 External Up/Down Control Input</b> |
|            | TMS_A         | I            | In/A        | <b>JTAG Test Mode Selection Input</b>               |
| 29         | P5.5          | I            | In/A        | <b>Bit 5 of Port 5, General Purpose Input</b>       |
|            | ADC0_CH5      | I            | In/A        | <b>Analog Input Channel 5 for ADC0</b>              |
|            | CCU60_T12HRB  | I            | In/A        | <b>External Run Control Input for T12 of CCU60</b>  |
| 30         | P5.8          | I            | In/A        | <b>Bit 8 of Port 5, General Purpose Input</b>       |
|            | ADC0_CH8      | I            | In/A        | <b>Analog Input Channel 8 for ADC0</b>              |
|            | CCU6x_T12HRC  | I            | In/A        | <b>External Run Control Input for T12 of CCU6x</b>  |
|            | CCU6x_T13HRC  | I            | In/A        | <b>External Run Control Input for T13 of CCU6x</b>  |
| 31         | P5.9          | I            | In/A        | <b>Bit 9 of Port 5, General Purpose Input</b>       |
|            | ADC0_CH9      | I            | In/A        | <b>Analog Input Channel 9 for ADC0</b>              |
|            | CC2_T7IN      | I            | In/A        | <b>CAPCOM2 Timer T7 Count Input</b>                 |
| 32         | P5.10         | I            | In/A        | <b>Bit 10 of Port 5, General Purpose Input</b>      |
|            | ADC0_CH10     | I            | In/A        | <b>Analog Input Channel 10 for ADC0</b>             |
|            | BRKIN_A       | I            | In/A        | <b>OCDS Break Signal Input</b>                      |
| 33         | P5.11         | I            | In/A        | <b>Bit 11 of Port 5, General Purpose Input</b>      |
|            | ADC0_CH11     | I            | In/A        | <b>Analog Input Channel 11 for ADC0</b>             |
| 34         | P5.13         | I            | In/A        | <b>Bit 13 of Port 5, General Purpose Input</b>      |
|            | ADC0_CH13     | I            | In/A        | <b>Analog Input Channel 13 for ADC0</b>             |
|            | EX0BINB       | I            | In/A        | <b>External Interrupt Trigger Input</b>             |



**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol                             | Ctrl.  | Type | Function  |
|-----|------------------------------------|--------|------|---|
| 35  | P5.15                              | I      | In/A | <b>Bit 15 of Port 5, General Purpose Input</b>  |
|     | ADC0_CH15                          | I      | In/A | <b>Analog Input Channel 15 for ADC0</b>   |
| 36  | P2.12                              | O0 / I | St/B | <b>Bit 12 of Port 2, General Purpose Input/Output</b>   |
|     | U0C0_SELO4                         | O1     | St/B | <b>USIC0 Channel 0 Select/Control 4 Output</b>  |
|     | U0C1_SELO3                         | O2     | St/B | <b>USIC0 Channel 1 Select/Control 3 Output</b>  |
|     | READY                              | I      | St/B | <b>External Bus Interface READY Input</b>   |
| 37  | P2.11                              | O0 / I | St/B | <b>Bit 11 of Port 2, General Purpose Input/Output</b>   |
|     | U0C0_SELO2                         | O1     | St/B | <b>USIC0 Channel 0 Select/Control 2 Output</b>  |
|     | U0C1_SELO2                         | O2     | St/B | <b>USIC0 Channel 1 Select/Control 2 Output</b>  |
|     | $\overline{\text{BHE}}/\text{WRH}$ | OH     | St/B | <b>External Bus Interf. High-Byte Control Output</b><br>Can operate either as Byte High Enable ( $\overline{\text{BHE}}$ ) or as Write strobe for High Byte ( $\text{WRH}$ ). |
| 39  | P2.0                               | O0 / I | St/B | <b>Bit 0 of Port 2, General Purpose Input/Output</b>  |
|     | AD13                               | OH / I | St/B | <b>External Bus Interface Address/Data Line 13</b>  |
|     | RxDC0C                             | I      | St/B | <b>CAN Node 0 Receive Data Input</b>  |
| 40  | P2.1                               | O0 / I | St/B | <b>Bit 1 of Port 2, General Purpose Input/Output</b>  |
|     | TxDC0                              | O1     | St/B | <b>CAN Node 0 Transmit Data Output</b>  |
|     | AD14                               | OH / I | St/B | <b>External Bus Interface Address/Data Line 14</b>  |
|     | ESR1_5                             | I      | St/B | <b>ESR1 Trigger Input 5</b>   |
|     | EX0AINA                            | I      | St/B | <b>External Interrupt Trigger Input</b>   |
| 41  | P2.2                               | O0 / I | St/B | <b>Bit 2 of Port 2, General Purpose Input/Output</b>  |
|     | TxDC1                              | O1     | St/B | <b>CAN Node 1 Transmit Data Output</b>  |
|     | AD15                               | OH / I | St/B | <b>External Bus Interface Address/Data Line 15</b>  |
|     | ESR2_5                             | I      | St/B | <b>ESR2 Trigger Input 5</b>   |
|     | EX1AINA                            | I      | St/B | <b>External Interrupt Trigger Input</b>   |
| 42  | P4.0                               | O0 / I | St/B | <b>Bit 0 of Port 4, General Purpose Input/Output</b>  |
|     | CC2_24                             | O3 / I | St/B | <b>CAPCOM2 CC24IO Capture Inp./ Compare Out.</b>  |
|     | $\overline{\text{CS0}}$            | OH     | St/B | <b>External Bus Interface Chip Select 0 Output</b>  |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol       | Ctrl.  | Type | Function   |
|-----|--------------|--------|------|--|
| 43  | P2.3         | O0 / I | St/B | <b>Bit 3 of Port 2, General Purpose Input/Output</b> |
|     | U0C0_DOUT    | O1     | St/B | <b>USIC0 Channel 0 Shift Data Output</b>             |
|     | CC2_16       | O3 / I | St/B | <b>CAPCOM2 CC16IO Capture Inp./ Compare Out.</b>     |
|     | A16          | OH     | St/B | <b>External Bus Interface Address Line 16</b>        |
|     | ESR2_0       | I      | St/B | <b>ESR2 Trigger Input 0</b>                          |
|     | U0C0_DX0E    | I      | St/B | <b>USIC0 Channel 0 Shift Data Input</b>              |
|     | U0C1_DX0D    | I      | St/B | <b>USIC0 Channel 1 Shift Data Input</b>              |
|     | RxDC0A       | I      | St/B | <b>CAN Node 0 Receive Data Input</b>                 |
| 44  | P4.1         | O0 / I | St/B | <b>Bit 1 of Port 4, General Purpose Input/Output</b> |
|     | TxDC2        | O2     | St/B | <b>CAN Node 2 Transmit Data Output</b>               |
|     | CC2_25       | O3 / I | St/B | <b>CAPCOM2 CC25IO Capture Inp./ Compare Out.</b>     |
|     | CS1          | OH     | St/B | <b>External Bus Interface Chip Select 1 Output</b>   |
| 45  | P2.4         | O0 / I | St/B | <b>Bit 4 of Port 2, General Purpose Input/Output</b> |
|     | U0C1_DOUT    | O1     | St/B | <b>USIC0 Channel 1 Shift Data Output</b>             |
|     | TxDC0        | O2     | St/B | <b>CAN Node 0 Transmit Data Output</b>               |
|     | CC2_17       | O3 / I | St/B | <b>CAPCOM2 CC17IO Capture Inp./ Compare Out.</b>     |
|     | A17          | OH     | St/B | <b>External Bus Interface Address Line 17</b>        |
|     | ESR1_0       | I      | St/B | <b>ESR1 Trigger Input 0</b>                          |
|     | U0C0_DX0F    | I      | St/B | <b>USIC0 Channel 0 Shift Data Input</b>              |
|     | RxDC1A       | I      | St/B | <b>CAN Node 1 Receive Data Input</b>                 |
| 46  | P2.5         | O0 / I | St/B | <b>Bit 5 of Port 2, General Purpose Input/Output</b> |
|     | U0C0_SCLKOUT | O1     | St/B | <b>USIC0 Channel 0 Shift Clock Output</b>            |
|     | TxDC0        | O2     | St/B | <b>CAN Node 0 Transmit Data Output</b>               |
|     | CC2_18       | O3 / I | St/B | <b>CAPCOM2 CC18IO Capture Inp./ Compare Out.</b>     |
|     | A18          | OH     | St/B | <b>External Bus Interface Address Line 18</b>        |
|     | U0C0_DX1D    | I      | St/B | <b>USIC0 Channel 0 Shift Clock Input</b>             |

**General Device Information**

**Table 4 Pin Definitions and Functions (cont'd)**

| <b>Pin</b> | <b>Symbol</b>           | <b>Ctrl.</b> | <b>Type</b> | <b>Function</b>                                      |
|------------|-------------------------|--------------|-------------|--|
| 47         | P4.2                    | O0 / I       | St/B        | <b>Bit 2 of Port 4, General Purpose Input/Output</b> |
|            | TxDC2                   | O2           | St/B        | <b>CAN Node 2 Transmit Data Output</b>               |
|            | CC2_26                  | O3 / I       | St/B        | <b>CAPCOM2 CC26IO Capture Inp./ Compare Out.</b>     |
|            | $\overline{\text{CS2}}$ | OH           | St/B        | <b>External Bus Interface Chip Select 2 Output</b>   |
|            | T2IN                    | I            | St/B        | <b>GPT1 Timer T2 Count/Gate Input</b>                |
| 48         | P2.6                    | O0 / I       | St/B        | <b>Bit 6 of Port 2, General Purpose Input/Output</b> |
|            | U0C0_SELO0              | O1           | St/B        | <b>USIC0 Channel 0 Select/Control 0 Output</b>       |
|            | U0C1_SELO1              | O2           | St/B        | <b>USIC0 Channel 1 Select/Control 1 Output</b>       |
|            | CC2_19                  | O3 / I       | St/B        | <b>CAPCOM2 CC19IO Capture Inp./ Compare Out.</b>     |
|            | A19                     | OH           | St/B        | <b>External Bus Interface Address Line 19</b>        |
|            | U0C0_DX2D               | I            | St/B        | <b>USIC0 Channel 0 Shift Control Input</b>           |
|            | RxDC0D                  | I            | St/B        | <b>CAN Node 0 Receive Data Input</b>                 |
| 49         | P4.3                    | O0 / I       | St/B        | <b>Bit 3 of Port 4, General Purpose Input/Output</b> |
|            | CC2_27                  | O3 / I       | St/B        | <b>CAPCOM2 CC27IO Capture Inp./ Compare Out.</b>     |
|            | $\overline{\text{CS3}}$ | OH           | St/B        | <b>External Bus Interface Chip Select 3 Output</b>   |
|            | RxDC2A                  | I            | St/B        | <b>CAN Node 2 Receive Data Input</b>                 |
|            | T2EUD                   | I            | St/B        | <b>GPT1 Timer T2 External Up/Down Control Input</b>  |
| 53         | P0.0                    | O0 / I       | St/B        | <b>Bit 0 of Port 0, General Purpose Input/Output</b> |
|            | U1C0_DOUT               | O1           | St/B        | <b>USIC1 Channel 0 Shift Data Output</b>             |
|            | CCU61_CC60              | O3 / I       | St/B        | <b>CCU61 Channel 0 Input/Output</b>                  |
|            | A0                      | OH           | St/B        | <b>External Bus Interface Address Line 0</b>         |
|            | U1C0_DX0A               | I            | St/B        | <b>USIC1 Channel 0 Shift Data Input</b>              |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol       | Ctrl.  | Type | Function   |
|-----|--------------|--------|------|--|
| 54  | P2.7         | O0 / I | St/B | <b>Bit 7 of Port 2, General Purpose Input/Output</b> |
|     | U0C1_SELO0   | O1     | St/B | <b>USIC0 Channel 1 Select/Control 0 Output</b>       |
|     | U0C0_SELO1   | O2     | St/B | <b>USIC0 Channel 0 Select/Control 1 Output</b>       |
|     | CC2_20       | O3 / I | St/B | <b>CAPCOM2 CC20IO Capture Inp./ Compare Out.</b>     |
|     | A20          | OH     | St/B | <b>External Bus Interface Address Line 20</b>        |
|     | U0C1_DX2C    | I      | St/B | <b>USIC0 Channel 1 Shift Control Input</b>           |
|     | RxDC1C       | I      | St/B | <b>CAN Node 1 Receive Data Input</b>                 |
| 55  | P0.1         | O0 / I | St/B | <b>Bit 1 of Port 0, General Purpose Input/Output</b> |
|     | U1C0_DOUT    | O1     | St/B | <b>USIC1 Channel 0 Shift Data Output</b>             |
|     | TxDC0        | O2     | St/B | <b>CAN Node 0 Transmit Data Output</b>               |
|     | CCU61_CC61   | O3 / I | St/B | <b>CCU61 Channel 1 Input/Output</b>                  |
|     | A1           | OH     | St/B | <b>External Bus Interface Address Line 1</b>         |
|     | U1C0_DX0B    | I      | St/B | <b>USIC1 Channel 0 Shift Data Input</b>              |
|     | U1C0_DX1A    | I      | St/B | <b>USIC1 Channel 0 Shift Clock Input</b>             |
| 56  | P2.8         | O0 / I | DP/B | <b>Bit 8 of Port 2, General Purpose Input/Output</b> |
|     | U0C1_SCLKOUT | O1     | DP/B | <b>USIC0 Channel 1 Shift Clock Output</b>            |
|     | EXTCLK       | O2     | DP/B | <b>Programmable Clock Signal Output</b><br>1)        |
|     | CC2_21       | O3 / I | DP/B | <b>CAPCOM2 CC21IO Capture Inp./ Compare Out.</b>     |
|     | A21          | OH     | DP/B | <b>External Bus Interface Address Line 21</b>        |
|     | U0C1_DX1D    | I      | DP/B | <b>USIC0 Channel 1 Shift Clock Input</b>             |
|     |              |        |      |  |
| 57  | P2.9         | O0 / I | St/B | <b>Bit 9 of Port 2, General Purpose Input/Output</b> |
|     | U0C1_DOUT    | O1     | St/B | <b>USIC0 Channel 1 Shift Data Output</b>             |
|     | TxDC1        | O2     | St/B | <b>CAN Node 1 Transmit Data Output</b>               |
|     | CC2_22       | O3 / I | St/B | <b>CAPCOM2 CC22IO Capture Inp./ Compare Out.</b>     |
|     | A22          | OH     | St/B | <b>External Bus Interface Address Line 22</b>        |
|     | CLKIN1       | I      | St/B | <b>Clock Signal Input</b>                            |
|     | TCK_A        | I      | St/B | <b>JTAG Clock Input</b>                              |

**Table 4 Pin Definitions and Functions (cont'd)**

| <b>Pin</b> | <b>Symbol</b> | <b>Ctrl.</b> | <b>Type</b> | <b>Function</b>                                       |
|------------|---------------|--------------|-------------|---|
| 58         | P0.2          | O0 / I       | St/B        | <b>Bit 2 of Port 0, General Purpose Input/Output</b>  |
|            | U1C0_SCLKOUT  | O1           | St/B        | <b>USIC1 Channel 0 Shift Clock Output</b>             |
|            | TxDC0         | O2           | St/B        | <b>CAN Node 0 Transmit Data Output</b>                |
|            | CCU61_CC62    | O3 / I       | St/B        | <b>CCU61 Channel 2 Input/Output</b>                   |
|            | A2            | OH           | St/B        | <b>External Bus Interface Address Line 2</b>          |
|            | U1C0_DX1B     | I            | St/B        | <b>USIC1 Channel 0 Shift Clock Input</b>              |
| 59         | P10.0         | O0 / I       | St/B        | <b>Bit 0 of Port 10, General Purpose Input/Output</b> |
|            | U0C1_DOUT     | O1           | St/B        | <b>USIC0 Channel 1 Shift Data Output</b>              |
|            | CCU60_CC60    | O2 / I       | St/B        | <b>CCU60 Channel 0 Input/Output</b>                   |
|            | AD0           | OH / I       | St/B        | <b>External Bus Interface Address/Data Line 0</b>     |
|            | ESR1_2        | I            | St/B        | <b>ESR1 Trigger Input 2</b>                           |
|            | U0C0_DX0A     | I            | St/B        | <b>USIC0 Channel 0 Shift Data Input</b>               |
|            | U0C1_DX0A     | I            | St/B        | <b>USIC0 Channel 1 Shift Data Input</b>               |
| 60         | P10.1         | O0 / I       | St/B        | <b>Bit 1 of Port 10, General Purpose Input/Output</b> |
|            | U0C0_DOUT     | O1           | St/B        | <b>USIC0 Channel 0 Shift Data Output</b>              |
|            | CCU60_CC61    | O2 / I       | St/B        | <b>CCU60 Channel 1 Input/Output</b>                   |
|            | AD1           | OH / I       | St/B        | <b>External Bus Interface Address/Data Line 1</b>     |
|            | U0C0_DX0B     | I            | St/B        | <b>USIC0 Channel 0 Shift Data Input</b>               |
|            | U0C0_DX1A     | I            | St/B        | <b>USIC0 Channel 0 Shift Clock Input</b>              |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol       | Ctrl.  | Type | Function  |
|-----|--------------|--------|------|---|
| 61  | P0.3         | O0 / I | St/B | <b>Bit 3 of Port 0, General Purpose Input/Output</b>  |
|     | U1C0_SELO0   | O1     | St/B | <b>USIC1 Channel 0 Select/Control 0 Output</b>        |
|     | U1C1_SELO1   | O2     | St/B | <b>USIC1 Channel 1 Select/Control 1 Output</b>        |
|     | CCU61_COUT60 | O3     | St/B | <b>CCU61 Channel 0 Output</b>                         |
|     | A3           | OH     | St/B | <b>External Bus Interface Address Line 3</b>          |
|     | U1C0_DX2A    | I      | St/B | <b>USIC1 Channel 0 Shift Control Input</b>            |
|     | RxDC0B       | I      | St/B | <b>CAN Node 0 Receive Data Input</b>                  |
| 62  | P10.2        | O0 / I | St/B | <b>Bit 2 of Port 10, General Purpose Input/Output</b> |
|     | U0C0_SCLKOUT | O1     | St/B | <b>USIC0 Channel 0 Shift Clock Output</b>             |
|     | CCU60_CC62   | O2 / I | St/B | <b>CCU60 Channel 2 Input/Output</b>                   |
|     | AD2          | OH / I | St/B | <b>External Bus Interface Address/Data Line 2</b>     |
|     | U0C0_DX1B    | I      | St/B | <b>USIC0 Channel 0 Shift Clock Input</b>              |
| 63  | P0.4         | O0 / I | St/B | <b>Bit 4 of Port 0, General Purpose Input/Output</b>  |
|     | U1C1_SELO0   | O1     | St/B | <b>USIC1 Channel 1 Select/Control 0 Output</b>        |
|     | U1C0_SELO1   | O2     | St/B | <b>USIC1 Channel 0 Select/Control 1 Output</b>        |
|     | CCU61_COUT61 | O3     | St/B | <b>CCU61 Channel 1 Output</b>                         |
|     | A4           | OH     | St/B | <b>External Bus Interface Address Line 4</b>          |
|     | U1C1_DX2A    | I      | St/B | <b>USIC1 Channel 1 Shift Control Input</b>            |
|     | RxDC1B       | I      | St/B | <b>CAN Node 1 Receive Data Input</b>                  |
| 65  | TRef         | IO     | Sp/1 | <b>Control Pin for Core Voltage Generation</b><br>2)  |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol       | Ctrl.  | Type | Function  |
|-----|--------------|--------|------|---|
| 66  | P2.10        | O0 / I | St/B | <b>Bit 10 of Port 2, General Purpose Input/Output</b> |
|     | U0C1_DOUT    | O1     | St/B | <b>USIC0 Channel 1 Shift Data Output</b>              |
|     | U0C0_SELO3   | O2     | St/B | <b>USIC0 Channel 0 Select/Control 3 Output</b>        |
|     | CC2_23       | O3 / I | St/B | <b>CAPCOM2 CC23IO Capture Inp./ Compare Out.</b>      |
|     | A23          | OH     | St/B | <b>External Bus Interface Address Line 23</b>         |
|     | U0C1_DX0E    | I      | St/B | <b>USIC0 Channel 1 Shift Data Input</b>               |
|     | CAPIN        | I      | St/B | <b>GPT2 Register CAPREL Capture Input</b>             |
| 67  | P10.3        | O0 / I | St/B | <b>Bit 3 of Port 10, General Purpose Input/Output</b> |
|     | CCU60_COUT60 | O2     | St/B | <b>CCU60 Channel 0 Output</b>                         |
|     | AD3          | OH / I | St/B | <b>External Bus Interface Address/Data Line 3</b>     |
|     | U0C0_DX2A    | I      | St/B | <b>USIC0 Channel 0 Shift Control Input</b>            |
|     | U0C1_DX2A    | I      | St/B | <b>USIC0 Channel 1 Shift Control Input</b>            |
| 68  | P0.5         | O0 / I | St/B | <b>Bit 5 of Port 0, General Purpose Input/Output</b>  |
|     | U1C1_SCLKOUT | O1     | St/B | <b>USIC1 Channel 1 Shift Clock Output</b>             |
|     | U1C0_SELO2   | O2     | St/B | <b>USIC1 Channel 0 Select/Control 2 Output</b>        |
|     | CCU61_COUT62 | O3     | St/B | <b>CCU61 Channel 2 Output</b>                         |
|     | A5           | OH     | St/B | <b>External Bus Interface Address Line 5</b>          |
|     | U1C1_DX1A    | I      | St/B | <b>USIC1 Channel 1 Shift Clock Input</b>              |
|     | U1C0_DX1C    | I      | St/B | <b>USIC1 Channel 0 Shift Clock Input</b>              |
| 69  | P10.4        | O0 / I | St/B | <b>Bit 4 of Port 10, General Purpose Input/Output</b> |
|     | U0C0_SELO3   | O1     | St/B | <b>USIC0 Channel 0 Select/Control 3 Output</b>        |
|     | CCU60_COUT61 | O2     | St/B | <b>CCU60 Channel 1 Output</b>                         |
|     | AD4          | OH / I | St/B | <b>External Bus Interface Address/Data Line 4</b>     |
|     | U0C0_DX2B    | I      | St/B | <b>USIC0 Channel 0 Shift Control Input</b>            |
|     | U0C1_DX2B    | I      | St/B | <b>USIC0 Channel 1 Shift Control Input</b>            |

**Table 4 Pin Definitions and Functions (cont'd)**

| <b>Pin</b> | <b>Symbol</b> | <b>Ctrl.</b> | <b>Type</b> | <b>Function</b>                                       |
|------------|---------------|--------------|-------------|---|
| 70         | P10.5         | O0 / I       | St/B        | <b>Bit 5 of Port 10, General Purpose Input/Output</b> |
|            | U0C1_SCLKOUT  | O1           | St/B        | <b>USIC0 Channel 1 Shift Clock Output</b>             |
|            | CCU60_COUT62  | O2           | St/B        | <b>CCU60 Channel 2 Output</b>                         |
|            | AD5           | OH / I       | St/B        | <b>External Bus Interface Address/Data Line 5</b>     |
|            | U0C1_DX1B     | I            | St/B        | <b>USIC0 Channel 1 Shift Clock Input</b>              |
| 71         | P0.6          | O0 / I       | St/B        | <b>Bit 6 of Port 0, General Purpose Input/Output</b>  |
|            | U1C1_DOUT     | O1           | St/B        | <b>USIC1 Channel 1 Shift Data Output</b>              |
|            | TxDC1         | O2           | St/B        | <b>CAN Node 1 Transmit Data Output</b>                |
|            | CCU61_COUT63  | O3           | St/B        | <b>CCU61 Channel 3 Output</b>                         |
|            | A6            | OH           | St/B        | <b>External Bus Interface Address Line 6</b>          |
|            | U1C1_DX0A     | I            | St/B        | <b>USIC1 Channel 1 Shift Data Input</b>               |
|            | CCU61_CTRAPA  | I            | St/B        | <b>CCU61 Emergency Trap Input</b>                     |
|            | U1C1_DX1B     | I            | St/B        | <b>USIC1 Channel 1 Shift Clock Input</b>              |
| 72         | P10.6         | O0 / I       | St/B        | <b>Bit 6 of Port 10, General Purpose Input/Output</b> |
|            | U0C0_DOUT     | O1           | St/B        | <b>USIC0 Channel 0 Shift Data Output</b>              |
|            | U1C0_SELO0    | O3           | St/B        | <b>USIC1 Channel 0 Select/Control 0 Output</b>        |
|            | AD6           | OH / I       | St/B        | <b>External Bus Interface Address/Data Line 6</b>     |
|            | U0C0_DX0C     | I            | St/B        | <b>USIC0 Channel 0 Shift Data Input</b>               |
|            | U1C0_DX2D     | I            | St/B        | <b>USIC1 Channel 0 Shift Control Input</b>            |
|            | CCU60_CTRAPA  | I            | St/B        | <b>CCU60 Emergency Trap Input</b>                     |



**Table 4 Pin Definitions and Functions (cont'd)**

| <b>Pin</b> | <b>Symbol</b> | <b>Ctrl.</b> | <b>Type</b> | <b>Function</b>                                       |
|------------|---------------|--------------|-------------|---|
| 73         | P10.7         | O0 / I       | St/B        | <b>Bit 7 of Port 10, General Purpose Input/Output</b> |
|            | U0C1_DOUT     | O1           | St/B        | <b>USIC0 Channel 1 Shift Data Output</b>              |
|            | CCU60_COUT63  | O2           | St/B        | <b>CCU60 Channel 3 Output</b>                         |
|            | AD7           | OH / I       | St/B        | <b>External Bus Interface Address/Data Line 7</b>     |
|            | U0C1_DX0B     | I            | St/B        | <b>USIC0 Channel 1 Shift Data Input</b>               |
|            | CCU60_CCPOS0A | I            | St/B        | <b>CCU60 Position Input 0</b>                         |
| 74         | P0.7          | O0 / I       | St/B        | <b>Bit 7 of Port 0, General Purpose Input/Output</b>  |
|            | U1C1_DOUT     | O1           | St/B        | <b>USIC1 Channel 1 Shift Data Output</b>              |
|            | U1C0_SELO3    | O2           | St/B        | <b>USIC1 Channel 0 Select/Control 3 Output</b>        |
|            | A7            | OH           | St/B        | <b>External Bus Interface Address Line 7</b>          |
|            | U1C1_DX0B     | I            | St/B        | <b>USIC1 Channel 1 Shift Data Input</b>               |
|            | CCU61_CTRAPB  | I            | St/B        | <b>CCU61 Emergency Trap Input</b>                     |
| 78         | P1.0          | O0 / I       | St/B        | <b>Bit 0 of Port 1, General Purpose Input/Output</b>  |
|            | U1C0_MCLKOUT  | O1           | St/B        | <b>USIC1 Channel 0 Master Clock Output</b>            |
|            | U1C0_SELO4    | O2           | St/B        | <b>USIC1 Channel 0 Select/Control 4 Output</b>        |
|            | A8            | OH           | St/B        | <b>External Bus Interface Address Line 8</b>          |
|            | ESR1_3        | I            | St/B        | <b>ESR1 Trigger Input 3</b>                           |
|            | EX0BINA       | I            | St/B        | <b>External Interrupt Trigger Input</b>               |
|            | CCU62_CTRAPB  | I            | St/B        | <b>CCU62 Emergency Trap Input</b>                     |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol        | Ctrl.  | Type | Function  |
|-----|---------------|--------|------|---|
| 79  | P10.8         | O0 / I | St/B | <b>Bit 8 of Port 10, General Purpose Input/Output</b> |
|     | U0C0_MCLKOUT  | O1     | St/B | <b>USIC0 Channel 0 Master Clock Output</b>            |
|     | U0C1_SELO0    | O2     | St/B | <b>USIC0 Channel 1 Select/Control 0 Output</b>        |
|     | AD8           | OH / I | St/B | <b>External Bus Interface Address/Data Line 8</b>     |
|     | CCU60_CCPOS1A | I      | St/B | <b>CCU60 Position Input 1</b>                         |
|     | U0C0_DX1C     | I      | St/B | <b>USIC0 Channel 0 Shift Clock Input</b>              |
|     | BRKIN_B       | I      | St/B | <b>OCDS Break Signal Input</b>                        |
| 80  | P10.9         | O0 / I | St/B | <b>Bit 9 of Port 10, General Purpose Input/Output</b> |
|     | U0C0_SELO4    | O1     | St/B | <b>USIC0 Channel 0 Select/Control 4 Output</b>        |
|     | U0C1_MCLKOUT  | O2     | St/B | <b>USIC0 Channel 1 Master Clock Output</b>            |
|     | AD9           | OH / I | St/B | <b>External Bus Interface Address/Data Line 9</b>     |
|     | CCU60_CCPOS2A | I      | St/B | <b>CCU60 Position Input 2</b>                         |
|     | TCK_B         | I      | St/B | <b>JTAG Clock Input</b>                               |
|     |               |        |      |   |
| 81  | P1.1          | O0 / I | St/B | <b>Bit 1 of Port 1, General Purpose Input/Output</b>  |
|     | CCU62_COUT62  | O1     | St/B | <b>CCU62 Channel 2 Output</b>                         |
|     | U1C0_SELO5    | O2     | St/B | <b>USIC1 Channel 0 Select/Control 5 Output</b>        |
|     | U2C1_DOUT     | O3     | St/B | <b>USIC2 Channel 1 Shift Data Output</b>              |
|     | A9            | OH     | St/B | <b>External Bus Interface Address Line 9</b>          |
|     | ESR2_3        | I      | St/B | <b>ESR2 Trigger Input 3</b>                           |
|     | EX1BINA       | I      | St/B | <b>External Interrupt Trigger Input</b>               |
|     | U2C1_DX0C     | I      | St/B | <b>USIC2 Channel 1 Shift Data Input</b>               |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol       | Ctrl.  | Type | Function   |
|-----|--------------|--------|------|--|
| 82  | P10.10       | O0 / I | St/B | <b>Bit 10 of Port 10, General Purpose Input/Output</b> |
|     | U0C0_SELO0   | O1     | St/B | <b>USIC0 Channel 0 Select/Control 0 Output</b>         |
|     | CCU60_COUT63 | O2     | St/B | <b>CCU60 Channel 3 Output</b>                          |
|     | AD10         | OH / I | St/B | <b>External Bus Interface Address/Data Line 10</b>     |
|     | U0C0_DX2C    | I      | St/B | <b>USIC0 Channel 0 Shift Control Input</b>             |
|     | TDI_B        | I      | St/B | <b>JTAG Test Data Input</b>                            |
|     | U0C1_DX1A    | I      | St/B | <b>USIC0 Channel 1 Shift Clock Input</b>               |
| 83  | P10.11       | O0 / I | St/B | <b>Bit 11 of Port 10, General Purpose Input/Output</b> |
|     | U1C0_SCLKOUT | O1     | St/B | <b>USIC1 Channel 0 Shift Clock Output</b>              |
|     | BRKOUT       | O2     | St/B | <b>OCDS Break Signal Output</b>                        |
|     | AD11         | OH / I | St/B | <b>External Bus Interface Address/Data Line 11</b>     |
|     | U1C0_DX1D    | I      | St/B | <b>USIC1 Channel 0 Shift Clock Input</b>               |
|     | RxDC2B       | I      | St/B | <b>CAN Node 2 Receive Data Input</b>                   |
|     | TMS_B        | I      | St/B | <b>JTAG Test Mode Selection Input</b>                  |
| 84  | P1.2         | O0 / I | St/B | <b>Bit 2 of Port 1, General Purpose Input/Output</b>   |
|     | CCU62_CC62   | O1 / I | St/B | <b>CCU62 Channel 2 Input/Output</b>                    |
|     | U1C0_SELO6   | O2     | St/B | <b>USIC1 Channel 0 Select/Control 6 Output</b>         |
|     | U2C1_SCLKOUT | O3     | St/B | <b>USIC2 Channel 1 Shift Clock Output</b>              |
|     | A10          | OH     | St/B | <b>External Bus Interface Address Line 10</b>          |
|     | ESR1_4       | I      | St/B | <b>ESR1 Trigger Input 4</b>                            |
|     | CCU61_T12HRB | I      | St/B | <b>External Run Control Input for T12 of CCU61</b>     |
|     | EX2AINA      | I      | St/B | <b>External Interrupt Trigger Input</b>                |
|     | U2C1_DX0D    | I      | St/B | <b>USIC2 Channel 1 Shift Data Input</b>                |
|     | U2C1_DX1C    | I      | St/B | <b>USIC2 Channel 1 Shift Clock Input</b>               |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol                                       | Ctrl.  | Type | Function  |
|-----|--|--------|------|---|
| 85  | P10.12                                       | O0 / I | St/B | <b>Bit 12 of Port 10, General Purpose Input/Output</b>  |
|     | U1C0_DOUT                                    | O1     | St/B | <b>USIC1 Channel 0 Shift Data Output</b>  |
|     | TxDC2  | O2     | St/B | <b>CAN Node 2 Transmit Data Output</b>  |
|     | TDO_B  | O3     | St/B | <b>JTAG Test Data Output</b>  |
|     | AD12   | OH / I | St/B | <b>External Bus Interface Address/Data Line 12</b>  |
|     | U1C0_DX0C                                    | I      | St/B | <b>USIC1 Channel 0 Shift Data Input</b>   |
|     | U1C0_DX1E                                    | I      | St/B | <b>USIC1 Channel 0 Shift Clock Input</b>  |
| 86  | P10.13                                       | O0 / I | St/B | <b>Bit 13 of Port 10, General Purpose Input/Output</b>  |
|     | U1C0_DOUT                                    | O1     | St/B | <b>USIC1 Channel 0 Shift Data Output</b>  |
|     | TxDC3  | O2     | St/B | <b>CAN Node 3 Transmit Data Output</b>  |
|     | U1C0_SELO3                                   |        | St/B | <b>USIC1 Channel 0 Select/Control 3 Output</b>  |
|     | $\overline{\text{WR}}/\overline{\text{WRL}}$ | OH     | St/B | <b>External Bus Interface Write Strobe Output</b><br>Active for each external write access, when $\overline{\text{WR}}$ ,<br>active for ext. writes to the low byte, when $\overline{\text{WRL}}$ . |
|     | U1C0_DX0D                                    | I      | St/B | <b>USIC1 Channel 0 Shift Data Input</b>   |
|     |  |        |      |   |
| 87  | P1.3   | O0 / I | St/B | <b>Bit 3 of Port 1, General Purpose Input/Output</b>  |
|     | CCU62_COUT63                                 | O1     | St/B | <b>CCU62 Channel 3 Output</b>   |
|     | U1C0_SELO7                                   | O2     | St/B | <b>USIC1 Channel 0 Select/Control 7 Output</b>  |
|     | U2C0_SELO4                                   | O3     | St/B | <b>USIC2 Channel 0 Select/Control 4 Output</b>  |
|     | A11  | OH     | St/B | <b>External Bus Interface Address Line 11</b>   |
|     | ESR2_4                                       | I      | St/B | <b>ESR2 Trigger Input 4</b>   |
|     | CCU62_T12HRB                                 | I      | St/B | <b>External Run Control Input for T12 of CCU62</b>  |
|     | EX3AINA                                      | I      | St/B | <b>External Interrupt Trigger Input</b>   |

**Table 4 Pin Definitions and Functions (cont'd)**

| <b>Pin</b> | <b>Symbol</b>              | <b>Ctrl.</b> | <b>Type</b> | <b>Function</b>  |
|------------|----------------------------|--------------|-------------|--|
| 89         | P10.14                     | O0 / I       | St/B        | <b>Bit 14 of Port 10, General Purpose Input/Output</b> |
|            | U1C0_SELO1                 | O1           | St/B        | <b>USIC1 Channel 0 Select/Control 1 Output</b>         |
|            | U0C1_DOUT                  | O2           | St/B        | <b>USIC0 Channel 1 Shift Data Output</b>               |
|            | $\overline{\text{RD}}$     | OH           | St/B        | <b>External Bus Interface Read Strobe Output</b>       |
|            | ESR2_2                     | I            | St/B        | <b>ESR2 Trigger Input 2</b>                            |
|            | U0C1_DX0C                  | I            | St/B        | <b>USIC0 Channel 1 Shift Data Input</b>                |
|            | RxDC3C                     | I            | St/B        | <b>CAN Node 3 Receive Data Input</b>                   |
| 90         | P1.4                       | O0 / I       | St/B        | <b>Bit 4 of Port 1, General Purpose Input/Output</b>   |
|            | CCU62_COUT61               | O1           | St/B        | <b>CCU62 Channel 1 Output</b>                          |
|            | U1C1_SELO4                 | O2           | St/B        | <b>USIC1 Channel 1 Select/Control 4 Output</b>         |
|            | U2C0_SELO5                 | O3           | St/B        | <b>USIC2 Channel 0 Select/Control 5 Output</b>         |
|            | A12                        | OH           | St/B        | <b>External Bus Interface Address Line 12</b>          |
|            | U2C0_DX2B                  | I            | St/B        | <b>USIC2 Channel 0 Shift Control Input</b>             |
| 91         | P10.15                     | O0 / I       | St/B        | <b>Bit 15 of Port 10, General Purpose Input/Output</b> |
|            | U1C0_SELO2                 | O1           | St/B        | <b>USIC1 Channel 0 Select/Control 2 Output</b>         |
|            | U0C1_DOUT                  | O2           | St/B        | <b>USIC0 Channel 1 Shift Data Output</b>               |
|            | U1C0_DOUT                  | O3           | St/B        | <b>USIC1 Channel 0 Shift Data Output</b>               |
|            | ALE                        | OH           | St/B        | <b>External Bus Interf. Addr. Latch Enable Output</b>  |
|            | U0C1_DX1C                  | I            | St/B        | <b>USIC0 Channel 1 Shift Clock Input</b>               |
| 92         | P1.5                       | O0 / I       | St/B        | <b>Bit 5 of Port 1, General Purpose Input/Output</b>   |
|            | CCU62_COUT60               | O1           | St/B        | <b>CCU62 Channel 0 Output</b>                          |
|            | U1C1_SELO3                 | O2           | St/B        | <b>USIC1 Channel 1 Select/Control 3 Output</b>         |
|            | $\overline{\text{BRKOUT}}$ | O3           | St/B        | <b>OCDS Break Signal Output</b>                        |
|            | A13                        | OH           | St/B        | <b>External Bus Interface Address Line 13</b>          |
|            | U2C0_DX0C                  | I            | St/B        | <b>USIC2 Channel 0 Shift Data Input</b>                |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin | Symbol                    | Ctrl.  | Type | Function   |
|-----|---------------------------|--------|------|--|
| 93  | P1.6                      | O0 / I | St/B | <b>Bit 6 of Port 1, General Purpose Input/Output</b>   |
|     | CCU62_<br>CC61            | O1 / I | St/B | <b>CCU62 Channel 1 Input/Output</b>  |
|     | U1C1_<br>SELO2            | O2     | St/B | <b>USIC1 Channel 1 Select/Control 2 Output</b>   |
|     | U2C0_DOUT                 | O3     | St/B | <b>USIC2 Channel 0 Shift Data Output</b>   |
|     | A14                       | OH     | St/B | <b>External Bus Interface Address Line 14</b>  |
|     | U2C0_DX0D                 | I      | St/B | <b>USIC2 Channel 0 Shift Data Input</b>  |
| 94  | P1.7                      | O0 / I | St/B | <b>Bit 7 of Port 1, General Purpose Input/Output</b>   |
|     | CCU62_<br>CC60            | O1 / I | St/B | <b>CCU62 Channel 0 Input/Output</b>  |
|     | U1C1_<br>MCLKOUT          | O2     | St/B | <b>USIC1 Channel 1 Master Clock Output</b>   |
|     | U2C0_<br>SCLKOUT          | O3     | St/B | <b>USIC2 Channel 0 Shift Clock Output</b>  |
|     | A15                       | OH     | St/B | <b>External Bus Interface Address Line 15</b>  |
|     | U2C0_DX1C                 | I      | St/B | <b>USIC2 Channel 0 Shift Clock Input</b>   |
| 95  | XTAL2                     | O      | Sp/1 | <b>Crystal Oscillator Amplifier Output</b>   |
| 96  | XTAL1                     | I      | Sp/1 | <b>Crystal Oscillator Amplifier Input</b><br>To clock the device from an external source, drive XTAL1, while leaving XTAL2 unconnected. Voltages on XTAL1 must comply to the core supply voltage $V_{DDI1}$ .  |
| 97  | $\overline{\text{PORST}}$ | I      | In/B | <b>Power On Reset Input</b><br>A low level at this pin resets the XE164 completely. A spike filter suppresses input pulses <10 ns. Input pulses >100 ns safely pass the filter. The minimum duration for a safe recognition should be 120 ns.<br>An internal pullup device will hold this pin high when nothing is driving it. |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin              | Symbol                   | Ctrl.  | Type | Function  |
|------------------|--------------------------|--------|------|---|
| 98               | $\overline{\text{ESR1}}$ | O0 / I | St/B | <b>External Service Request 1</b>   |
|                  | U1C0_DX0F                | I      | St/B | <b>USIC1 Channel 0 Shift Data Input</b>   |
|                  | U1C0_DX2C                | I      | St/B | <b>USIC1 Channel 0 Shift Control Input</b>  |
|                  | U1C1_DX0C                | I      | St/B | <b>USIC1 Channel 1 Shift Data Input</b>   |
|                  | U1C1_DX2B                | I      | St/B | <b>USIC1 Channel 1 Shift Control Input</b>  |
|                  | U2C1_DX2C                | I      | St/B | <b>USIC2 Channel 1 Shift Control Input</b>  |
|                  | EX0AINB                  | I      | St/B | <b>External Interrupt Trigger Input</b>   |
| 99               | $\overline{\text{ESR0}}$ | O0 / I | St/B | <b>External Service Request 0</b><br><i>Note: After power-up, ESR0 operates as open-drain bidirectional reset with a weak pull-up.</i>  |
|                  | U1C0_DX0E                | I      | St/B | <b>USIC1 Channel 0 Shift Data Input</b>   |
|                  | U1C0_DX2B                | I      | St/B | <b>USIC1 Channel 0 Shift Control Input</b>  |
| 10               | $V_{\text{DDIM}}$        | -      | PS/M | <b>Digital Core Supply Voltage for Domain M</b><br>Decouple with a ceramic capacitor, see <a href="#">Table 12</a> for details.   |
| 38,<br>64,<br>88 | $V_{\text{DDI1}}$        | -      | PS/1 | <b>Digital Core Supply Voltage for Domain 1</b><br>Decouple with a ceramic capacitor, see <a href="#">Table 12</a> for details.<br>All $V_{\text{DDI1}}$ pins must be connected to each other.  |
| 14               | $V_{\text{DDPA}}$        | -      | PS/A | <b>Digital Pad Supply Voltage for Domain A</b><br>Connect decoupling capacitors to adjacent $V_{\text{DDP}}/V_{\text{SS}}$ pin pairs as close as possible to the pins.<br><i>Note: The A/D_Converters and ports P5, P6, and P15 are fed from supply voltage <math>V_{\text{DDPA}}</math>.</i> |

**Table 4 Pin Definitions and Functions (cont'd)**

| Pin   | Symbol     | Ctrl. | Type  | Function  |
|---|------------|-------|-------|---|
| 2,<br>25,<br>27,<br>50,<br>52,<br>75,<br>77,<br>100 | $V_{DDPB}$ | -     | PS/B  | <b>Digital Pad Supply Voltage for Domain B</b><br>Connect decoupling capacitors to adjacent $V_{DDP}/V_{SS}$ pin pairs as close as possible to the pins.<br><i>Note: The on-chip voltage regulators and all ports except P5, P6, and P15 are fed from supply voltage <math>V_{DDPB}</math>.</i> |
| 1,<br>26,<br>51,<br>76                              | $V_{SS}$   | -     | PS/-- | <b>Digital Ground</b><br>All $V_{SS}$ pins must be connected to the ground-line or ground-plane.<br><i>Note: Also the exposed pad is connected to <math>V_{SS}</math>. The respective board area must be connected to ground (if soldered) or left free.</i>                                    |

- 1) To generate the reference clock output for bus timing measurement,  $f_{SYS}$  must be selected as source for EXTCLK and P2.8 must be selected as output pin. Also the high-speed clock pad must be enabled. This configuration is referred to as reference clock output signal CLKOUT.
- 2) Pin TRef was used to control the core voltage generation in step AA. For that step, pin TRef must be connected to  $V_{DDPB}$ .  
This connection is no more required from step AB on. For the current step, pin TRef is logically not connected. Future derivatives will feature an additional general purpose IO pin at this position.

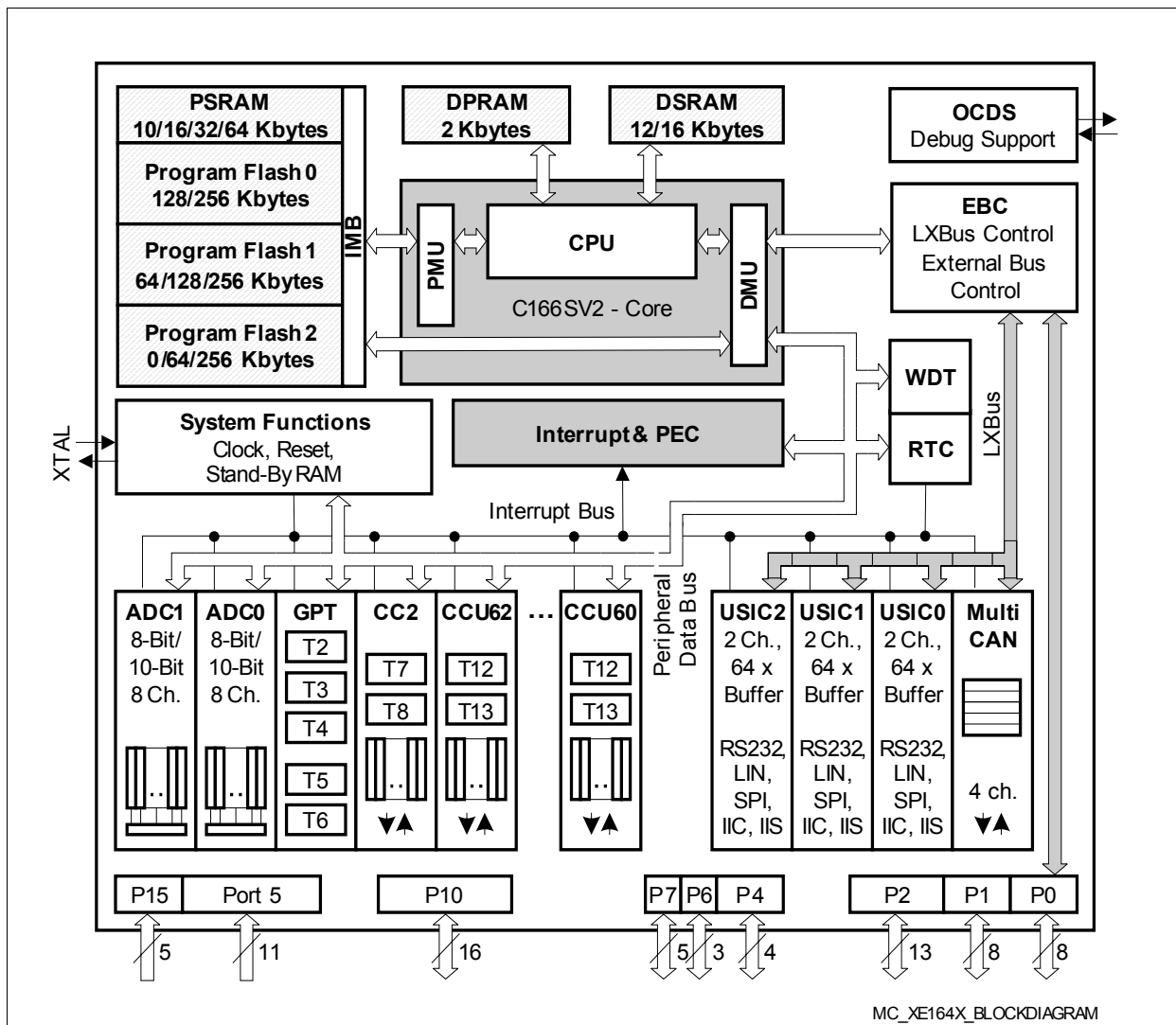


### 3 Functional Description

The architecture of the XE164 combines advantages of RISC, CISC, and DSP processors with an advanced peripheral subsystem in a well-balanced design. On-chip memory blocks allow the design of compact systems-on-silicon with maximum performance suited for computing, control, and communication.

The on-chip memory blocks (program code memory and SRAM, dual-port RAM, data SRAM) and the generic peripherals are connected to the CPU by separate high-speed buses. Another bus, the LXBus, connects additional on-chip resources and external resources (see [Figure 3](#)). This bus structure enhances overall system performance by enabling the concurrent operation of several subsystems of the XE164.

The block diagram gives an overview of the on-chip components and the advanced internal bus structure of the XE164.



**Figure 3 Block Diagram**

### 3.1 Memory Subsystem and Organization

The memory space of the XE164 is configured in the von Neumann architecture. In this architecture all internal and external resources, including code memory, data memory, registers and I/O ports, are organized in the same linear address space.

**Table 5 XE164 Memory Map**

| Address Area                         | Start Loc.           | End Loc.             | Area Size <sup>1)</sup> | Notes               |
|--------------------------------------|----------------------|----------------------|-------------------------|---------------------|
| IMB register space                   | FF'FF00 <sub>H</sub> | FF'FFFF <sub>H</sub> | 256 Bytes               | –                   |
| Reserved (Access trap)               | F0'0000 <sub>H</sub> | FF'FEFF <sub>H</sub> | <1 Mbyte                | Minus IMB registers |
| Reserved for EPSRAM                  | E9'0000 <sub>H</sub> | EF'FFFF <sub>H</sub> | 448 Kbytes              | Mirrors EPSRAM      |
| Emulated PSRAM                       | E8'0000 <sub>H</sub> | E8'FFFF <sub>H</sub> | 64 Kbytes               | Flash timing        |
| Reserved for PSRAM                   | E1'0000 <sub>H</sub> | E7'FFFF <sub>H</sub> | 448 Kbytes              | Mirrors PSRAM       |
| Program SRAM                         | E0'0000 <sub>H</sub> | E0'FFFF <sub>H</sub> | 64 Kbytes               | Maximum speed       |
| Reserved for pr. mem.                | CC'0000 <sub>H</sub> | DF'FFFF <sub>H</sub> | <1.25 Mbytes            | –                   |
| Program Flash 2                      | C8'0000 <sub>H</sub> | CB'FFFF <sub>H</sub> | 256 Kbytes              | –                   |
| Program Flash 1                      | C4'0000 <sub>H</sub> | C7'FFFF <sub>H</sub> | 256 Kbytes              | –                   |
| Program Flash 0                      | C0'0000 <sub>H</sub> | C3'FFFF <sub>H</sub> | 256 Kbytes              | <sup>2)</sup>       |
| External memory area                 | 40'0000 <sub>H</sub> | BF'FFFF <sub>H</sub> | 8 Mbytes                | –                   |
| Available Ext. IO area <sup>3)</sup> | 20'5800 <sub>H</sub> | 3F'FFFF <sub>H</sub> | < 2 Mbytes              | Minus USIC/CAN      |
| USIC registers                       | 20'4000 <sub>H</sub> | 20'57FF <sub>H</sub> | 6 Kbytes                | Accessed via EBC    |
| MultiCAN registers                   | 20'0000 <sub>H</sub> | 20'3FFF <sub>H</sub> | 16 Kbytes               | Accessed via EBC    |
| External memory area                 | 01'0000 <sub>H</sub> | 1F'FFFF <sub>H</sub> | < 2 Mbytes              | Minus segment 0     |
| SFR area                             | 00'FE00 <sub>H</sub> | 00'FFFF <sub>H</sub> | 0.5 Kbyte               | –                   |
| Dual-Port RAM                        | 00'F600 <sub>H</sub> | 00'FDFF <sub>H</sub> | 2 Kbytes                | –                   |
| Reserved for DPRAM                   | 00'F200 <sub>H</sub> | 00'F5FF <sub>H</sub> | 1 Kbyte                 | –                   |
| ESFR area                            | 00'F000 <sub>H</sub> | 00'F1FF <sub>H</sub> | 0.5 Kbyte               | –                   |
| XSFR area                            | 00'E000 <sub>H</sub> | 00'EFFF <sub>H</sub> | 4 Kbytes                | –                   |
| Data SRAM                            | 00'A000 <sub>H</sub> | 00'DFFF <sub>H</sub> | 16 Kbytes               | –                   |
| Reserved for DSRAM                   | 00'8000 <sub>H</sub> | 00'9FFF <sub>H</sub> | 8 Kbytes                | –                   |
| External memory area                 | 00'0000 <sub>H</sub> | 00'7FFF <sub>H</sub> | 32 Kbytes               | –                   |

1) The areas marked with “<” are slightly smaller than indicated. See column “Notes”.

2) The uppermost 4-Kbyte sector of the first Flash segment is reserved for internal use (C0'F000<sub>H</sub> to C0'FFFF<sub>H</sub>).

3) Several pipeline optimizations are not active within the external IO area. This is necessary to control external peripherals properly.

**Functional Description**

This common memory space consists of 16 Mbytes organized as 256 segments of 64 Kbytes; each segment contains four data pages of 16 Kbytes. The entire memory space can be accessed byte-wise or word-wise. Portions of the on-chip DPRAM and the register spaces (ESFR/SFR) additionally are directly bit addressable.

The internal data memory areas and the Special Function Register areas (SFR and ESFR) are mapped into segment 0, the system segment.

The Program Management Unit (PMU) handles all code fetches and, therefore, controls access to the program memories such as Flash memory and PSRAM.

The Data Management Unit (DMU) handles all data transfers and, therefore, controls access to the DSRAM and the on-chip peripherals.

Both units (PMU and DMU) are connected to the high-speed system bus so that they can exchange data. This is required if operands are read from program memory, code or data is written to the PSRAM, code is fetched from external memory, or data is read from or written to external resources. These include peripherals on the LXBus such as USIC or MultiCAN. The system bus allows concurrent two-way communication for maximum transfer performance.

**Up to 64 Kbytes of on-chip Program SRAM (PSRAM)** are provided to store user code or data. The PSRAM is accessed via the PMU and is optimized for code fetches. A section of the PSRAM with programmable size can be write-protected.

*Note: The actual size of the PSRAM depends on the chosen derivative (see [Table 1](#)).*

**Up to 16 Kbytes of on-chip Data SRAM (DSRAM)** are used for storage of general user data (12 Kbytes for devices with 192 Kbytes of Flash). The DSRAM is accessed via a separate interface and is optimized for data access.

**2 Kbytes of on-chip Dual-Port RAM (DPRAM)** provide storage for user-defined variables, for the system stack, and for general purpose register banks. A register bank can consist of up to 16 word-wide (R0 to R15) and/or byte-wide (RL0, RH0, ..., RL7, RH7) General Purpose Registers (GPRs).

The upper 256 bytes of the DPRAM are directly bit addressable. When used by a GPR, any location in the DPRAM is bit addressable.

**1 Kbyte of on-chip Stand-By SRAM (SBRAM)** provides storage for system-relevant user data that must be preserved while the major part of the device is powered down. The SBRAM is accessed via a specific interface and is powered in domain M.

**Functional Description**

**1024 bytes (2 × 512 bytes)** of the address space are reserved for the Special Function Register areas (SFR space and ESFR space). SFRs are word-wide registers which are used to control and monitor functions of the different on-chip units. Unused SFR addresses are reserved for future members of the XE166 Family. In order to ensure upward compatibility they should either not be accessed or written with zeros.

In order to meet the requirements of designs where more memory is required than is available on chip, up to 12 Mbytes (approximately, see [Table 5](#)) of external RAM and/or ROM can be connected to the microcontroller. The External Bus Interface also provides access to external peripherals.

**Up to 768 Kbytes of on-chip Flash memory** store code, constant data, and control data. The on-chip Flash memory consists of up to three modules with a maximum capacity of 256 Kbytes each. Each module is organized in 4-Kbyte sectors.

The uppermost 4-Kbyte sector of segment 0 (located in Flash module 0) is used internally to store operation control parameters and protection information.

*Note: The actual size of the Flash memory depends on the chosen derivative (see [Table 1](#)).*

Each sector can be separately write protected<sup>1)</sup>, erased and programmed (in blocks of 128 Bytes). The complete Flash area can be read-protected. A user-defined password sequence temporarily unlocks protected areas. The Flash modules combine 128-bit read access with protected and efficient writing algorithms for programming and erasing. Dynamic error correction provides extremely high read data security for all read access operations. Access to different Flash modules can be executed in parallel.

For Flash parameters, please see [Section 4.5](#).

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1) To save control bits, sectors are clustered for protection purposes, they remain separate for programming/erasing.

### **3.2 External Bus Controller**

All external memory access operations are performed by a special on-chip External Bus Controller (EBC). The EBC also controls access to resources connected to the on-chip LXBus (MultiCAN and the USIC modules). The LXBus is an internal representation of the external bus that allows access to integrated peripherals and modules in the same way as to external components.

The EBC can be programmed either to Single Chip Mode, when no external memory is required, or to an external bus mode with the following selections<sup>1)</sup>:

- Address Bus Width with a range of 0 ... 24-bit
- Data Bus Width 8-bit or 16-bit
- Bus Operation Multiplexed or Demultiplexed

The bus interface uses Port 10 and Port 2 for addresses and data. In the demultiplexed bus modes, the lower addresses are output separately on Port 0 and Port 1. The number of active segment address lines is selectable, restricting the external address space to 8 Mbytes ... 64 Kbytes. This is required when interface lines shall be assigned to Port 2.

Up to four external  $\overline{\text{CS}}$  signals (three windows plus default) can be generated and output on Port 4 in order to save external glue logic. External modules can be directly connected to the common address/data bus and their individual select lines.

Important timing characteristics of the external bus interface are programmable (with registers TCONCSx/FCONCSx) to allow the user to adapt it to a wide range of different types of memories and external peripherals.

Access to very slow memories or modules with varying access times is supported by a special 'Ready' function. The active level of the control input signal is selectable.

In addition, up to four independent address windows may be defined (using registers ADDRSELx) to control access to resources with different bus characteristics. These address windows are arranged hierarchically where window 4 overrides window 3, and window 2 overrides window 1. All accesses to locations not covered by these four address windows are controlled by TCONCS0/FCONCS0. The currently active window can generate a chip select signal.

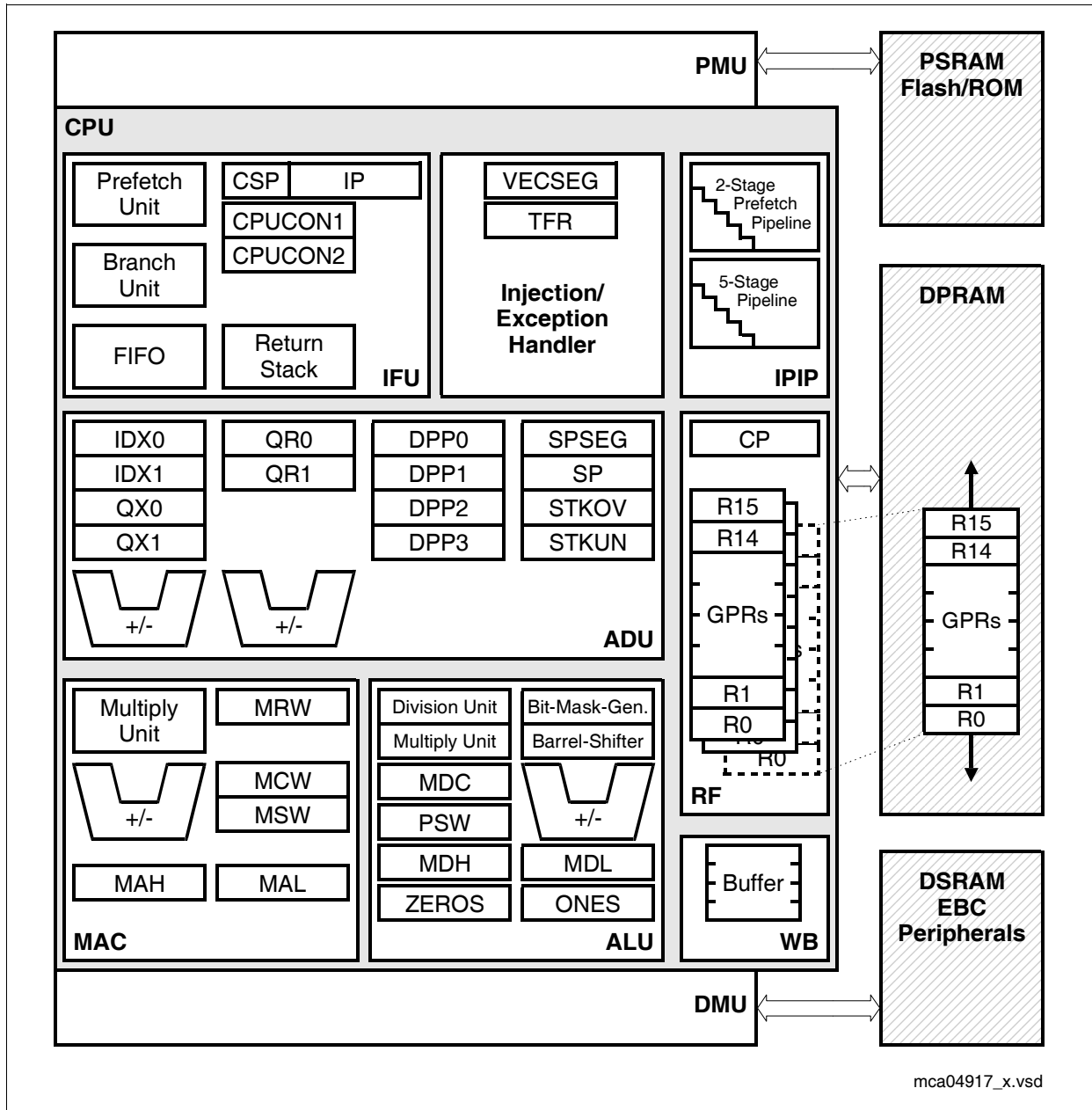
The external bus timing is based on the rising edge of the reference clock output CLKOUT. The external bus protocol is compatible with that of the standard C166 Family.

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1) Bus modes are switched dynamically if several address windows with different mode settings are used.

### 3.3 Central Processing Unit (CPU)

The core of the CPU consists of a 5-stage execution pipeline with a 2-stage instruction-fetch pipeline, a 16-bit arithmetic and logic unit (ALU), a 32-bit/40-bit multiply and accumulate unit (MAC), a register-file providing three register banks, and dedicated SFRs. The ALU features a multiply-and-divide unit, a bit-mask generator, and a barrel shifter.



**Figure 4 CPU Block Diagram**

**Functional Description**

With this hardware most XE164 instructions can be executed in a single machine cycle of 12.5 ns with an 80-MHz CPU clock. For example, shift and rotate instructions are always processed during one machine cycle, no matter how many bits are shifted. Also, multiplication and most MAC instructions execute in one cycle. All multiple-cycle instructions have been optimized so that they can be executed very fast; for example, a 32-/16-bit division is started within 4 cycles while the remaining cycles are executed in the background. Another pipeline optimization, the branch target prediction, eliminates the execution time of branch instructions if the prediction was correct.

The CPU has a register context consisting of up to three register banks with 16 word-wide GPRs each at its disposal. One of these register banks is physically allocated within the on-chip DPRAM area. A Context Pointer (CP) register determines the base address of the active register bank accessed by the CPU at any time. The number of these register bank copies is only restricted by the available internal RAM space. For easy parameter passing, a register bank may overlap others.

A system stack of up to 32 Kwords is provided for storage of temporary data. The system stack can be allocated to any location within the address space (preferably in the on-chip RAM area); it is accessed by the CPU with the stack pointer (SP) register. Two separate SFRs, STKOV and STKUN, are implicitly compared with the stack pointer value during each stack access to detect stack overflow or underflow.

The high performance of the CPU hardware implementation can be best utilized by the programmer with the highly efficient XE164 instruction set. This includes the following instruction classes:

- Standard Arithmetic Instructions
- DSP-Oriented Arithmetic Instructions
- Logical Instructions
- Boolean Bit Manipulation Instructions
- Compare and Loop Control Instructions
- Shift and Rotate Instructions
- Prioritize Instruction
- Data Movement Instructions
- System Stack Instructions
- Jump and Call Instructions
- Return Instructions
- System Control Instructions
- Miscellaneous Instructions

The basic instruction length is either 2 or 4 bytes. Possible operand types are bits, bytes and words. A variety of direct, indirect or immediate addressing modes are provided to specify the required operands.

### **3.4 Interrupt System**

With a minimum interrupt response time of  $7/11^{1)}$  CPU clocks (in the case of internal program execution), the XE164 can react quickly to the occurrence of non-deterministic events.

The architecture of the XE164 supports several mechanisms for fast and flexible response to service requests; these can be generated from various sources internal or external to the microcontroller. Any of these interrupt requests can be programmed to be serviced by the Interrupt Controller or by the Peripheral Event Controller (PEC).

Where in a standard interrupt service the current program execution is suspended and a branch to the interrupt vector table is performed, just one cycle is 'stolen' from the current CPU activity to perform a PEC service. A PEC service implies a single byte or word data transfer between any two memory locations with an additional increment of either the PEC source pointer, the destination pointer, or both. An individual PEC transfer counter is implicitly decremented for each PEC service except when performing in the continuous transfer mode. When this counter reaches zero, a standard interrupt is performed to the corresponding source-related vector location. PEC services are particularly well suited to supporting the transmission or reception of blocks of data. The XE164 has eight PEC channels, each with fast interrupt-driven data transfer capabilities.

Each of the possible interrupt nodes has a separate control register containing an interrupt request flag, an interrupt enable flag and an interrupt priority bitfield. Each node can be programmed by its related register to one of sixteen interrupt priority levels. Once accepted by the CPU, an interrupt service can only be interrupted by a higher-priority service request. For standard interrupt processing, each possible interrupt node has a dedicated vector location.

Fast external interrupt inputs can service external interrupts with high-precision requirements. These fast interrupt inputs feature programmable edge detection (rising edge, falling edge, or both edges).

Software interrupts are supported by the 'TRAP' instruction in combination with an individual trap (interrupt) number.

**Table 6** shows all of the possible XE164 interrupt sources and the corresponding hardware-related interrupt flags, vectors, vector locations and trap (interrupt) numbers.

*Note: Interrupt nodes which are not assigned to peripherals (unassigned nodes) may be used to generate software-controlled interrupt requests by setting the respective interrupt request bit (xIR).*

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1) Depending if the jump cache is used or not.



**Functional Description**

**Table 6      XE164 Interrupt Nodes**

| <b>Source of Interrupt or PEC Service Request</b> | <b>Control Register</b> | <b>Vector Location<sup>1)</sup></b> | <b>Trap Number</b>                |
|---|-------------------------|-------------------------------------|-----------------------------------|
| CAPCOM Register 16, or ERU Request 0              | CC2_CC16IC              | xx'0040 <sub>H</sub>                | 10 <sub>H</sub> / 16 <sub>D</sub> |
| CAPCOM Register 17, or ERU Request 1              | CC2_CC17IC              | xx'0044 <sub>H</sub>                | 11 <sub>H</sub> / 17 <sub>D</sub> |
| CAPCOM Register 18, or ERU Request 2              | CC2_CC18IC              | xx'0048 <sub>H</sub>                | 12 <sub>H</sub> / 18 <sub>D</sub> |
| CAPCOM Register 19, or ERU Request 3              | CC2_CC19IC              | xx'004C <sub>H</sub>                | 13 <sub>H</sub> / 19 <sub>D</sub> |
| CAPCOM Register 20, or USIC0 Request 6            | CC2_CC20IC              | xx'0050 <sub>H</sub>                | 14 <sub>H</sub> / 20 <sub>D</sub> |
| CAPCOM Register 21, or USIC0 Request 7            | CC2_CC21IC              | xx'0054 <sub>H</sub>                | 15 <sub>H</sub> / 21 <sub>D</sub> |
| CAPCOM Register 22, or USIC1 Request 6            | CC2_CC22IC              | xx'0058 <sub>H</sub>                | 16 <sub>H</sub> / 22 <sub>D</sub> |
| CAPCOM Register 23, or USIC1 Request 7            | CC2_CC23IC              | xx'005C <sub>H</sub>                | 17 <sub>H</sub> / 23 <sub>D</sub> |
| CAPCOM Register 24, or ERU Request 0              | CC2_CC24IC              | xx'0060 <sub>H</sub>                | 18 <sub>H</sub> / 24 <sub>D</sub> |
| CAPCOM Register 25, or ERU Request 1              | CC2_CC25IC              | xx'0064 <sub>H</sub>                | 19 <sub>H</sub> / 25 <sub>D</sub> |
| CAPCOM Register 26, or ERU Request 2              | CC2_CC26IC              | xx'0068 <sub>H</sub>                | 1A <sub>H</sub> / 26 <sub>D</sub> |
| CAPCOM Register 27, or ERU Request 3              | CC2_CC27IC              | xx'006C <sub>H</sub>                | 1B <sub>H</sub> / 27 <sub>D</sub> |
| CAPCOM Register 28, or USIC2 Request 6            | CC2_CC28IC              | xx'0070 <sub>H</sub>                | 1C <sub>H</sub> / 28 <sub>D</sub> |
| CAPCOM Register 29, or USIC2 Request 7            | CC2_CC29IC              | xx'0074 <sub>H</sub>                | 1D <sub>H</sub> / 29 <sub>D</sub> |
| CAPCOM Register 30                                | CC2_CC30IC              | xx'0078 <sub>H</sub>                | 1E <sub>H</sub> / 30 <sub>D</sub> |
| CAPCOM Register 31                                | CC2_CC31IC              | xx'007C <sub>H</sub>                | 1F <sub>H</sub> / 31 <sub>D</sub> |
| GPT1 Timer 2                                      | GPT12E_T2IC             | xx'0080 <sub>H</sub>                | 20 <sub>H</sub> / 32 <sub>D</sub> |
| GPT1 Timer 3                                      | GPT12E_T3IC             | xx'0084 <sub>H</sub>                | 21 <sub>H</sub> / 33 <sub>D</sub> |
| GPT1 Timer 4                                      | GPT12E_T4IC             | xx'0088 <sub>H</sub>                | 22 <sub>H</sub> / 34 <sub>D</sub> |

**Functional Description**

**Table 6      XE164 Interrupt Nodes (cont'd)**

| <b>Source of Interrupt or PEC Service Request</b> | <b>Control Register</b> | <b>Vector Location<sup>1)</sup></b> | <b>Trap Number</b>                |
|---|-------------------------|-------------------------------------|-----------------------------------|
| GPT2 Timer 5                                      | GPT12E_T5IC             | xx'008C <sub>H</sub>                | 23 <sub>H</sub> / 35 <sub>D</sub> |
| GPT2 Timer 6                                      | GPT12E_T6IC             | xx'0090 <sub>H</sub>                | 24 <sub>H</sub> / 36 <sub>D</sub> |
| GPT2 CAPREL Register                              | GPT12E_CRIC             | xx'0094 <sub>H</sub>                | 25 <sub>H</sub> / 37 <sub>D</sub> |
| CAPCOM Timer 7                                    | CC2_T7IC                | xx'0098 <sub>H</sub>                | 26 <sub>H</sub> / 38 <sub>D</sub> |
| CAPCOM Timer 8                                    | CC2_T8IC                | xx'009C <sub>H</sub>                | 27 <sub>H</sub> / 39 <sub>D</sub> |
| A/D Converter Request 0                           | ADC_0IC                 | xx'00A0 <sub>H</sub>                | 28 <sub>H</sub> / 40 <sub>D</sub> |
| A/D Converter Request 1                           | ADC_1IC                 | xx'00A4 <sub>H</sub>                | 29 <sub>H</sub> / 41 <sub>D</sub> |
| A/D Converter Request 2                           | ADC_2IC                 | xx'00A8 <sub>H</sub>                | 2A <sub>H</sub> / 42 <sub>D</sub> |
| A/D Converter Request 3                           | ADC_3IC                 | xx'00AC <sub>H</sub>                | 2B <sub>H</sub> / 43 <sub>D</sub> |
| A/D Converter Request 4                           | ADC_4IC                 | xx'00B0 <sub>H</sub>                | 2C <sub>H</sub> / 44 <sub>D</sub> |
| A/D Converter Request 5                           | ADC_5IC                 | xx'00B4 <sub>H</sub>                | 2D <sub>H</sub> / 45 <sub>D</sub> |
| A/D Converter Request 6                           | ADC_6IC                 | xx'00B8 <sub>H</sub>                | 2E <sub>H</sub> / 46 <sub>D</sub> |
| A/D Converter Request 7                           | ADC_7IC                 | xx'00BC <sub>H</sub>                | 2F <sub>H</sub> / 47 <sub>D</sub> |
| CCU60 Request 0                                   | CCU60_0IC               | xx'00C0 <sub>H</sub>                | 30 <sub>H</sub> / 48 <sub>D</sub> |
| CCU60 Request 1                                   | CCU60_1IC               | xx'00C4 <sub>H</sub>                | 31 <sub>H</sub> / 49 <sub>D</sub> |
| CCU60 Request 2                                   | CCU60_2IC               | xx'00C8 <sub>H</sub>                | 32 <sub>H</sub> / 50 <sub>D</sub> |
| CCU60 Request 3                                   | CCU60_3IC               | xx'00CC <sub>H</sub>                | 33 <sub>H</sub> / 51 <sub>D</sub> |
| CCU61 Request 0                                   | CCU61_0IC               | xx'00D0 <sub>H</sub>                | 34 <sub>H</sub> / 52 <sub>D</sub> |
| CCU61 Request 1                                   | CCU61_1IC               | xx'00D4 <sub>H</sub>                | 35 <sub>H</sub> / 53 <sub>D</sub> |
| CCU61 Request 2                                   | CCU61_2IC               | xx'00D8 <sub>H</sub>                | 36 <sub>H</sub> / 54 <sub>D</sub> |
| CCU61 Request 3                                   | CCU61_3IC               | xx'00DC <sub>H</sub>                | 37 <sub>H</sub> / 55 <sub>D</sub> |
| CCU62 Request 0                                   | CCU62_0IC               | xx'00E0 <sub>H</sub>                | 38 <sub>H</sub> / 56 <sub>D</sub> |
| CCU62 Request 1                                   | CCU62_1IC               | xx'00E4 <sub>H</sub>                | 39 <sub>H</sub> / 57 <sub>D</sub> |
| CCU62 Request 2                                   | CCU62_2IC               | xx'00E8 <sub>H</sub>                | 3A <sub>H</sub> / 58 <sub>D</sub> |
| CCU62 Request 3                                   | CCU62_3IC               | xx'00EC <sub>H</sub>                | 3B <sub>H</sub> / 59 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'00F0 <sub>H</sub>                | 3C <sub>H</sub> / 60 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'00F4 <sub>H</sub>                | 3D <sub>H</sub> / 61 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'00F8 <sub>H</sub>                | 3E <sub>H</sub> / 62 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'00FC <sub>H</sub>                | 3F <sub>H</sub> / 63 <sub>D</sub> |
| CAN Request 0                                     | CAN_0IC                 | xx'0100 <sub>H</sub>                | 40 <sub>H</sub> / 64 <sub>D</sub> |

**Functional Description**

**Table 6 XE164 Interrupt Nodes (cont'd)**

| <b>Source of Interrupt or PEC Service Request</b> | <b>Control Register</b> | <b>Vector Location<sup>1)</sup></b> | <b>Trap Number</b>                |
|---|-------------------------|-------------------------------------|-----------------------------------|
| CAN Request 1                                     | CAN_1IC                 | xx'0104 <sub>H</sub>                | 41 <sub>H</sub> / 65 <sub>D</sub> |
| CAN Request 2                                     | CAN_2IC                 | xx'0108 <sub>H</sub>                | 42 <sub>H</sub> / 66 <sub>D</sub> |
| CAN Request 3                                     | CAN_3IC                 | xx'010C <sub>H</sub>                | 43 <sub>H</sub> / 67 <sub>D</sub> |
| CAN Request 4                                     | CAN_4IC                 | xx'0110 <sub>H</sub>                | 44 <sub>H</sub> / 68 <sub>D</sub> |
| CAN Request 5                                     | CAN_5IC                 | xx'0114 <sub>H</sub>                | 45 <sub>H</sub> / 69 <sub>D</sub> |
| CAN Request 6                                     | CAN_6IC                 | xx'0118 <sub>H</sub>                | 46 <sub>H</sub> / 70 <sub>D</sub> |
| CAN Request 7                                     | CAN_7IC                 | xx'011C <sub>H</sub>                | 47 <sub>H</sub> / 71 <sub>D</sub> |
| CAN Request 8                                     | CAN_8IC                 | xx'0120 <sub>H</sub>                | 48 <sub>H</sub> / 72 <sub>D</sub> |
| CAN Request 9                                     | CAN_9IC                 | xx'0124 <sub>H</sub>                | 49 <sub>H</sub> / 73 <sub>D</sub> |
| CAN Request 10                                    | CAN_10IC                | xx'0128 <sub>H</sub>                | 4A <sub>H</sub> / 74 <sub>D</sub> |
| CAN Request 11                                    | CAN_11IC                | xx'012C <sub>H</sub>                | 4B <sub>H</sub> / 75 <sub>D</sub> |
| CAN Request 12                                    | CAN_12IC                | xx'0130 <sub>H</sub>                | 4C <sub>H</sub> / 76 <sub>D</sub> |
| CAN Request 13                                    | CAN_13IC                | xx'0134 <sub>H</sub>                | 4D <sub>H</sub> / 77 <sub>D</sub> |
| CAN Request 14                                    | CAN_14IC                | xx'0138 <sub>H</sub>                | 4E <sub>H</sub> / 78 <sub>D</sub> |
| CAN Request 15                                    | CAN_15IC                | xx'013C <sub>H</sub>                | 4F <sub>H</sub> / 79 <sub>D</sub> |
| USIC0 Cannel 0, Request 0                         | U0C0_0IC                | xx'0140 <sub>H</sub>                | 50 <sub>H</sub> / 80 <sub>D</sub> |
| USIC0 Cannel 0, Request 1                         | U0C0_1IC                | xx'0144 <sub>H</sub>                | 51 <sub>H</sub> / 81 <sub>D</sub> |
| USIC0 Cannel 0, Request 2                         | U0C0_2IC                | xx'0148 <sub>H</sub>                | 52 <sub>H</sub> / 82 <sub>D</sub> |
| USIC0 Cannel 1, Request 0                         | U0C1_0IC                | xx'014C <sub>H</sub>                | 53 <sub>H</sub> / 83 <sub>D</sub> |
| USIC0 Cannel 1, Request 1                         | U0C1_1IC                | xx'0150 <sub>H</sub>                | 54 <sub>H</sub> / 84 <sub>D</sub> |
| USIC0 Cannel 1, Request 2                         | U0C1_2IC                | xx'0154 <sub>H</sub>                | 55 <sub>H</sub> / 85 <sub>D</sub> |
| USIC1 Cannel 0, Request 0                         | U1C0_0IC                | xx'0158 <sub>H</sub>                | 56 <sub>H</sub> / 86 <sub>D</sub> |
| USIC1 Cannel 0, Request 1                         | U1C0_1IC                | xx'015C <sub>H</sub>                | 57 <sub>H</sub> / 87 <sub>D</sub> |
| USIC1 Cannel 0, Request 2                         | U1C0_2IC                | xx'0160 <sub>H</sub>                | 58 <sub>H</sub> / 88 <sub>D</sub> |
| USIC1 Cannel 1, Request 0                         | U1C1_0IC                | xx'0164 <sub>H</sub>                | 59 <sub>H</sub> / 89 <sub>D</sub> |
| USIC1 Cannel 1, Request 1                         | U1C1_1IC                | xx'0168 <sub>H</sub>                | 5A <sub>H</sub> / 90 <sub>D</sub> |
| USIC1 Cannel 1, Request 2                         | U1C1_2IC                | xx'016C <sub>H</sub>                | 5B <sub>H</sub> / 91 <sub>D</sub> |
| USIC2 Cannel 0, Request 0                         | U2C0_0IC                | xx'0170 <sub>H</sub>                | 5C <sub>H</sub> / 92 <sub>D</sub> |
| USIC2 Cannel 0, Request 1                         | U2C0_1IC                | xx'0174 <sub>H</sub>                | 5D <sub>H</sub> / 93 <sub>D</sub> |
| USIC2 Cannel 0, Request 2                         | U2C0_2IC                | xx'0178 <sub>H</sub>                | 5E <sub>H</sub> / 94 <sub>D</sub> |

**Functional Description**

**Table 6      XE164 Interrupt Nodes (cont'd)**

| <b>Source of Interrupt or PEC Service Request</b> | <b>Control Register</b> | <b>Vector Location<sup>1)</sup></b> | <b>Trap Number</b>                 |
|---|-------------------------|-------------------------------------|------------------------------------|
| USIC2 Cannel 1, Request 0                         | U2C1_0IC                | xx'017C <sub>H</sub>                | 5F <sub>H</sub> / 95 <sub>D</sub>  |
| USIC2 Cannel 1, Request 1                         | U2C1_1IC                | xx'0180 <sub>H</sub>                | 60 <sub>H</sub> / 96 <sub>D</sub>  |
| USIC2 Cannel 1, Request 2                         | U2C1_2IC                | xx'0184 <sub>H</sub>                | 61 <sub>H</sub> / 97 <sub>D</sub>  |
| Unassigned node                                   | –                       | xx'0188 <sub>H</sub>                | 62 <sub>H</sub> / 98 <sub>D</sub>  |
| Unassigned node                                   | –                       | xx'018C <sub>H</sub>                | 63 <sub>H</sub> / 99 <sub>D</sub>  |
| Unassigned node                                   | –                       | xx'0190 <sub>H</sub>                | 64 <sub>H</sub> / 100 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'0194 <sub>H</sub>                | 65 <sub>H</sub> / 101 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'0198 <sub>H</sub>                | 66 <sub>H</sub> / 102 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'019C <sub>H</sub>                | 67 <sub>H</sub> / 103 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'01A0 <sub>H</sub>                | 68 <sub>H</sub> / 104 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'01A4 <sub>H</sub>                | 69 <sub>H</sub> / 105 <sub>D</sub> |
| Unassigned node                                   | –                       | xx'01A8 <sub>H</sub>                | 6A <sub>H</sub> / 106 <sub>D</sub> |
| SCU Request 1                                     | SCU_1IC                 | xx'01AC <sub>H</sub>                | 6B <sub>H</sub> / 107 <sub>D</sub> |
| SCU Request 0                                     | SCU_0IC                 | xx'01B0 <sub>H</sub>                | 6C <sub>H</sub> / 108 <sub>D</sub> |
| Program Flash Modules                             | PFM_IC                  | xx'01B4 <sub>H</sub>                | 6D <sub>H</sub> / 109 <sub>D</sub> |
| RTC   | RTC_IC                  | xx'01B8 <sub>H</sub>                | 6E <sub>H</sub> / 110 <sub>D</sub> |
| End of PEC Subchannel                             | EOPIC                   | xx'01BC <sub>H</sub>                | 6F <sub>H</sub> / 111 <sub>D</sub> |

- 1) Register VECSEG defines the segment where the vector table is located.  
 Bitfield VECSC in register CPUCON1 defines the distance between two adjacent vectors. This table represents the default setting with a distance of 4 (two words) between two vectors.

## Functional Description

The XE164 includes an excellent mechanism to identify and process exceptions or error conditions that arise during run-time, the so-called 'Hardware Traps'. A hardware trap causes an immediate non-maskable system reaction similar to a standard interrupt service (branching to a dedicated vector table location). The occurrence of a hardware trap is also indicated by a single bit in the trap flag register (TFR). Unless another higher-priority trap service is in progress, a hardware trap will interrupt any ongoing program execution. In turn, hardware trap services can normally not be interrupted by standard or PEC interrupts.

**Table 7** shows all possible exceptions or error conditions that can arise during runtime:

**Table 7      Trap Summary**

| Exception Condition           | Trap Flag | Trap Vector | Vector Location <sup>1)</sup>  | Trap Number                          | Trap Priority |
|-------------------------------|-----------|-------------|--|--------------------------------------|---------------|
| Reset Functions               | —         | RESET       | xx'0000 <sub>H</sub>   | 00 <sub>H</sub>                      | III           |
| Class A Hardware Traps:       |           |             |  |                                      |               |
| • System Request 0            | SR0       | SR0TRAP     | xx'0008 <sub>H</sub>   | 02 <sub>H</sub>                      | II            |
| • Stack Overflow              | STKOF     | STOTRAP     | xx'0010 <sub>H</sub>   | 04 <sub>H</sub>                      | II            |
| • Stack Underflow             | STKUF     | STUTRAP     | xx'0018 <sub>H</sub>   | 06 <sub>H</sub>                      | II            |
| • Software Break              | SOFTBRK   | SBRKTRAP    | xx'0020 <sub>H</sub>   | 08 <sub>H</sub>                      | II            |
| Class B Hardware Traps:       |           |             |  |                                      |               |
| • System Request 1            | SR1       | BTRAP       | xx'0028 <sub>H</sub>   | 0A <sub>H</sub>                      | I             |
| • Undefined Opcode            | UNDOPC    | BTRAP       | xx'0028 <sub>H</sub>   | 0A <sub>H</sub>                      | I             |
| • Memory Access Error         | ACER      | BTRAP       | xx'0028 <sub>H</sub>   | 0A <sub>H</sub>                      | I             |
| • Protected Instruction Fault | PRTFLT    | BTRAP       | xx'0028 <sub>H</sub>   | 0A <sub>H</sub>                      | I             |
| • Illegal Word Operand Access | ILLOPA    | BTRAP       | xx'0028 <sub>H</sub>   | 0A <sub>H</sub>                      | I             |
| Reserved                      | —         | —           | [2C <sub>H</sub> - 3C <sub>H</sub> ]   | [0B <sub>H</sub> - 0F <sub>H</sub> ] | —             |
| Software Traps:               | —         | —           | Any  | Any                                  | Current       |
| • TRAP Instruction            |           |             | [xx'0000 <sub>H</sub> - xx'01FC <sub>H</sub> ]<br>in steps of 4 <sub>H</sub> | [00 <sub>H</sub> - 7F <sub>H</sub> ] | CPU Priority  |

1) Register VECSEG defines the segment where the vector table is located to.

Bitfield VECSC in register CPUCON1 defines the distance between two adjacent vectors. This table represents the default setting, with a distance of 4 (two words) between two vectors.

### **3.5 On-Chip Debug Support (OCDS)**

The On-Chip Debug Support system built into the XE164 provides a broad range of debug and emulation features. User software running on the XE164 can be debugged within the target system environment.

The OCDS is controlled by an external debugging device via the debug interface. This consists of the JTAG port conforming to IEEE-1149. The debug interface can be completed with an optional break interface.

The debugger controls the OCDS with a set of dedicated registers accessible via the debug interface (JTAG). In addition the OCDS system can be controlled by the CPU, e.g. by a monitor program. An injection interface allows the execution of OCDS-generated instructions by the CPU.

Multiple breakpoints can be triggered by on-chip hardware, by software, or by an external trigger input. Single stepping is supported, as is the injection of arbitrary instructions and read/write access to the complete internal address space. A breakpoint trigger can be answered with a CPU halt, a monitor call, a data transfer, or/and the activation of an external signal.

Tracing data can be obtained via the debug interface, or via the external bus interface for increased performance.

The JTAG interface uses four interface signals, to communicate with external circuitry. The debug interface can be amended with two optional break lines.

### **3.6 Capture/Compare Unit (CAPCOM2)**

The CAPCOM2 unit supports generation and control of timing sequences on up to 16 channels with a maximum resolution of one system clock cycle (eight cycles in staggered mode). The CAPCOM2 unit is typically used to handle high-speed I/O tasks such as pulse and waveform generation, pulse width modulation (PWM), digital to analog (D/A) conversion, software timing, or time recording with respect to external events.

Two 16-bit timers (T7/T8) with reload registers provide two independent time bases for the capture/compare register array.

The input clock for the timers is programmable to a number of prescaled values of the internal system clock. It may also be derived from an overflow/underflow of timer T6 in module GPT2. This provides a wide range for the timer period and resolution while allowing precise adjustments for application-specific requirements. An external count input for CAPCOM2 timer T7 allows event scheduling for the capture/compare registers with respect to external events.

The capture/compare register array contains 16 dual purpose capture/compare registers. Each may be individually allocated to either CAPCOM2 timer T7 or T8 and programmed for a capture or compare function.

12 registers of the CAPCOM2 module have one port pin associated with it. This serves as an input pin to trigger the capture function or as an output pin to indicate the occurrence of a compare event.

**Table 8 Compare Modes (CAPCOM2)**

| <b>Compare Modes</b> | <b>Function</b>   |
|----------------------|---|
| Mode 0               | Interrupt-only compare mode;<br>Several compare interrupts per timer period are possible  |
| Mode 1               | Pin toggles on each compare match;<br>Several compare events per timer period are possible                                      |
| Mode 2               | Interrupt-only compare mode;<br>Only one compare interrupt per timer period is generated  |
| Mode 3               | Pin set '1' on match; pin reset '0' on compare timer overflow;<br>Only one compare event per timer period is generated          |
| Double Register Mode | Two registers operate on one pin;<br>Pin toggles on each compare match;<br>Several compare events per timer period are possible |
| Single Event Mode    | Generates single edges or pulses;<br>Can be used with any compare mode  |

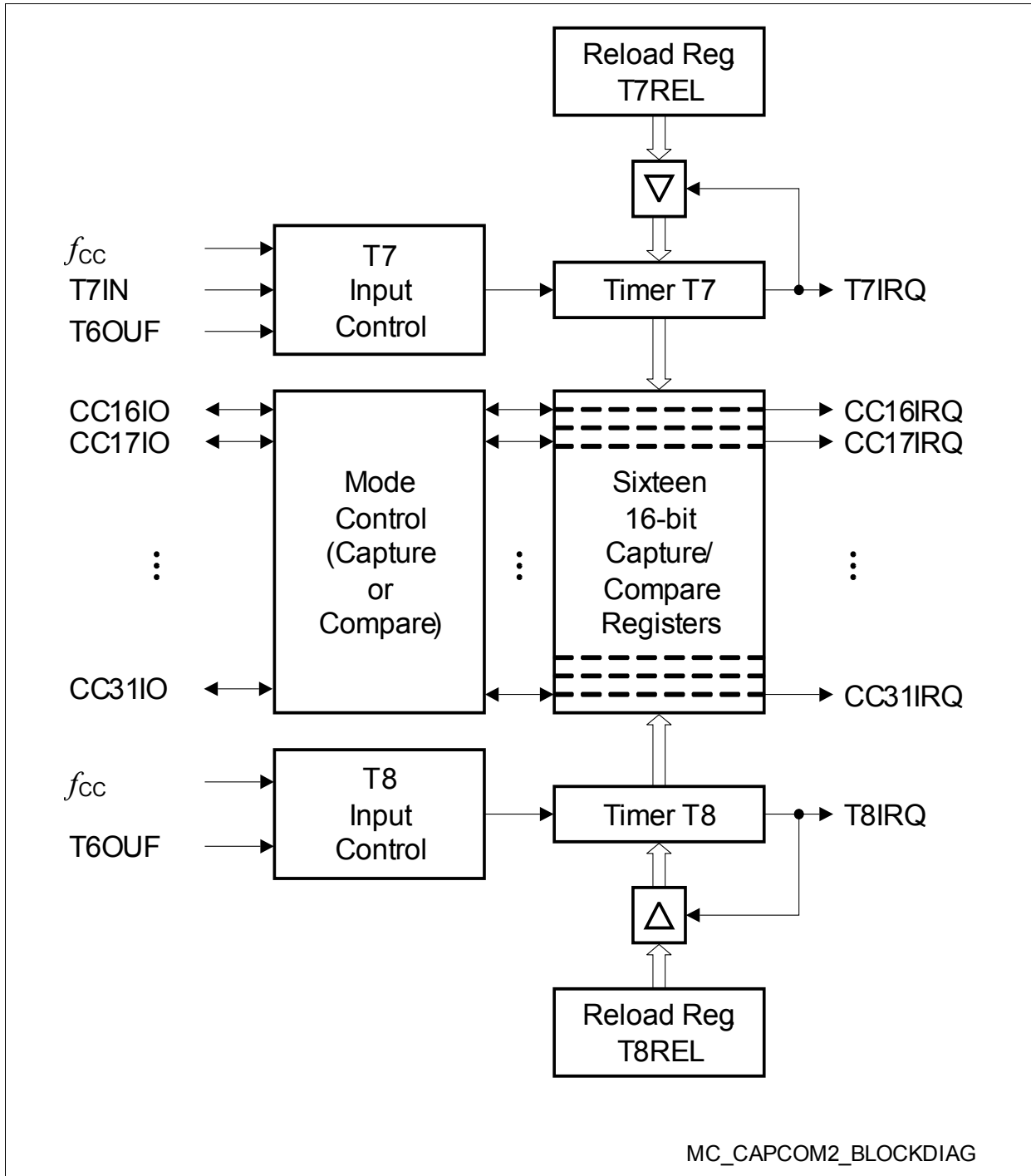
**Functional Description**

When a capture/compare register has been selected for capture mode, the current contents of the allocated timer will be latched ('captured') into the capture/compare register in response to an external event at the port pin associated with this register. In addition, a specific interrupt request for this capture/compare register is generated. Either a positive, a negative, or both a positive and a negative external signal transition at the pin can be selected as the triggering event.

The contents of all registers selected for one of the five compare modes are continuously compared with the contents of the allocated timers.

When a match occurs between the timer value and the value in a capture/compare register, specific actions will be taken based on the compare mode selected.





**Figure 5 CAPCOM2 Unit Block Diagram**

### **3.7 Capture/Compare Units CCU6x**

The XE164 features up to three CCU6 units (CCU60, CCU61, CCU62).

The CCU6 is a high-resolution capture and compare unit with application-specific modes. It provides inputs to start the timers synchronously, an important feature in devices with several CCU6 modules.

The module provides two independent timers (T12, T13), that can be used for PWM generation, especially for AC motor control. Additionally, special control modes for block commutation and multi-phase machines are supported.

#### **Timer 12 Features**

- Three capture/compare channels, where each channel can be used either as a capture or as a compare channel.
- Supports generation of a three-phase PWM (six outputs, individual signals for high-side and low-side switches)
- 16-bit resolution, maximum count frequency = peripheral clock
- Dead-time control for each channel to avoid short circuits in the power stage
- Concurrent update of the required T12/13 registers
- Center-aligned and edge-aligned PWM can be generated
- Single-shot mode supported
- Many interrupt request sources
- Hysteresis-like control mode
- Automatic start on a HW event (T12HR, for synchronization purposes)

#### **Timer 13 Features**

- One independent compare channel with one output
- 16-bit resolution, maximum count frequency = peripheral clock
- Can be synchronized to T12
- Interrupt generation at period match and compare match
- Single-shot mode supported
- Automatic start on a HW event (T13HR, for synchronization purposes)

#### **Additional Features**

- Block commutation for brushless DC drives implemented
- Position detection via Hall sensor pattern
- Automatic rotational speed measurement for block commutation
- Integrated error handling
- Fast emergency stop without CPU load via external signal ( $\overline{\text{CTRAP}}$ )
- Control modes for multi-channel AC drives
- Output levels can be selected and adapted to the power stage



**Figure 6 CCU6 Block Diagram**

Timer T12 can work in capture and/or compare mode for its three channels. The modes can also be combined. Timer T13 can work in compare mode only. The multi-channel control unit generates output patterns that can be modulated by timer T12 and/or timer T13. The modulation sources can be selected and combined for signal modulation.

### **3.8 General Purpose Timer (GPT12E) Unit**

The GPT12E unit is a very flexible multifunctional timer/counter structure which can be used for many different timing tasks such as event timing and counting, pulse width and duty cycle measurements, pulse generation, or pulse multiplication.

The GPT12E unit incorporates five 16-bit timers organized in two separate modules, GPT1 and GPT2. Each timer in each module may either operate independently in a number of different modes or be concatenated with another timer of the same module.

Each of the three timers T2, T3, T4 of **module GPT1** can be configured individually for one of four basic modes of operation: Timer, Gated Timer, Counter, and Incremental Interface Mode. In Timer Mode, the input clock for a timer is derived from the system clock and divided by a programmable prescaler. Counter Mode allows timer clocking in reference to external events.

Pulse width or duty cycle measurement is supported in Gated Timer Mode, where the operation of a timer is controlled by the 'gate' level on an external input pin. For these purposes each timer has one associated port pin (TxIN<sup>1)</sup>) which serves as a gate or clock input. The maximum resolution of the timers in module GPT1 is 4 system clock cycles.

The counting direction (up/down) for each timer can be programmed by software or altered dynamically by an external signal on a port pin (TxEUD<sup>1)</sup>), e.g. to facilitate position tracking.

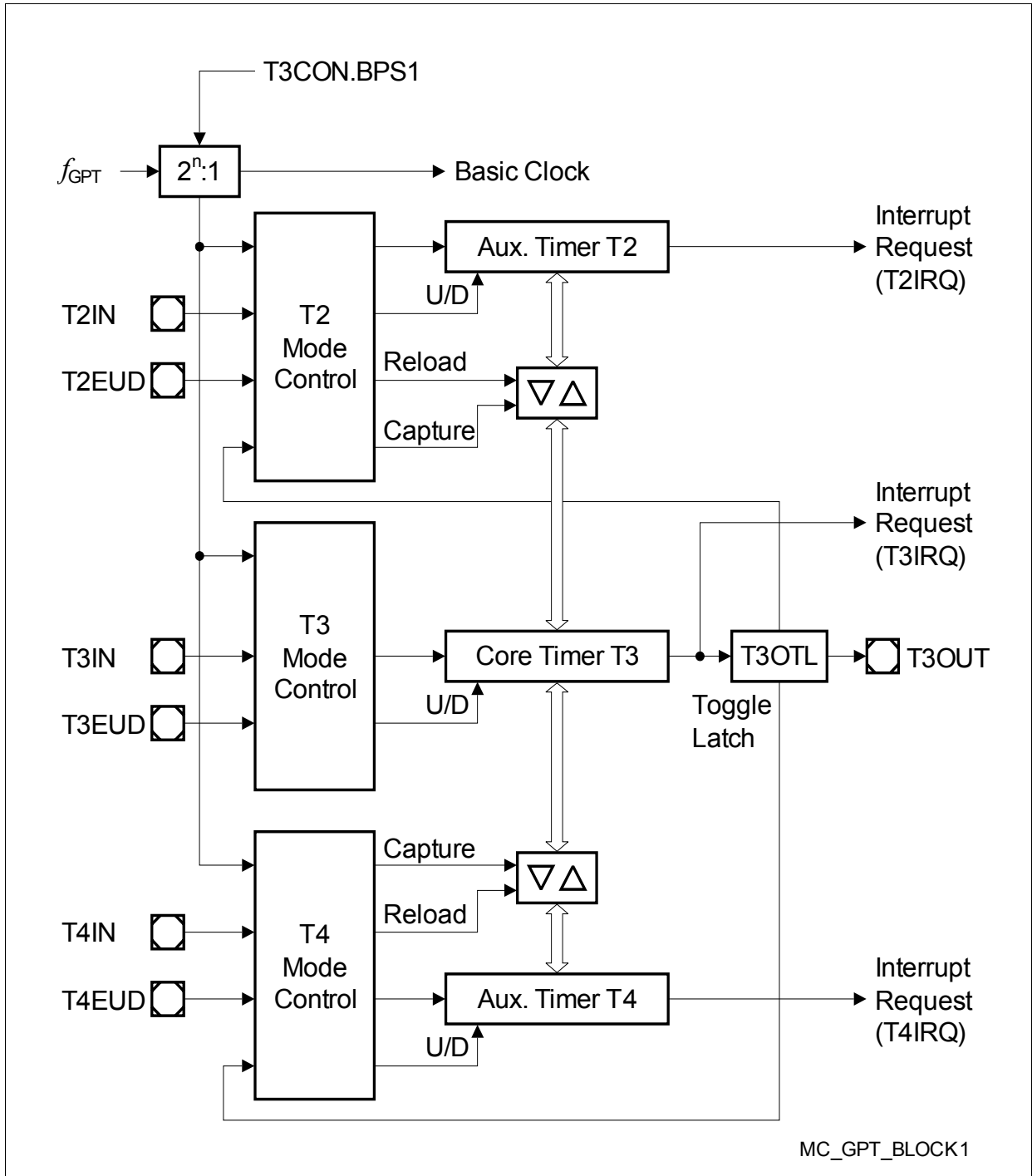
In Incremental Interface Mode the GPT1 timers<sup>1)</sup> can be directly connected to the incremental position sensor signals A and B through their respective inputs TxIN and TxEUD. Direction and counting signals are internally derived from these two input signals, so that the contents of the respective timer Tx corresponds to the sensor position. The third position sensor signal TOP0 can be connected to an interrupt input.

Timer T3 has an output toggle latch (T3OTL) which changes its state on each timer overflow/underflow. The state of this latch may be output on pin T3OUT e.g. for time out monitoring of external hardware components. It may also be used internally to clock timers T2 and T4 for measuring long time periods with high resolution.

In addition to the basic operating modes, T2 may be configured as reload or capture register for timer T3. A timer used as capture or reload register is stopped. The contents of timer T3 is captured into T2 in response to a signal at the associated input pin (TxIN). Timer T3 is reloaded with the contents of T2, triggered either by an external signal or a selectable state transition of its toggle latch T3OTL.

---

1) Exception: Timer T4 is not connected to pins.



**Figure 7**      **Block Diagram of GPT1**

**Functional Description**

With its maximum resolution of 2 system clock cycles, the **GPT2 module** provides precise event control and time measurement. It includes two timers (T5, T6) and a capture/reload register (CAPREL). Both timers can be clocked with an input clock which is derived from the CPU clock via a programmable prescaler or with external signals. The counting direction (up/down) for each timer can be programmed by software or altered dynamically with an external signal on a port pin (TxEUD<sup>1)</sup>). Concatenation of the timers is supported with the output toggle latch (T6OTL) of timer T6, which changes its state on each timer overflow/underflow.

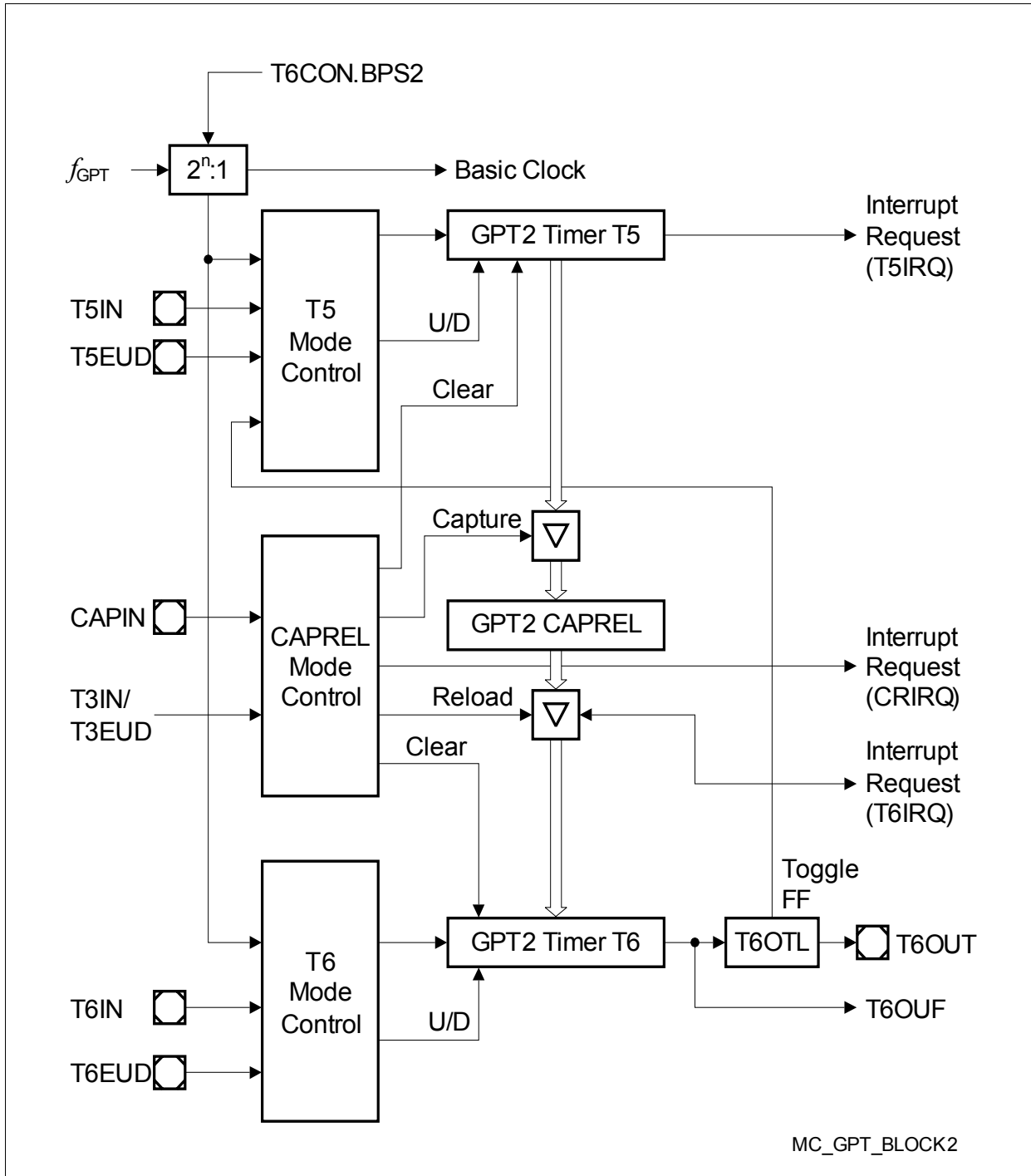
The state of this latch may be used to clock timer T5, and/or it may be output on pin T6OUT. The overflows/underflows of timer T6 can also be used to clock the CAPCOM2 timers and to initiate a reload from the CAPREL register.

The CAPREL register can capture the contents of timer T5 based on an external signal transition on the corresponding port pin (CAPIN); timer T5 may optionally be cleared after the capture procedure. This allows the XE164 to measure absolute time differences or to perform pulse multiplication without software overhead.

The capture trigger (timer T5 to CAPREL) can also be generated upon transitions of GPT1 timer T3 inputs T3IN and/or T3EUD. This is especially advantageous when T3 operates in Incremental Interface Mode.

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1) Exception: T5EUD is not connected to a pin.



**Figure 8 Block Diagram of GPT2**

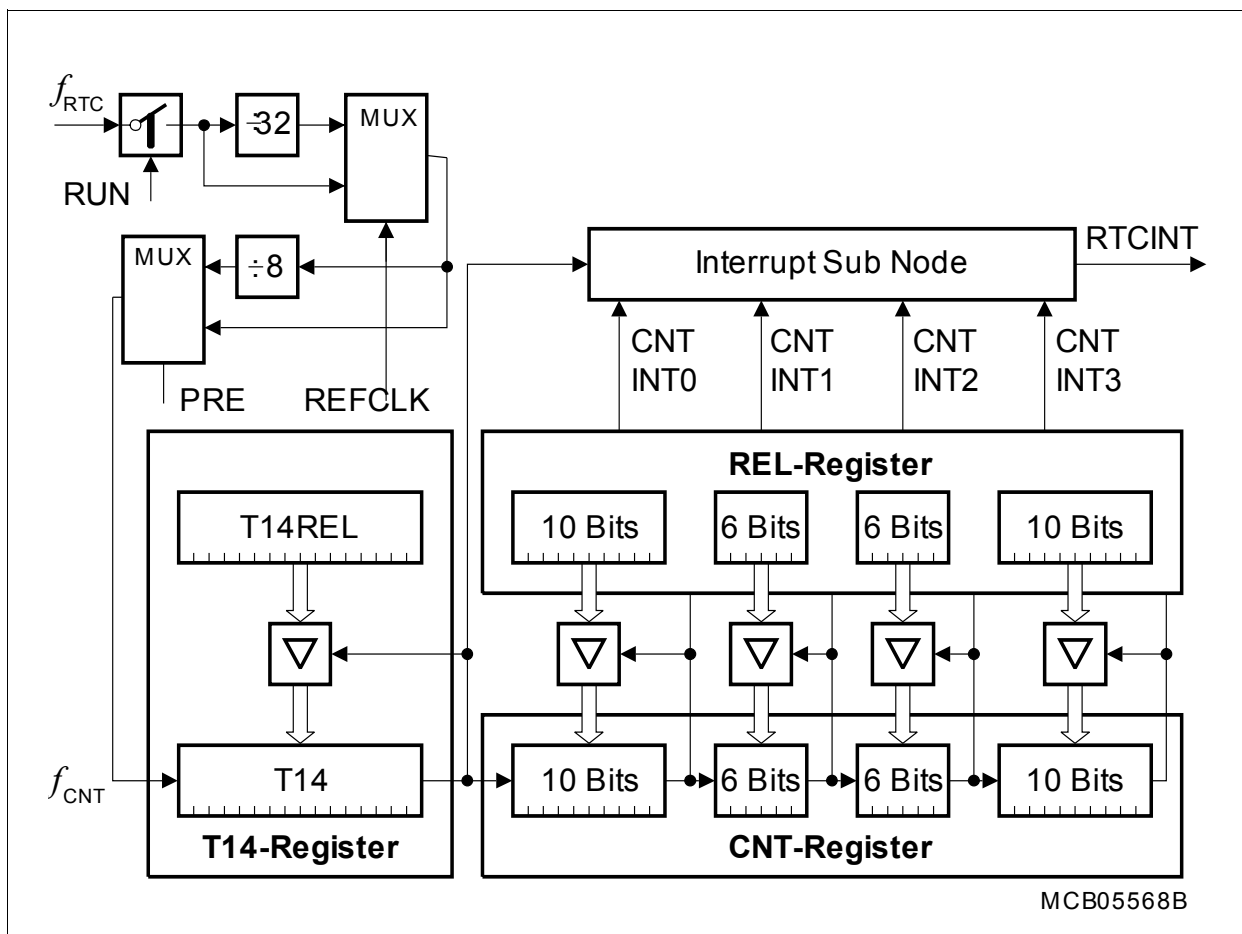
### 3.9 Real Time Clock

The Real Time Clock (RTC) module of the XE164 can be clocked with a clock signal selected from internal sources or external sources (pins).

The RTC basically consists of a chain of divider blocks:

- Selectable 32:1 and 8:1 dividers (on - off)
- The reloadable 16-bit timer T14
- The 32-bit RTC timer block (accessible via registers RTCH and RTCL) consisting of:
  - a reloadable 10-bit timer
  - a reloadable 6-bit timer
  - a reloadable 6-bit timer
  - a reloadable 10-bit timer

All timers count up. Each timer can generate an interrupt request. All requests are combined to a common node request.



**Figure 9 RTC Block Diagram**

*Note: The registers associated with the RTC are only affected by a power reset.*



**Functional Description**

The RTC module can be used for different purposes:

- System clock to determine the current time and date
- Cyclic time-based interrupt, to provide a system time tick independent of CPU frequency and other resources
- 48-bit timer for long-term measurements
- Alarm interrupt at a defined time

### **3.10 A/D Converters**

For analog signal measurement, up to two 10-bit A/D converters (ADC0, ADC1) with 11 + 5 multiplexed input channels and a sample and hold circuit have been integrated on-chip. They use the successive approximation method. The sample time (to charge the capacitors) and the conversion time are programmable so that they can be adjusted to the external circuit. The A/D converters can also operate in 8-bit conversion mode, further reducing the conversion time.

Several independent conversion result registers, selectable interrupt requests, and highly flexible conversion sequences provide a high degree of programmability to meet the application requirements. Both modules can be synchronized to allow parallel sampling of two input channels.

For applications that require more analog input channels, external analog multiplexers can be controlled automatically.

For applications that require fewer analog input channels, the remaining channel inputs can be used as digital input port pins.

The A/D converters of the XE164 support two types of request sources which can be triggered by several internal and external events.

- Parallel requests are activated at the same time and then executed in a predefined sequence.
- Queued requests are executed in a user-defined sequence.

In addition, the conversion of a specific channel can be inserted into a running sequence without disturbing that sequence. All requests are arbitrated according to the priority level assigned to them.

Data reduction features, such as limit checking or result accumulation, reduce the number of required CPU access operations allowing the precise evaluation of analog inputs (high conversion rate) even at a low CPU speed.

The Peripheral Event Controller (PEC) can be used to control the A/D converters or to automatically store conversion results to a table in memory for later evaluation, without requiring the overhead of entering and exiting interrupt routines for each data transfer. Each A/D converter contains eight result registers which can be concatenated to build a result FIFO. Wait-for-read mode can be enabled for each result register to prevent the loss of conversion data.

In order to decouple analog inputs from digital noise and to avoid input trigger noise, those pins used for analog input can be disconnected from the digital input stages under software control. This can be selected for each pin separately with registers P5\_DIDIS and P15\_DIDIS (Port x Digital Input Disable).

The Auto-Power-Down feature of the A/D converters minimizes the power consumption when no conversion is in progress.

### 3.11 Universal Serial Interface Channel Modules (USIC)

The XE164 includes up to three USIC modules (USIC0, USIC1, USIC2), each providing two serial communication channels.

The Universal Serial Interface Channel (USIC) module is based on a generic data shift and data storage structure which is identical for all supported serial communication protocols. Each channel supports complete full-duplex operation with a basic data buffer structure (one transmit buffer and two receive buffer stages). In addition, the data handling software can use FIFOs.

The protocol part (generation of shift clock/data/control signals) is independent of the general part and is handled by protocol-specific preprocessors (PPPs).

The USIC's input/output lines are connected to pins by a pin routing unit. The inputs and outputs of each USIC channel can be assigned to different interface pins, providing great flexibility to the application software. All assignments can be made during runtime.



**Figure 10 General Structure of a USIC Module**

The regular structure of the USIC module brings the following advantages:

- Higher flexibility through configuration with same look-and-feel for data management
- Reduced complexity for low-level drivers serving different protocols
- Wide range of protocols with improved performances (baud rate, buffer handling)

**Target Protocols**

Each USIC channel can receive and transmit data frames with a selectable data word width from 1 to 16 bits in each of the following protocols:

- **UART** (asynchronous serial channel)
  - maximum baud rate:  $f_{\text{SYS}} / 4$
  - data frame length programmable from 1 to 63 bits
  - MSB or LSB first
- **LIN** Support (Local Interconnect Network)
  - maximum baud rate:  $f_{\text{SYS}} / 16$
  - checksum generation under software control
  - baud rate detection possible by built-in capture event of baud rate generator
- **SSC/SPI/QSPI** (synchronous serial channel with or without data buffer)
  - maximum baud rate in slave mode:  $f_{\text{SYS}}$
  - maximum baud rate in master mode:  $f_{\text{SYS}} / 2$ , limited by loop delay
  - number of data bits programmable from 1 to 63, more with explicit stop condition
  - MSB or LSB first
  - optional control of slave select signals
- **IIC** (Inter-IC Bus)
  - supports baud rates of 100 kbit/s and 400 kbit/s
- **IIS** (Inter-IC Sound Bus)
  - maximum baud rate:  $f_{\text{SYS}} / 2$  for transmitter,  $f_{\text{SYS}}$  for receiver

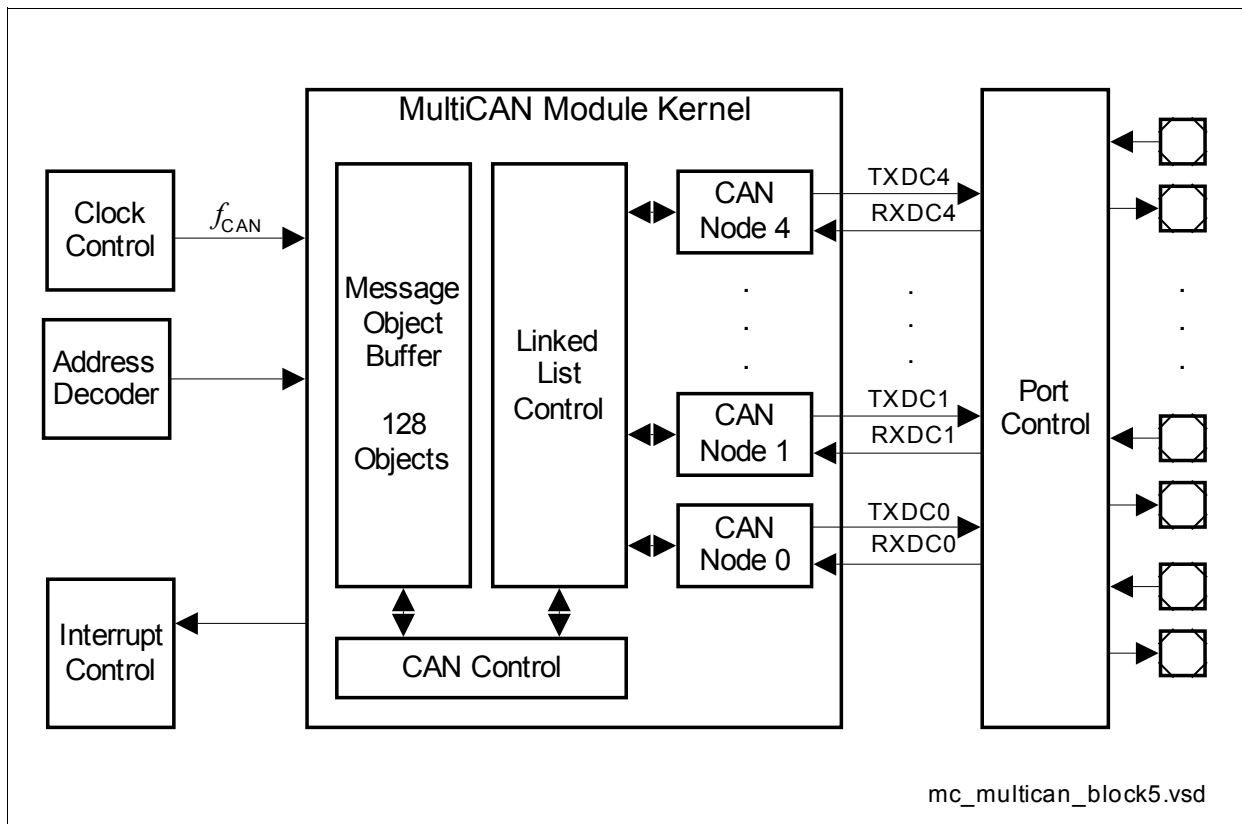
*Note: Depending on the selected functions (such as digital filters, input synchronization stages, sample point adjustment, etc.), the maximum achievable baud rate can be limited. Please note that there may be additional delays, such as internal or external propagation delays and driver delays (e.g. for collision detection in UART mode, for IIC, etc.).*

### 3.12 MultiCAN Module

The MultiCAN module contains up to four independently operating CAN nodes with Full-CAN functionality which are able to exchange Data and Remote Frames using a gateway function. Transmission and reception of CAN frames is handled in accordance with CAN specification V2.0 B (active). Each CAN node can receive and transmit standard frames with 11-bit identifiers as well as extended frames with 29-bit identifiers.

All CAN nodes share a common set of 128 message objects. Each message object can be individually allocated to one of the CAN nodes. Besides serving as a storage container for incoming and outgoing frames, message objects can be combined to build gateways between the CAN nodes or to set up a FIFO buffer.

The message objects are organized in double-chained linked lists, where each CAN node has its own list of message objects. A CAN node stores frames only into message objects that are allocated to its own message object list and it transmits only messages belonging to this message object list. A powerful, command-driven list controller performs all message object list operations.



**Figure 11 Block Diagram of MultiCAN Module**

### **MultiCAN Features**

- CAN functionality conforming to CAN specification V2.0 B active for each CAN node (compliant to ISO 11898)
- Up to four independent CAN nodes
- 128 independent message objects (shared by the CAN nodes)
- Dedicated control registers for each CAN node
- Data transfer rate up to 1 Mbit/s, individually programmable for each node
- Flexible and powerful message transfer control and error handling capabilities
- Full-CAN functionality for message objects:
  - Can be assigned to one of the CAN nodes
  - Configurable as transmit or receive objects, or as message buffer FIFO
  - Handle 11-bit or 29-bit identifiers with programmable acceptance mask for filtering
  - Remote Monitoring Mode, and frame counter for monitoring
- Automatic Gateway Mode support
- 16 individually programmable interrupt nodes
- Analyzer mode for CAN bus monitoring

### **3.13 Watchdog Timer**

The Watchdog Timer is one of the fail-safe mechanisms which have been implemented to prevent the controller from malfunctioning for longer periods of time.

The Watchdog Timer is always enabled after an application reset of the chip. It can be disabled and enabled at any time by executing the instructions DISWDT and ENWDT respectively. The software has to service the Watchdog Timer before it overflows. If this is not the case because of a hardware or software failure, the Watchdog Timer overflows, generating a prewarning interrupt and then a reset request.

The Watchdog Timer is a 16-bit timer clocked with the system clock divided by 16,384 or 256. The Watchdog Timer register is set to a prespecified reload value (stored in WDTREL) in order to allow further variation of the monitored time interval. Each time it is serviced by the application software, the Watchdog Timer is reloaded and the prescaler is cleared.

Time intervals between 3.2  $\mu$ s and 13.4 s can be monitored (@ 80 MHz).

The default Watchdog Timer interval after power-up is 6.5 ms (@ 10 MHz).

### **3.14 Clock Generation**

The Clock Generation Unit can generate the system clock signal  $f_{\text{SYS}}$  for the XE164 from a number of external or internal clock sources:

- External clock signals with pad or core voltage levels
- External crystal using the on-chip oscillator
- On-chip clock source for operation without crystal
- Wake-up clock (ultra-low-power) to further reduce power consumption

The programmable on-chip PLL with multiple prescalers generates a clock signal for maximum system performance from standard crystals or from the on-chip clock source. See also [Section 4.6.2](#).

The Oscillator Watchdog (OWD) generates an interrupt if the crystal oscillator frequency falls below a certain limit or stops completely. In this case, the system can be supplied with an emergency clock to enable operation even after an external clock failure.

All available clock signals can be output on one of two selectable pins.

### 3.15 Parallel Ports

The XE164 provides up to 75 I/O lines which are organized into 7 input/output ports and 2 input ports. All port lines are bit-addressable, and all input/output lines can be individually (bit-wise) configured via port control registers. This configuration selects the direction (input/output), push/pull or open-drain operation, activation of pull devices, and edge characteristics (shape) and driver characteristics (output current) of the port drivers. The I/O ports are true bidirectional ports which are switched to high impedance state when configured as inputs. During the internal reset, all port pins are configured as inputs without pull devices active.

All port lines have alternate input or output functions associated with them. These alternate functions can be programmed to be assigned to various port pins to support the best utilization for a given application. For this reason, certain functions appear several times in [Table 9](#).

All port lines that are not used for alternate functions may be used as general purpose I/O lines.

**Table 9 Summary of the XE164's Parallel Ports**

| Port   | Width | Alternate Functions   |
|--------|-------|---|
| Port 0 | 8     | Address lines,<br>Serial interface lines of USIC1, CAN0, and CAN1,<br>Input/Output lines for CCU61  |
| Port 1 | 8     | Address lines,<br>Serial interface lines of USIC1 and USIC2,<br>Input/Output lines for CCU62,<br>OCDS control, interrupts   |
| Port 2 | 13    | Address and/or data lines, bus control,<br>Serial interface lines of USIC0, CAN0, and CAN1,<br>Input/Output lines for CCU60 and CAPCOM2,<br>Timer control signals,<br>JTAG, interrupts, system clock output |
| Port 4 | 8     | Chip select signals,<br>Serial interface lines of CAN2,<br>Input/Output lines for CAPCOM2,<br>Timer control signals   |
| Port 5 | 16    | Analog input channels to ADC0,<br>Input/Output lines for CCU6x,<br>Timer control signals,<br>JTAG, OCDS control, interrupts   |



**Table 9      Summary of the XE164's Parallel Ports (cont'd)**

| <b>Port</b> | <b>Width</b> | <b>Alternate Functions</b>   |
|-------------|--------------|--|
| Port 6      | 4            | ADC control lines,<br>Serial interface lines of USIC1,<br>Timer control signals,<br>OCDS control   |
| Port 7      | 5            | ADC control lines,<br>Serial interface lines of USIC0,<br>Input/Output lines for CCU62,<br>Timer control signals,<br>JTAG, OCDS control, system clock output |
| Port 10     | 16           | Address and/or data lines, bus control,<br>Serial interface lines of USIC0, USIC1, CAN2 and CAN3,<br>Input/Output lines for CCU60,<br>JTAG, OCDS control     |
| Port 15     | 8            | Analog input channels to ADC1,<br>Timer control signals  |

### 3.16 Instruction Set Summary

**Table 10** lists the instructions of the XE164.

The addressing modes that can be used with a specific instruction, the function of the instructions, parameters for conditional execution of instructions, and the opcodes for each instruction can be found in the “**Instruction Set Manual**”.

This document also provides a detailed description of each instruction.

**Table 10 Instruction Set Summary**

| Mnemonic      | Description  | Bytes |
|---------------|--|-------|
| ADD(B)        | Add word (byte) operands   | 2 / 4 |
| ADDC(B)       | Add word (byte) operands with Carry  | 2 / 4 |
| SUB(B)        | Subtract word (byte) operands  | 2 / 4 |
| SUBC(B)       | Subtract word (byte) operands with Carry   | 2 / 4 |
| MUL(U)        | (Un)Signed multiply direct GPR by direct GPR<br>(16- × 16-bit)                                       | 2     |
| DIV(U)        | (Un)Signed divide register MDL by direct GPR (16-/16-bit)  | 2     |
| DIVL(U)       | (Un)Signed long divide reg. MD by direct GPR (32-/16-bit)  | 2     |
| CPL(B)        | Complement direct word (byte) GPR  | 2     |
| NEG(B)        | Negate direct word (byte) GPR  | 2     |
| AND(B)        | Bitwise AND, (word/byte operands)  | 2 / 4 |
| OR(B)         | Bitwise OR, (word/byte operands)   | 2 / 4 |
| XOR(B)        | Bitwise exclusive OR, (word/byte operands)   | 2 / 4 |
| BCLR/BSET     | Clear/Set direct bit   | 2     |
| BMOV(N)       | Move (negated) direct bit to direct bit  | 4     |
| BAND/BOR/BXOR | AND/OR/XOR direct bit with direct bit  | 4     |
| BCMP          | Compare direct bit to direct bit   | 4     |
| BFLDH/BFLDL   | Bitwise modify masked high/low byte of bit-addressable<br>direct word memory with immediate data     | 4     |
| CMP(B)        | Compare word (byte) operands   | 2 / 4 |
| CMPD1/2       | Compare word data to GPR and decrement GPR by 1/2  | 2 / 4 |
| CMPI1/2       | Compare word data to GPR and increment GPR by 1/2  | 2 / 4 |
| PRIOR         | Determine number of shift cycles to normalize direct<br>word GPR and store result in direct word GPR | 2     |
| SHL/SHR       | Shift left/right direct word GPR   | 2     |

**Functional Description**

**Table 10 Instruction Set Summary (cont'd)**

| <b>Mnemonic</b> | <b>Description</b>   | <b>Bytes</b> |
|-----------------|--|--------------|
| ROL/ROR         | Rotate left/right direct word GPR  | 2            |
| ASHR            | Arithmetic (sign bit) shift right direct word GPR  | 2            |
| MOV(B)          | Move word (byte) data  | 2 / 4        |
| MOVBS/Z         | Move byte operand to word op. with sign/zero extension                                   | 2 / 4        |
| JMPA/I/R        | Jump absolute/indirect/relative if condition is met                                      | 4            |
| JMPS            | Jump absolute to a code segment  | 4            |
| JB(C)           | Jump relative if direct bit is set (and clear bit)                                       | 4            |
| JNB(S)          | Jump relative if direct bit is not set (and set bit)                                     | 4            |
| CALLA/I/R       | Call absolute/indirect/relative subroutine if condition is met                           | 4            |
| CALLS           | Call absolute subroutine in any code segment   | 4            |
| PCALL           | Push direct word register onto system stack and call absolute subroutine                 | 4            |
| TRAP            | Call interrupt service routine via immediate trap number                                 | 2            |
| PUSH/POP        | Push/pop direct word register onto/from system stack                                     | 2            |
| SCXT            | Push direct word register onto system stack and update register with word operand        | 4            |
| RET(P)          | Return from intra-segment subroutine<br>(and pop direct word register from system stack) | 2            |
| RETS            | Return from inter-segment subroutine   | 2            |
| RETI            | Return from interrupt service subroutine   | 2            |
| SBRK            | Software Break   | 2            |
| SRST            | Software Reset   | 4            |
| IDLE            | Enter Idle Mode  | 4            |
| PWRDN           | Unused instruction <sup>1)</sup>   | 4            |
| SRVWDT          | Service Watchdog Timer   | 4            |
| DISWDT/ENWDT    | Disable/Enable Watchdog Timer  | 4            |
| EINIT           | End-of-Initialization Register Lock  | 4            |
| ATOMIC          | Begin ATOMIC sequence  | 2            |
| EXTR            | Begin EXTENDED Register sequence   | 2            |
| EXTP(R)         | Begin EXTENDED Page (and Register) sequence  | 2 / 4        |
| EXTS(R)         | Begin EXTENDED Segment (and Register) sequence   | 2 / 4        |

**Functional Description**

**Table 10      Instruction Set Summary (cont'd)**

| <b>Mnemonic</b> | <b>Description</b>                  | <b>Bytes</b> |
|-----------------|-------------------------------------|--------------|
| NOP             | Null operation                      | 2            |
| CoMUL/CoMAC     | Multiply (and accumulate)           | 4            |
| CoADD/CoSUB     | Add/Subtract                        | 4            |
| Co(A)SHR        | (Arithmetic) Shift right            | 4            |
| CoSHL           | Shift left                          | 4            |
| CoLOAD/STORE    | Load accumulator/Store MAC register | 4            |
| CoCMP           | Compare                             | 4            |
| CoMAX/MIN       | Maximum/Minimum                     | 4            |
| CoABS/CoRND     | Absolute value/Round accumulator    | 4            |
| CoMOV           | Data move                           | 4            |
| CoNEG/NOP       | Negate accumulator/Null operation   | 4            |

- 1) The Enter Power Down Mode instruction is not used in the XE164, due to the enhanced power control scheme. PWRDN will be correctly decoded, but will trigger no action.

## 4 Electrical Parameters

The operating range for the XE164 is defined by its electrical parameters. For proper operation the specified limits must be respected during system design.

*Note: Typical parameter values refer to room temperature and nominal supply voltage, minimum/maximum parameter values also include conditions of minimum/maximum temperature and minimum/maximum supply voltage. Additional details are described where applicable.*

### 4.1 General Parameters

These parameters are valid for all subsequent descriptions, unless otherwise noted.

**Table 11 Absolute Maximum Rating Parameters**

| Parameter   | Symbol                     | Values |      |                 | Unit | Note / Test Condition |
|---|----------------------------|--------|------|-----------------|------|-----------------------|
|   |                            | Min.   | Typ. | Max.            |      |                       |
| Storage temperature   | $T_{ST}$                   | -65    | –    | 150             | °C   | –                     |
| Junction temperature  | $T_J$                      | -40    | –    | 125             | °C   | under bias            |
| Voltage on $V_{DDI}$ pins with respect to ground ( $V_{SS}$ ) | $V_{DDIM}$ ,<br>$V_{DDI1}$ | -0.5   | –    | 1.65            | V    | –                     |
| Voltage on $V_{DDP}$ pins with respect to ground ( $V_{SS}$ ) | $V_{DDPA}$ ,<br>$V_{DDPB}$ | -0.5   | –    | 6.0             | V    | –                     |
| Voltage on any pin with respect to ground ( $V_{SS}$ )        | $V_{IN}$                   | -0.5   | –    | $V_{DDP} + 0.5$ | V    | $V_{IN} < V_{DDPmax}$ |
| Input current on any pin during overload condition            | –                          | -10    | –    | 10              | mA   | –                     |
| Absolute sum of all input currents during overload condition  | –                          | –      | –    | 100             | mA   | –                     |
| Output current on any pin                                     | $I_{OH}$ , $I_{OL}$        | –      | –    | 30              | mA   | –                     |

*Note: Stresses above the values listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for an extended time may affect device reliability. During absolute maximum rating overload conditions ( $V_{IN} > V_{DDP}$  or  $V_{IN} < V_{SS}$ ) the voltage on  $V_{DDP}$  pins with respect to ground ( $V_{SS}$ ) must not exceed the values defined by the absolute maximum ratings.*

### Operating Conditions

The following operating conditions must not be exceeded to ensure correct operation of the XE164. All parameters specified in the following sections refer to these operating conditions, unless otherwise noticed.

**Table 12      Operating Condition Parameters**

| Parameter  | Symbol               | Values |                      |                      | Unit | Note / Test Condition                |
|--|----------------------|--------|----------------------|----------------------|------|--------------------------------------|
|  |                      | Min.   | Typ.                 | Max.                 |      |                                      |
| Digital core supply voltage  | $V_{DDI}$            | 1.4    | –                    | 1.6                  | V    |                                      |
| Core Supply Voltage Difference   | $\Delta V_{DDI}$     | -10    | –                    | +10                  | mV   | $V_{DDIM} - V_{DDI1}$<br>1)          |
| Digital supply voltage for IO pads and voltage regulators, upper voltage range | $V_{DDPA}, V_{DDPB}$ | 4.5    | –                    | 5.5                  | V    | 2)                                   |
| Digital supply voltage for IO pads and voltage regulators, lower voltage range | $V_{DDPA}, V_{DDPB}$ | 3.0    | –                    | 4.5                  | V    | 2)                                   |
| Digital ground voltage   | $V_{SS}$             | 0      | –                    | 0                    | V    | Reference voltage                    |
| Overload current   | $I_{OV}$             | -5     | –                    | 5                    | mA   | Per IO pin <sup>3)4)</sup>           |
|  |                      | -2     | –                    | 5                    | mA   | Per analog input pin <sup>3)4)</sup> |
| Overload positive current coupling factor for analog inputs <sup>5)</sup>      | $K_{OVA}$            | –      | $1.0 \times 10^{-6}$ | $1.0 \times 10^{-4}$ | –    | $I_{OV} > 0$                         |
| Overload negative current coupling factor for analog inputs <sup>5)</sup>      | $K_{OVA}$            | –      | $2.5 \times 10^{-4}$ | $1.5 \times 10^{-3}$ | –    | $I_{OV} < 0$                         |
| Overload positive current coupling factor for digital I/O pins <sup>5)</sup>   | $K_{OVD}$            | –      | $1.0 \times 10^{-4}$ | $5.0 \times 10^{-3}$ | –    | $I_{OV} > 0$                         |
| Overload negative current coupling factor for digital I/O pins <sup>5)</sup>   | $K_{OVD}$            | –      | $1.0 \times 10^{-2}$ | $3.0 \times 10^{-2}$ | –    | $I_{OV} < 0$                         |
| Absolute sum of overload currents  | $\Sigma  IOV $       | –      | –                    | 50                   | mA   | 4)                                   |

**Table 12      Operating Condition Parameters (cont'd)**

| Parameter                                      | Symbol     | Values |      |      | Unit | Note /<br>Test Condition                         |
|--|------------|--------|------|------|------|--|
|  |            | Min.   | Typ. | Max. |      |  |
| External Pin Load Capacitance                  | $C_L$      | –      | 20   | –    | pF   | Pin drivers in <b>default mode</b> <sup>6)</sup> |
| Voltage Regulator Buffer Capacitance for DMP_M | $C_{EVRM}$ | 1.0    | –    | 4.7  | μF   | <sup>7)</sup>                                    |
| Voltage Regulator Buffer Capacitance for DMP_1 | $C_{EVR1}$ | 0.47   | –    | 2.2  | μF   | One for each supply pin <sup>7)</sup>            |
| Operating frequency                            | $f_{SYS}$  | –      | –    | 80   | MHz  | <sup>8)</sup>                                    |
| Ambient temperature                            | $T_A$      | –      | –    | –    | °C   | See <b>Table 1</b>                               |

- 1) If both core power domains are clocked, the difference between the power supply voltages must be less than 10 mV. This condition imposes additional constraints when using external power supplies.  
Do not combine internal and external supply of different core power domains.  
Do not supply the core power domains with two independent external voltage regulators. The simplest method is to supply both power domains directly via a single external power supply.
- 2) Performance of pad drivers, A/D Converter, and Flash module depends on  $V_{DDP}$ .  
If the external supply voltage  $V_{DDP}$  becomes lower than the specified operating range, a power reset must be generated. Otherwise, the core supply voltage  $V_{DDI}$  may rise above its specified operating range due to parasitic effects.  
This power reset can be generated by the on-chip SWD. If the SWD is disabled the power reset must be generated by activating the  $\overline{PORST}$  input.
- 3) Overload conditions occur if the standard operating conditions are exceeded, i.e. the voltage on any pin exceeds the specified range:  $V_{OV} > V_{IHmax}$  ( $I_{OV} > 0$ ) or  $V_{OV} < V_{ILmin}$  ( $I_{OV} < 0$ ). The absolute sum of input overload currents on all pins may not exceed **50 mA**. The supply voltages must remain within the specified limits. Proper operation under overload conditions depends on the application.  
Overload conditions must not occur on pin XTAL1 (powered by  $V_{DDI}$ ).
- 4) Not subject to production test - verified by design/characterization.
- 5) An overload current ( $I_{OV}$ ) through a pin injects an error current ( $I_{INJ}$ ) into the adjacent pins. This error current adds to that pin's leakage current ( $I_{OZ}$ ). The value of the error current depends on the overload current and is defined by the overload coupling factor  $K_{OV}$ . The polarity of the injected error current is reversed from the polarity of the overload current that produces it.  
The total current through a pin is  $|I_{TOT}| = |I_{OZ}| + (|I_{OV}| \times K_{OV})$ . The additional error current may distort the input voltage on analog inputs.
- 6) The timing is valid for pin drivers operating in default current mode (selected after reset). Reducing the output current may lead to increased delays or reduced driving capability ( $C_L$ ).
- 7) To ensure the stability of the voltage regulators the EVRs must be buffered with ceramic capacitors. Separate buffer capacitors with the recommended values shall be connected as close as possible to each  $V_{DDI}$  pin to keep the resistance of the board tracks below 2 Ω. Connect all  $V_{DDI1}$  pins together.  
The minimum capacitance value is required for proper operation under all conditions (e.g. temperature). Higher values slightly increase the startup time.
- 8) The operating frequency range may be reduced for specific types of the **XE164**. This is indicated in the device designation (...FxxL). 80-MHz devices are marked ...F80L.

### **Parameter Interpretation**

The parameters listed in the following include both the characteristics of the XE164 and its demands on the system. To aid in correctly interpreting the parameters when evaluating them for a design, they are marked accordingly in the column "Symbol":

**CC (Controller Characteristics):**

The logic of the XE164 provides signals with the specified characteristics.

**SR (System Requirement):**

The external system must provide signals with the specified characteristics to the XE164.



## 4.2 DC Parameters

These parameters are static or average values that may be exceeded during switching transitions (e.g. output current).

The XE164 can operate within a wide supply voltage range from 3.0 V to 5.5 V. However, during operation this supply voltage must remain within 10 percent of the selected nominal supply voltage. It cannot vary across the full operating voltage range.

Because of the supply voltage restriction and because electrical behavior depends on the supply voltage, the parameters are specified separately for the upper and the lower voltage range.

During operation, the supply voltages may only change with a maximum speed of  $dV/dt < 1 \text{ V/ms}$ .

Leakage current is strongly dependent on the operating temperature and the voltage level at the respective pin. The maximum values in the following tables apply under worst case conditions, i.e. maximum temperature and an input level equal to the supply voltage.

The value for the leakage current in an application can be determined by using the respective leakage derating formula (see tables) with values from that application.

The pads of the XE164 are designed to operate in various driver modes. The DC parameter specifications refer to the current limits in [Table 13](#).

**Table 13 Current Limits for Port Output Drivers**

| Port Output Driver Mode | Maximum Output Current<br>( $I_{OLmax}$ , $-I_{OHmax}$ ) <sup>1)</sup> |                           | Nominal Output Current<br>( $I_{OLnom}$ , $-I_{OHnom}$ ) |                           |
|-------------------------|--|---------------------------|--|---------------------------|
|                         | $V_{DDP} \geq 4.5 \text{ V}$   | $V_{DDP} < 4.5 \text{ V}$ | $V_{DDP} \geq 4.5 \text{ V}$                             | $V_{DDP} < 4.5 \text{ V}$ |
| <b>Strong driver</b>    | 10 mA  | 10 mA                     | 2.5 mA   | 2.5 mA                    |
| <b>Medium driver</b>    | 4.0 mA   | 2.5 mA                    | 1.0 mA   | 1.0 mA                    |
| <b>Weak driver</b>      | 0.5 mA   | 0.5 mA                    | 0.1 mA   | 0.1 mA                    |

1) An output current above  $|I_{OXnom}|$  may be drawn from up to three pins at the same time.

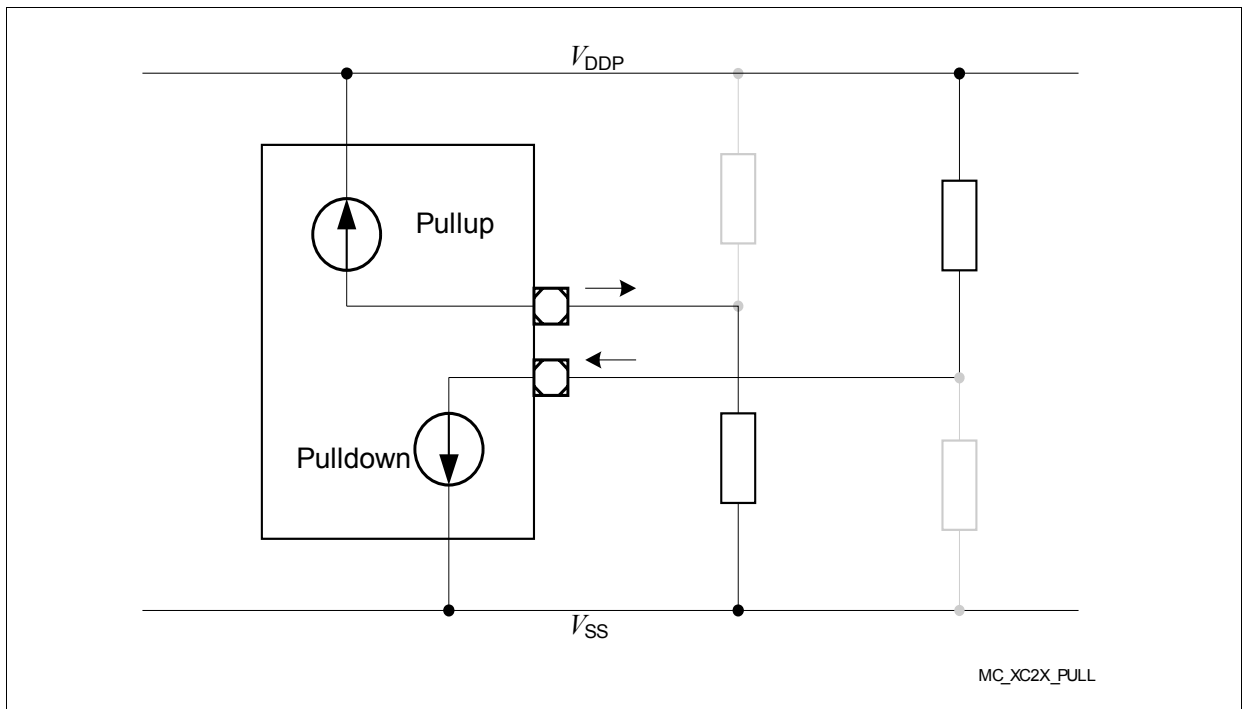
For any group of 16 neighboring output pins, the total output current in each direction ( $\Sigma I_{OL}$  and  $\Sigma -I_{OH}$ ) must remain below 50 mA.

### Pullup/Pulldown Device Behavior

Most pins of the XE164 feature pullup or pulldown devices. For some special pins these are fixed; for the port pins they can be selected by the application.

The specified current values indicate how to load the respective pin depending on the intended signal level. **Figure 12** shows the current paths.

The shaded resistors shown in the figure may be required to compensate system pull currents that do not match the given limit values.



**Figure 12 Pullup/Pulldown Current Definition**

### 4.2.1 DC Parameters for Upper Voltage Area

These parameters apply to the upper IO voltage range,  $4.5\text{ V} \leq V_{DDP} \leq 5.5\text{ V}$ .

**Table 14 DC Characteristics for Upper Voltage Range**  
(Operating Conditions apply)<sup>1)</sup>

| Parameter   | Symbol       | Values                |           |                      | Unit          | Note / Test Condition   |
|---|--------------|-----------------------|-----------|----------------------|---------------|---|
|   |              | Min.                  | Typ.      | Max.                 |               |   |
| Input low voltage<br>(all except XTAL1)                   | $V_{IL}$ SR  | -0.3                  | –         | $0.3 \times V_{DDP}$ | V             | –   |
| Input high voltage<br>(all except XTAL1)                  | $V_{IH}$ SR  | $0.7 \times V_{DDP}$  | –         | $V_{DDP} + 0.3$      | V             | –   |
| Input Hysteresis <sup>2)</sup>                            | HYS CC       | $0.11 \times V_{DDP}$ | –         | –                    | V             | $V_{DDP}$ in [V],<br>Series<br>resistance = $0\ \Omega$                   |
| Output low voltage  | $V_{OL}$ CC  | –                     | –         | 1.0                  | V             | $I_{OL} \leq I_{OLmax}^{3)}$  |
| Output low voltage  | $V_{OL}$ CC  | –                     | –         | 0.4                  | V             | $I_{OL} \leq I_{OLnom}^{3)4)}$  |
| Output high voltage <sup>5)</sup>                         | $V_{OH}$ CC  | $V_{DDP} - 1.0$       | –         | –                    | V             | $I_{OH} \geq I_{OHmax}^{3)}$  |
| Output high voltage <sup>5)</sup>                         | $V_{OH}$ CC  | $V_{DDP} - 0.4$       | –         | –                    | V             | $I_{OH} \geq I_{OHnom}^{3)4)}$  |
| Input leakage current<br>(Port 5, Port 15) <sup>6)</sup>  | $I_{OZ1}$ CC | –                     | $\pm 10$  | $\pm 200$            | nA            | $0\text{ V} < V_{IN} < V_{DDP}$   |
| Input leakage current<br>(all other) <sup>6)7)</sup>      | $I_{OZ2}$ CC | –                     | $\pm 0.2$ | $\pm 5$              | $\mu\text{A}$ | $T_J \leq 110^\circ\text{C}$ ,<br>$0.45\text{ V} < V_{IN}$<br>$< V_{DDP}$ |
| Pull level keep current                                   | $I_{PLK}$    | –                     | –         | $\pm 30$             | $\mu\text{A}$ | $V_{PIN} \geq V_{IH}$ (up) <sup>8)</sup><br>$V_{PIN} \leq V_{IL}$ (dn)    |
| Pull level force current                                  | $I_{PLF}$    | $\pm 250$             | –         | –                    | $\mu\text{A}$ | $V_{PIN} \leq V_{IL}$ (up) <sup>8)</sup><br>$V_{PIN} \geq V_{IH}$ (dn)    |
| Pin capacitance <sup>9)</sup><br>(digital inputs/outputs) | $C_{IO}$ CC  | –                     | –         | 10                   | pF            |   |

1) Keeping signal levels within the limits specified in this table ensures operation without overload conditions. For signal levels outside these specifications, also refer to the specification of the overload current  $I_{OV}$ .

2) Not subject to production test - verified by design/characterization. Hysteresis is implemented to avoid metastable states and switching due to internal ground bounce. It cannot suppress switching due to external system noise under all conditions.

3) The maximum deliverable output current of a port driver depends on the selected output driver mode, see [Table 13, Current Limits for Port Output Drivers](#). The limit for pin groups must be respected.

## Electrical Parameters

- 4) As a rule, with decreasing output current the output levels approach the respective supply level ( $V_{OL} \rightarrow V_{SS}$ ,  $V_{OH} \rightarrow V_{DDP}$ ). However, only the levels for nominal output currents are verified.
- 5) This specification is not valid for outputs which are switched to open drain mode. In this case the respective output will float and the voltage is determined by the external circuit.
- 6) An additional error current ( $I_{INJ}$ ) will flow if an overload current flows through an adjacent pin. Please refer to the definition of the overload coupling factor  $K_{OV}$ .
- 7) The given values are worst-case values. In production test, this leakage current is only tested at 125°C; other values are ensured by correlation. For derating, please refer to the following descriptions:  
 Leakage derating depending on temperature ( $T_J$  = junction temperature [°C]):  
 $I_{OZ} = 0.05 \times e^{(1.5 + 0.028 \times T_J)} [\mu A]$ . For example, at a temperature of 95°C the resulting leakage current is 3.2  $\mu A$ .  
 Leakage derating depending on voltage level ( $DV = V_{DDP} - V_{PIN}$  [V]):  
 $I_{OZ} = I_{OZtempmax} - (1.6 \times DV) [\mu A]$   
 This voltage derating formula is an approximation which applies for maximum temperature.  
 Because pin P2.8 is connected to two pads (standard pad and high-speed clock pad), it has twice the normal leakage.
- 8) Keep current: Limit the current through this pin to the indicated value so that the enabled pull device can keep the default pin level:  $V_{PIN} \geq V_{IH}$  for a pullup;  $V_{PIN} \leq V_{IL}$  for a pulldown.  
 Force current: Drive the indicated minimum current through this pin to change the default pin level driven by the enabled pull device:  $V_{PIN} \leq V_{IL}$  for a pullup;  $V_{PIN} \geq V_{IH}$  for a pulldown.  
 These values apply to the fixed pull-devices in dedicated pins and to the user-selectable pull-devices in general purpose IO pins.
- 9) Not subject to production test - verified by design/characterization.  
 Because pin P2.8 is connected to two pads (standard pad and high-speed clock pad), it has twice the normal capacitance.

## 4.2.2 DC Parameters for Lower Voltage Area

These parameters apply to the lower IO voltage range,  $3.0\text{ V} \leq V_{DDP} \leq 4.5\text{ V}$ .

**Table 15 DC Characteristics for Lower Voltage Range**  
(Operating Conditions apply)<sup>1)</sup>

| Parameter   | Symbol       | Values                |           |                      | Unit          | Note / Test Condition   |
|---|--------------|-----------------------|-----------|----------------------|---------------|---|
|   |              | Min.                  | Typ.      | Max.                 |               |   |
| Input low voltage<br>(all except XTAL1)                   | $V_{IL}$ SR  | -0.3                  | –         | $0.3 \times V_{DDP}$ | V             | –   |
| Input high voltage<br>(all except XTAL1)                  | $V_{IH}$ SR  | $0.7 \times V_{DDP}$  | –         | $V_{DDP} + 0.3$      | V             | –   |
| Input Hysteresis <sup>2)</sup>                            | HYS CC       | $0.07 \times V_{DDP}$ | –         | –                    | V             | $V_{DDP}$ in [V],<br>Series<br>resistance = $0\ \Omega$                   |
| Output low voltage  | $V_{OL}$ CC  | –                     | –         | 1.0                  | V             | $I_{OL} \leq I_{OLmax}^{3)}$  |
| Output low voltage  | $V_{OL}$ CC  | –                     | –         | 0.4                  | V             | $I_{OL} \leq I_{OLnom}^{3)4)}$  |
| Output high voltage <sup>5)</sup>                         | $V_{OH}$ CC  | $V_{DDP} - 1.0$       | –         | –                    | V             | $I_{OH} \geq I_{OHmax}^{3)}$  |
| Output high voltage <sup>5)</sup>                         | $V_{OH}$ CC  | $V_{DDP} - 0.4$       | –         | –                    | V             | $I_{OH} \geq I_{OHnom}^{3)4)}$  |
| Input leakage current<br>(Port 5, Port 15) <sup>6)</sup>  | $I_{OZ1}$ CC | –                     | $\pm 10$  | $\pm 200$            | nA            | $0\text{ V} < V_{IN} < V_{DDP}$   |
| Input leakage current<br>(all other) <sup>6)7)</sup>      | $I_{OZ2}$ CC | –                     | $\pm 0.2$ | $\pm 2.5$            | $\mu\text{A}$ | $T_J \leq 110^\circ\text{C}$ ,<br>$0.45\text{ V} < V_{IN}$<br>$< V_{DDP}$ |
| Pull level keep current                                   | $I_{PLK}$    | –                     | –         | $\pm 10$             | $\mu\text{A}$ | $V_{PIN} \geq V_{IH}$ (up) <sup>8)</sup><br>$V_{PIN} \leq V_{IL}$ (dn)    |
| Pull level force current                                  | $I_{PLF}$    | $\pm 150$             | –         | –                    | $\mu\text{A}$ | $V_{PIN} \leq V_{IL}$ (up) <sup>8)</sup><br>$V_{PIN} \geq V_{IH}$ (dn)    |
| Pin capacitance <sup>9)</sup><br>(digital inputs/outputs) | $C_{IO}$ CC  | –                     | –         | 10                   | pF            |   |

1) Keeping signal levels within the limits specified in this table ensures operation without overload conditions. For signal levels outside these specifications, also refer to the specification of the overload current  $I_{OV}$ .

2) Not subject to production test - verified by design/characterization. Hysteresis is implemented to avoid metastable states and switching due to internal ground bounce. It cannot suppress switching due to external system noise under all conditions.

3) The maximum deliverable output current of a port driver depends on the selected output driver mode, see [Table 13, Current Limits for Port Output Drivers](#). The limit for pin groups must be respected.

## Electrical Parameters

- 4) As a rule, with decreasing output current the output levels approach the respective supply level ( $V_{OL} \rightarrow V_{SS}$ ,  $V_{OH} \rightarrow V_{DDP}$ ). However, only the levels for nominal output currents are verified.
- 5) This specification is not valid for outputs which are switched to open drain mode. In this case the respective output will float and the voltage is determined by the external circuit.
- 6) An additional error current ( $I_{INJ}$ ) will flow if an overload current flows through an adjacent pin. Please refer to the definition of the overload coupling factor  $K_{OV}$ .  
The leakage current value is not tested in the lower voltage range but only in the upper voltage range. This parameter is ensured by correlation.
- 7) The given values are worst-case values. In production test, this leakage current is only tested at 125°C; other values are ensured by correlation. For derating, please refer to the following descriptions:  
Leakage derating depending on temperature ( $T_J$  = junction temperature [°C]):  
 $I_{OZ} = 0.03 \times e^{(1.35 + 0.028 \times T_J)} [\mu A]$ . For example, at a temperature of 95°C the resulting leakage current is 1.65  $\mu A$ .  
Leakage derating depending on voltage level ( $DV = V_{DDP} - V_{PIN}$  [V]):  
 $I_{OZ} = I_{OZtempmax} - (1.3 \times DV) [\mu A]$   
This voltage derating formula is an approximation which applies for maximum temperature.  
Because pin P2.8 is connected to two pads (standard pad and high-speed clock pad), it has twice the normal leakage.
- 8) Keep current: Limit the current through this pin to the indicated value so that the enabled pull device can keep the default pin level:  $V_{PIN} \geq V_{IH}$  for a pullup;  $V_{PIN} \leq V_{IL}$  for a pulldown.  
Force current: Drive the indicated minimum current through this pin to change the default pin level driven by the enabled pull device:  $V_{PIN} \leq V_{IL}$  for a pullup;  $V_{PIN} \geq V_{IH}$  for a pulldown.  
These values apply to the fixed pull-devices in dedicated pins and to the user-selectable pull-devices in general purpose IO pins.
- 9) Not subject to production test - verified by design/characterization.  
Because pin P2.8 is connected to two pads (standard pad and high-speed clock pad), it has twice the normal capacitance.

### 4.2.3 Power Consumption

The power consumed by the XE164 depends on several factors such as supply voltage, operating frequency, active circuits, and operating temperature. The power consumption specified here consists of two components:

- The switching current  $I_S$  depends on the device activity
- The leakage current  $I_{LK}$  depends on the device temperature

To determine the actual power consumption, always both components, switching current  $I_S$  ([Table 16](#)) and leakage current  $I_{LK}$  ([Table 17](#)) must be added:

$$I_{DDP} = I_S + I_{LK}$$

*Note: The power consumption values are not subject to production test. They are verified by design/characterization.*

*To determine the total power consumption for dimensioning the external power supply, also the pad driver currents must be considered.*

The given power consumption parameters and their values refer to specific operating conditions:

- **Active mode:**  
Regular operation, i.e. peripherals are active, code execution out of Flash.
- **Stopover mode:**  
Crystal oscillator and PLL stopped, Flash switched off, clock in domain DMP\_1 stopped.

*Note: The maximum values cover the complete specified operating range of all manufactured devices.*

*The typical values refer to average devices under typical conditions, such as nominal supply voltage, room temperature, application-oriented activity.*

*After a power reset, the decoupling capacitors for  $V_{DDI}$  are charged with the maximum possible current, see parameter  $I_{CC}$  in [Table 20](#).*

For additional information, please refer to [Section 5.2, Thermal Considerations](#).

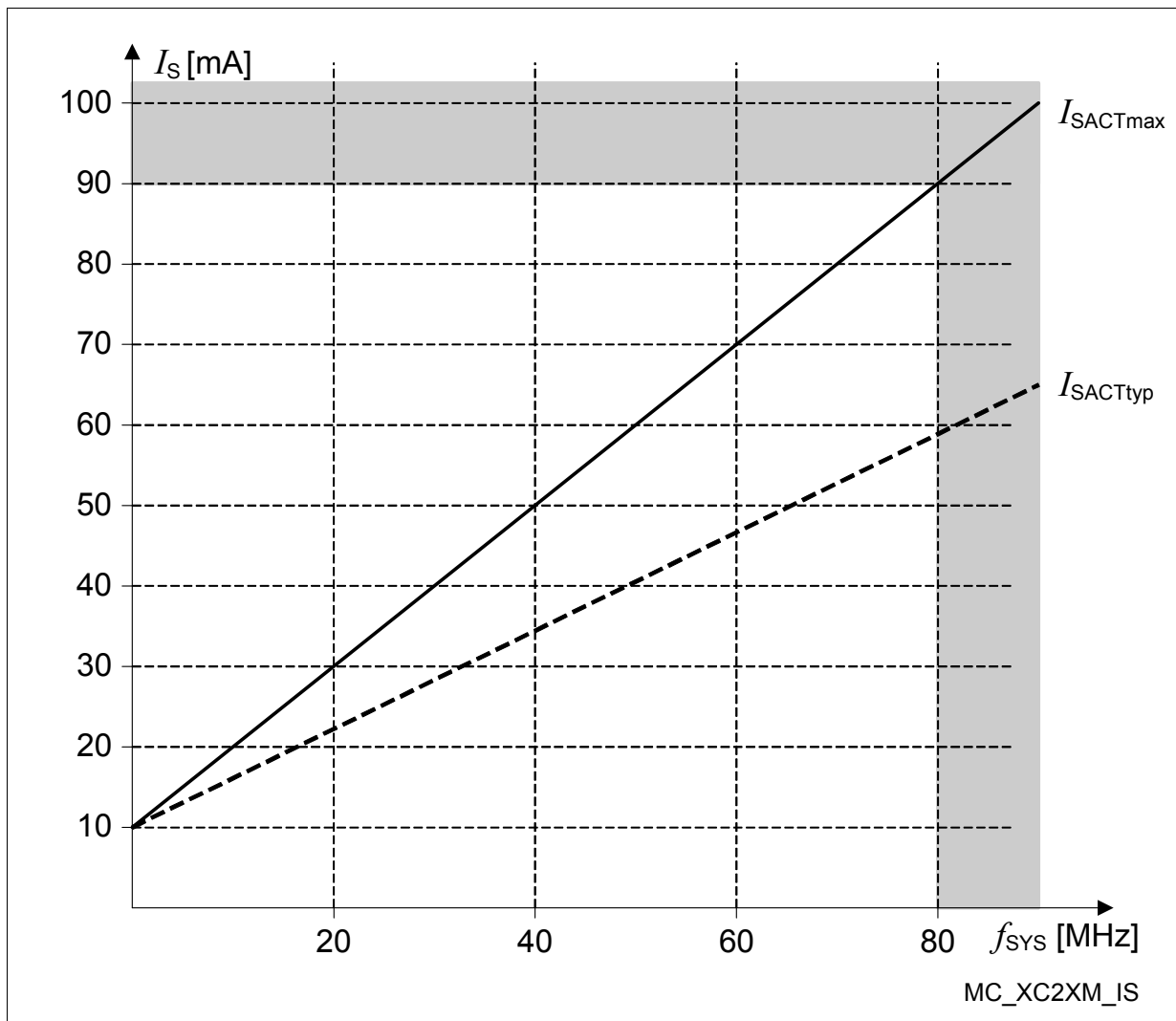
**Table 16      Switching Power Consumption XE164**  
**(Operating Conditions apply)**

| Parameter  | Sym-<br>bol       | Values |                                     |                                     | Unit | Note /<br>Test Condition                                 |
|--|-------------------|--------|-------------------------------------|-------------------------------------|------|--|
|  |                   | Min.   | Typ.                                | Max.                                |      |  |
| Power supply current<br>(active) with all peripherals<br>active and EVVRs on | $I_{\text{SACT}}$ | –      | 10 +<br>$0.6 \times f_{\text{SYS}}$ | 10 +<br>$1.0 \times f_{\text{SYS}}$ | mA   | Active mode <sup>1)2)</sup><br>$f_{\text{SYS}}$ in [MHz] |
| Power supply current<br>in stopover mode,<br>EVVRs on                        | $I_{\text{SSO}}$  | –      | 1.0                                 | 2.0                                 | mA   | Stopover Mode <sup>2)</sup>                              |

1) The pad supply voltage pins ( $V_{\text{DDPB}}$ ) provide the input current for the on-chip EVVRs and the current consumed by the pin output drivers. A small current is consumed because the drivers' input stages are switched.

2) The pad supply voltage has only a minor influence on this parameter.



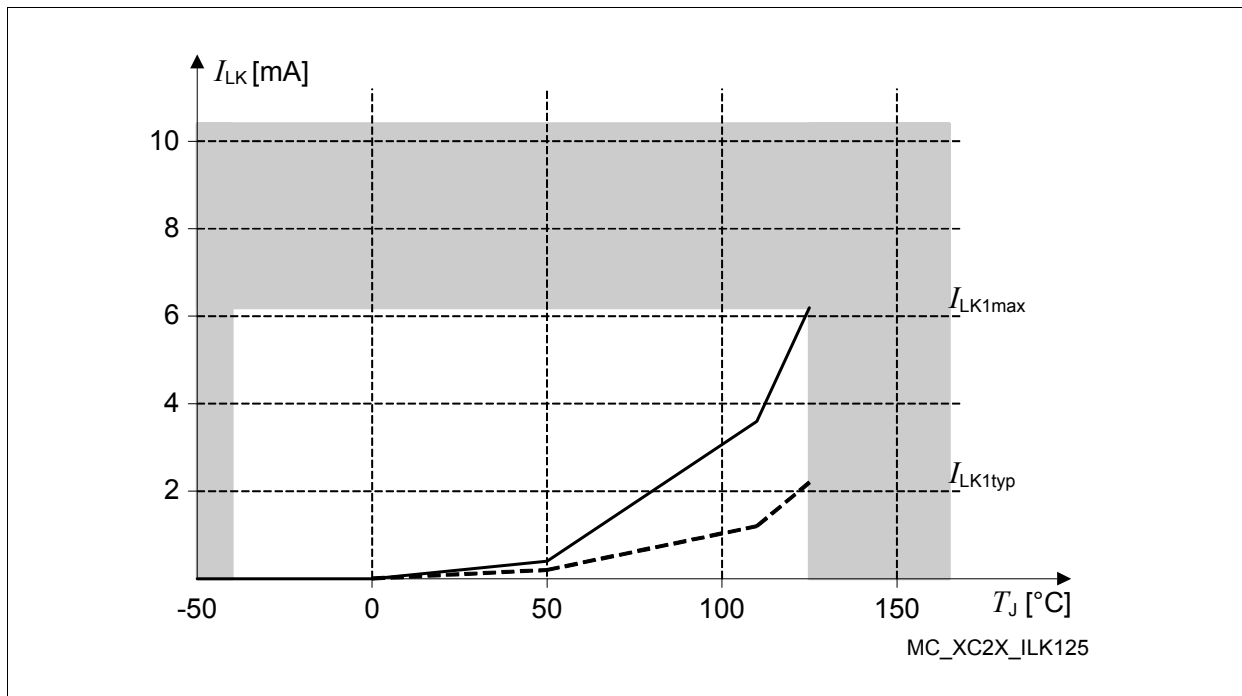


**Figure 13** Supply Current in Active Mode as a Function of Frequency

**Table 17      Leakage Power Consumption XE164**  
**(Operating Conditions apply)**

| Parameter   | Sym-<br>bol | Values |      |      | Unit | Note /<br>Test Condition <sup>1)</sup> |
|---|-------------|--------|------|------|------|--|
|   |             | Min.   | Typ. | Max. |      |  |
| Leakage supply current <sup>2)</sup><br>Formula <sup>3)</sup> : $600,000 \times e^{-\alpha}$ ;<br>$\alpha = 5000 / (273 + B \times T_J)$ ;<br>Typ.: $B = 1.0$ , Max.: $B = 1.3$ | $I_{LK1}$   | –      | 0.03 | 0.05 | mA   | $T_J = 25^\circ\text{C}$               |
|   |             | –      | 0.5  | 1.3  | mA   | $T_J = 85^\circ\text{C}$               |
|   |             | –      | 2.1  | 6.2  | mA   | $T_J = 125^\circ\text{C}$              |

- 1) All inputs (including pins configured as inputs) are set at 0 V to 0.1 V or at  $V_{DDP} - 0.1$  V to  $V_{DDP}$  and all outputs (including pins configured as outputs) are disconnected.
- 2) The supply current caused by leakage depends mainly on the junction temperature (see [Figure 14](#)) and the supply voltage. The temperature difference between the junction temperature  $T_J$  and the ambient temperature  $T_A$  must be taken into account. As this fraction of the supply current does not depend on device activity, it must be added to other power consumption values.
- 3) This formula is valid for temperatures above  $0^\circ\text{C}$ . For temperatures below  $0^\circ\text{C}$  a value of below 10  $\mu\text{A}$  can be assumed.



**Figure 14      Leakage Supply Current as a Function of Temperature**

### 4.3 Analog/Digital Converter Parameters

These parameters describe the conditions for optimum ADC performance.

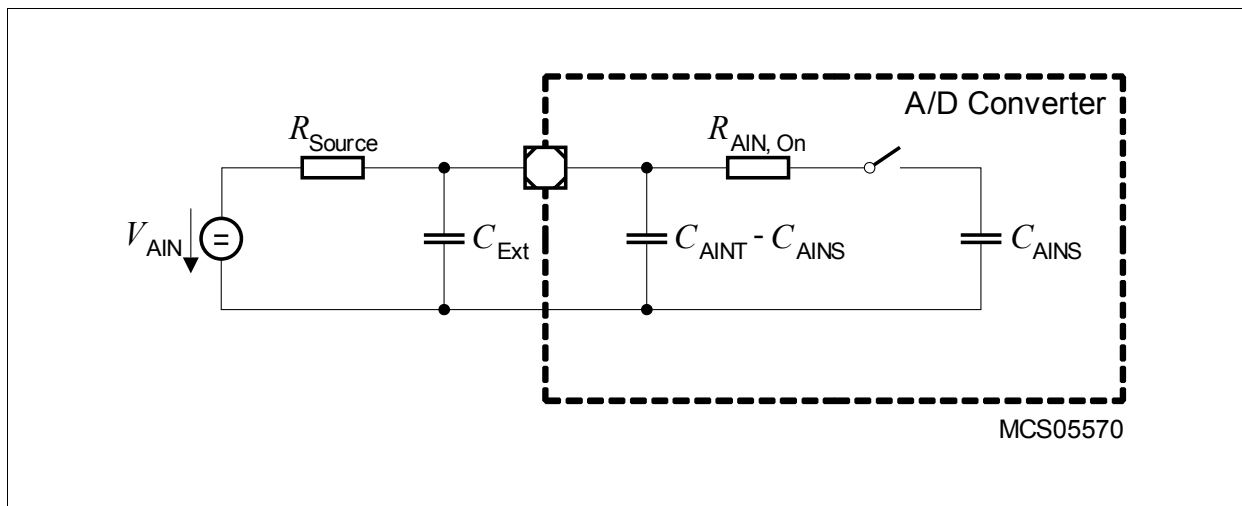
**Table 18 A/D Converter Characteristics**  
(Operating Conditions apply)

| Parameter                                       | Symbol      |    | Limit Values                                    |                   | Unit | Test Condition                  |
|---|-------------|----|---|-------------------|------|---------------------------------|
|   |             |    | Min.  | Max.              |      |                                 |
| Analog reference supply                         | $V_{AREF}$  | SR | $V_{AGND} + 1.0$                                | $V_{DDPA} + 0.05$ | V    | 1)                              |
| Analog reference ground                         | $V_{AGND}$  | SR | $V_{SS} - 0.05$                                 | $V_{AREF} - 1.0$  | V    | —                               |
| Analog input voltage range                      | $V_{AIN}$   | SR | $V_{AGND}$                                      | $V_{AREF}$        | V    | 2)                              |
| Analog clock frequency                          | $f_{ADCI}$  |    | 0.5   | 20                | MHz  | 3)                              |
| Conversion time for 10-bit result <sup>4)</sup> | $t_{C10}$   | CC | $(13 + STC) \times t_{ADCI} + 2 \times t_{SYS}$ |                   | —    | —                               |
| Conversion time for 8-bit result <sup>4)</sup>  | $t_{C8}$    | CC | $(11 + STC) \times t_{ADCI} + 2 \times t_{SYS}$ |                   | —    | —                               |
| Wakeup time from analog powerdown, fast mode    | $t_{WAF}$   | CC | —   | 1                 | μs   | —                               |
| Wakeup time from analog powerdown, slow mode    | $t_{WAS}$   | CC | —   | 10                | μs   | —                               |
| Total unadjusted error <sup>5)</sup>            | TUE         | CC | —   | ±2                | LSB  | $V_{AREF} = 5.0 \text{ V}^{1)}$ |
| DNL error                                       | $EA_{DNL}$  | CC | —   | ±1                | LSB  |                                 |
| INL error                                       | $EA_{INL}$  | CC | —   | ±1.2              | LSB  |                                 |
| Gain error                                      | $EA_{GAIN}$ | CC | —   | ±0.8              | LSB  |                                 |
| Offset error                                    | $EA_{OFF}$  | CC | —   | ±0.8              | LSB  |                                 |
| Total capacitance of an analog input            | $C_{AINT}$  | CC | —   | 10                | pF   | 6)7)                            |
| Switched capacitance of an analog input         | $C_{AINS}$  | CC | —   | 4                 | pF   | 6)7)                            |
| Resistance of the analog input path             | $R_{AIN}$   | CC | —   | 1.5               | kΩ   | 6)7)                            |
| Total capacitance of the reference input        | $C_{AREFT}$ | CC | —   | 15                | pF   | 6)7)                            |

**Table 18      A/D Converter Characteristics (cont'd)**  
**(Operating Conditions apply)**

| Parameter                                   | Symbol      |    | Limit Values |      | Unit | Test Condition |
|---|-------------|----|--------------|------|------|----------------|
|   |             |    | Min.         | Max. |      |                |
| Switched capacitance of the reference input | $C_{AREFS}$ | CC | –            | 7    | pF   | 6)7)           |
| Resistance of the reference input path      | $R_{AREF}$  | CC | –            | 2    | kΩ   | 6)7)           |

- 1) TUE is tested at  $V_{AREFX} = V_{DDPA}$ ,  $V_{AGND} = 0$  V. It is verified by design for all other voltages within the defined voltage range.  
The specified TUE is valid only if the absolute sum of input overload currents on Port 5 or Port 15 pins (see  $I_{OV}$  specification) does not exceed 10 mA, and if  $V_{AREF}$  and  $V_{AGND}$  remain stable during the measurement time.
- 2)  $V_{AIN}$  may exceed  $V_{AGND}$  or  $V_{AREFX}$  up to the absolute maximum ratings. However, the conversion result in these cases will be X000<sub>H</sub> or X3FF<sub>H</sub>, respectively.
- 3) The limit values for  $f_{ADCI}$  must not be exceeded when selecting the peripheral frequency and the prescaler setting.
- 4) This parameter includes the sample time (also the additional sample time specified by STC), the time to determine the digital result and the time to load the result register with the conversion result.  
Values for the basic clock  $t_{ADCI}$  depend on programming and are found in [Table 19](#).
- 5) The total unadjusted error TUE is the maximum deviation from the ideal ADC transfer curve, not the sum of individual errors.  
All error specifications are based on measurement methods standardized by IEEE 1241.2000.
- 6) Not subject to production test - verified by design/characterization.
- 7) These parameter values cover the complete operating range. Under relaxed operating conditions (temperature, supply voltage) typical values can be used for calculation. At room temperature and nominal supply voltage the following typical values can be used:  
 $C_{AINTtyp} = 12$  pF,  $C_{AINStyp} = 5$  pF,  $R_{AINTtyp} = 1.0$  kΩ,  $C_{AREFTtyp} = 15$  pF,  $C_{AREFStyp} = 10$  pF,  $R_{AREFTyp} = 1.0$  kΩ.



**Figure 15      Equivalent Circuitry for Analog Inputs**

## Electrical Parameters

Sample time and conversion time of the XE164's A/D converters are programmable. The timing above can be calculated using [Table 19](#).

The limit values for  $f_{\text{ADCI}}$  must not be exceeded when selecting the prescaler value.

**Table 19      A/D Converter Computation Table**

| <b>GLOBCTR.5-0<br/>(DIVA)</b> | <b>A/D Converter<br/>Analog Clock <math>f_{\text{ADCI}}</math></b> | <b>INPCRx.7-0<br/>(STC)</b> | <b>Sample Time<br/><math>t_s</math></b> |
|-------------------------------|--|-----------------------------|---|
| 000000 <sub>B</sub>           | $f_{\text{SYS}}$   | 00 <sub>H</sub>             | $t_{\text{ADCI}} \times 2$              |
| 000001 <sub>B</sub>           | $f_{\text{SYS}} / 2$   | 01 <sub>H</sub>             | $t_{\text{ADCI}} \times 3$              |
| 000010 <sub>B</sub>           | $f_{\text{SYS}} / 3$   | 02 <sub>H</sub>             | $t_{\text{ADCI}} \times 4$              |
| :                             | $f_{\text{SYS}} / (\text{DIVA}+1)$                                 | :                           | $t_{\text{ADCI}} \times (\text{STC}+2)$ |
| 111110 <sub>B</sub>           | $f_{\text{SYS}} / 63$  | FE <sub>H</sub>             | $t_{\text{ADCI}} \times 256$            |
| 111111 <sub>B</sub>           | $f_{\text{SYS}} / 64$  | FF <sub>H</sub>             | $t_{\text{ADCI}} \times 257$            |

### Converter Timing Example A:

Assumptions:  $f_{\text{SYS}} = 80 \text{ MHz}$  (i.e.  $t_{\text{SYS}} = 12.5 \text{ ns}$ ),  $\text{DIVA} = 03_{\text{H}}$ ,  $\text{STC} = 00_{\text{H}}$   
 Analog clock  $f_{\text{ADCI}} = f_{\text{SYS}} / 4 = 20 \text{ MHz}$ , i.e.  $t_{\text{ADCI}} = 50 \text{ ns}$   
 Sample time  $t_s = t_{\text{ADCI}} \times 2 = 100 \text{ ns}$

#### Conversion 10-bit:

$$t_{\text{C10}} = 13 \times t_{\text{ADCI}} + 2 \times t_{\text{SYS}} = 13 \times 50 \text{ ns} + 2 \times 12.5 \text{ ns} = 0.675 \mu\text{s}$$

#### Conversion 8-bit:

$$t_{\text{C8}} = 11 \times t_{\text{ADCI}} + 2 \times t_{\text{SYS}} = 11 \times 50 \text{ ns} + 2 \times 12.5 \text{ ns} = 0.575 \mu\text{s}$$

### Converter Timing Example B:

Assumptions:  $f_{\text{SYS}} = 40 \text{ MHz}$  (i.e.  $t_{\text{SYS}} = 25 \text{ ns}$ ),  $\text{DIVA} = 02_{\text{H}}$ ,  $\text{STC} = 03_{\text{H}}$   
 Analog clock  $f_{\text{ADCI}} = f_{\text{SYS}} / 3 = 13.3 \text{ MHz}$ , i.e.  $t_{\text{ADCI}} = 75 \text{ ns}$   
 Sample time  $t_s = t_{\text{ADCI}} \times 5 = 375 \text{ ns}$

#### Conversion 10-bit:

$$t_{\text{C10}} = 16 \times t_{\text{ADCI}} + 2 \times t_{\text{SYS}} = 16 \times 75 \text{ ns} + 2 \times 25 \text{ ns} = 1.25 \mu\text{s}$$

#### Conversion 8-bit:

$$t_{\text{C8}} = 14 \times t_{\text{ADCI}} + 2 \times t_{\text{SYS}} = 14 \times 75 \text{ ns} + 2 \times 25 \text{ ns} = 1.10 \mu\text{s}$$

## 4.4 System Parameters

The following parameters specify several aspects which are important when integrating the XE164 into an application system.

*Note: These parameters are not subject to production test but verified by design and/or characterization.*

**Table 20 Various System Parameters**

| Parameter  | Symbol              | Values                  |                 |                         | Unit | Note / Test Condition                                    |
|--|---------------------|-------------------------|-----------------|-------------------------|------|--|
|  |                     | Min.                    | Typ.            | Max.                    |      |  |
| Supply watchdog (SWD) supervision level<br>(see <a href="#">Table 21</a> ) | $V_{\text{SWD CC}}$ | $V_{\text{LV}} - 0.150$ | $V_{\text{LV}}$ | $V_{\text{LV}} + 0.100$ | V    | $V_{\text{LV}}$ = selected voltage in upper voltage area |
|  |                     | $V_{\text{LV}} - 0.125$ | $V_{\text{LV}}$ | $V_{\text{LV}} + 0.050$ | V    | $V_{\text{LV}}$ = selected voltage in lower voltage area |
| Core voltage (PVC) supervision level<br>(see <a href="#">Table 22</a> )    | $V_{\text{PVC CC}}$ | $V_{\text{LV}} - 0.070$ | $V_{\text{LV}}$ | $V_{\text{LV}} + 0.030$ | V    | $V_{\text{LV}}$ = selected voltage                       |
| Current control limit  | $I_{\text{CC CC}}$  | 13                      | –               | 30                      | mA   | Power domain DMP_M                                       |
|  |                     | 90                      | –               | 150                     | mA   | Power domain DMP_1                                       |
| Wakeup clock source frequency  | $f_{\text{WU CC}}$  | 400                     | 500             | 600                     | kHz  | FREQSEL = 00 <sub>B</sub>                                |
| Internal clock source frequency  | $f_{\text{INT CC}}$ | 4.8                     | 5.0             | 5.2                     | MHz  |  |
| Startup time from stopover mode  | $t_{\text{SSO CC}}$ | 200                     | 260             | 320                     | μs   | User instruction from PSRAM                              |

**Table 21 Coding of Bitfields LEVxV in Register SWDCON0**

| Code              | Default Voltage Level | Notes <sup>1)</sup>  |
|-------------------|-----------------------|----------------------|
| 0000 <sub>B</sub> | 2.9 V                 |                      |
| 0001 <sub>B</sub> | 3.0 V                 | LEV1V: reset request |
| 0010 <sub>B</sub> | 3.1 V                 |                      |
| 0011 <sub>B</sub> | 3.2 V                 |                      |
| 0100 <sub>B</sub> | 3.3 V                 |                      |
| 0101 <sub>B</sub> | 3.4 V                 |                      |
| 0110 <sub>B</sub> | 3.6 V                 |                      |
| 0111 <sub>B</sub> | 4.0 V                 |                      |
| 1000 <sub>B</sub> | 4.2 V                 |                      |
| 1001 <sub>B</sub> | 4.5 V                 | LEV2V: no request    |
| 1010 <sub>B</sub> | 4.6 V                 |                      |
| 1011 <sub>B</sub> | 4.7 V                 |                      |
| 1100 <sub>B</sub> | 4.8 V                 |                      |
| 1101 <sub>B</sub> | 4.9 V                 |                      |
| 1110 <sub>B</sub> | 5.0 V                 |                      |
| 1111 <sub>B</sub> | 5.5 V                 |                      |

1) The indicated default levels are selected automatically after a power reset.

**Table 22 Coding of Bitfields LEVxV in Registers PVCyCONz**

| Code             | Default Voltage Level | Notes <sup>1)</sup>      |
|------------------|-----------------------|--------------------------|
| 000 <sub>B</sub> | 0.9 V                 |                          |
| 001 <sub>B</sub> | 1.0 V                 |                          |
| 010 <sub>B</sub> | 1.1 V                 |                          |
| 011 <sub>B</sub> | 1.2 V                 |                          |
| 100 <sub>B</sub> | 1.3 V                 | LEV1V: reset request     |
| 101 <sub>B</sub> | 1.4 V                 | LEV2V: interrupt request |
| 110 <sub>B</sub> | 1.5 V                 |                          |
| 111 <sub>B</sub> | 1.6 V                 |                          |

1) The indicated default levels are selected automatically after a power reset.

## 4.5 Flash Memory Parameters

The XE164 is delivered with all Flash sectors erased and with no protection installed.

The data retention time of the XE164's Flash memory (i.e. the time after which stored data can still be retrieved) depends on the number of times the Flash memory has been erased and programmed.

*Note: These parameters are not subject to production test but verified by design and/or characterization.*

**Table 23 Flash Characteristics**  
(Operating Conditions apply)

| Parameter  | Symbol    | Limit Values |                 |      | Unit   | Note / Test Condition        |
|--|-----------|--------------|-----------------|------|--------|------------------------------|
|  |           | Min.         | Typ.            | Max. |        |                              |
| Programming time per 128-byte page                   | $t_{PR}$  | –            | 3 <sup>1)</sup> | 3.5  | ms     | ms                           |
| Erase time per sector/page                           | $t_{ER}$  | –            | 4 <sup>1)</sup> | 5    | ms     | ms                           |
| Data retention time                                  | $t_{RET}$ | 20           | –               | –    | years  | 1,000 erase / program cycles |
| Flash erase endurance for user sectors <sup>2)</sup> | $N_{ER}$  | 15,000       | –               | –    | cycles | Data retention time 5 years  |
| Flash erase endurance for security pages             | $N_{SEC}$ | 10           | –               | –    | cycles | Data retention time 20 years |
| Drain disturb limit                                  | $N_{DD}$  | 64           | –               | –    | cycles | <sup>3)</sup>                |

- 1) Programming and erase times depend on the internal Flash clock source. The control state machine needs a few system clock cycles. This requirement is only relevant for extremely low system frequencies.  
In the XE164 erased areas must be programmed completely (with actual code/data or dummy values) before that area is read.
- 2) A maximum of 64 Flash sectors can be cycled 15,000 times. For all other sectors the limit is 1,000 cycles.
- 3) This parameter limits the number of subsequent programming operations within a physical sector. The drain disturb limit is applicable if wordline erase is used repeatedly. For normal sector erase/program cycles this limit will not be violated.

Access to the XE164 Flash modules is controlled by the IMB. Built-in prefetch mechanisms optimize the performance for sequential access.

Flash access waitstates only affect non-sequential access. Due to prefetch mechanisms, the performance for sequential access (depending on the software structure) is only partially influenced by waitstates.



**Table 24      Flash Access Waitstates**

| <b>Required Waitstates</b>         | <b>System Frequency Range</b>           |
|------------------------------------|---|
| 4 WS (WSFLASH = 100 <sub>B</sub> ) | $f_{\text{SYS}} \leq f_{\text{SYSmax}}$ |
| 3 WS (WSFLASH = 011 <sub>B</sub> ) | $f_{\text{SYS}} \leq 17 \text{ MHz}$    |
| 2 WS (WSFLASH = 010 <sub>B</sub> ) | $f_{\text{SYS}} \leq 13 \text{ MHz}$    |
| 1 WS (WSFLASH = 001 <sub>B</sub> ) | $f_{\text{SYS}} \leq 8 \text{ MHz}$     |
| 0 WS (WSFLASH = 000 <sub>B</sub> ) | Forbidden! Must not be selected!        |

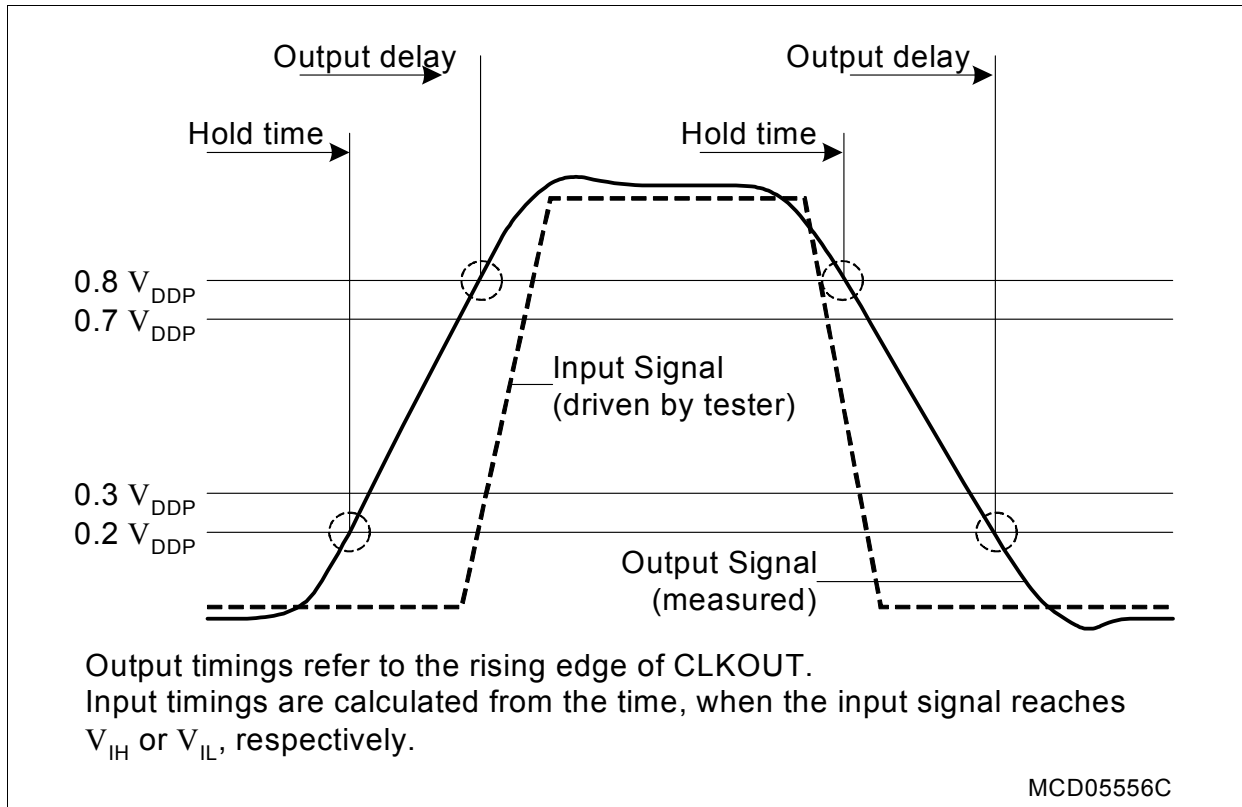
*Note: The maximum achievable system frequency is limited by the properties of the respective derivative.*

## 4.6 AC Parameters

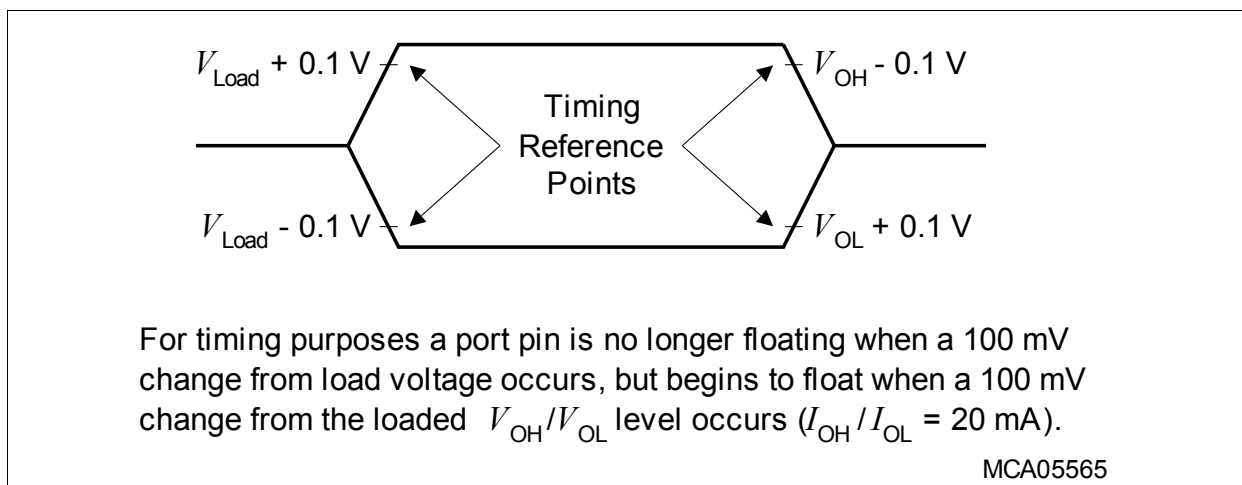
These parameters describe the dynamic behavior of the XE164.

### 4.6.1 Testing Waveforms

These values are used for characterization and production testing (except pin XTAL1).



**Figure 16 Input Output Waveforms**

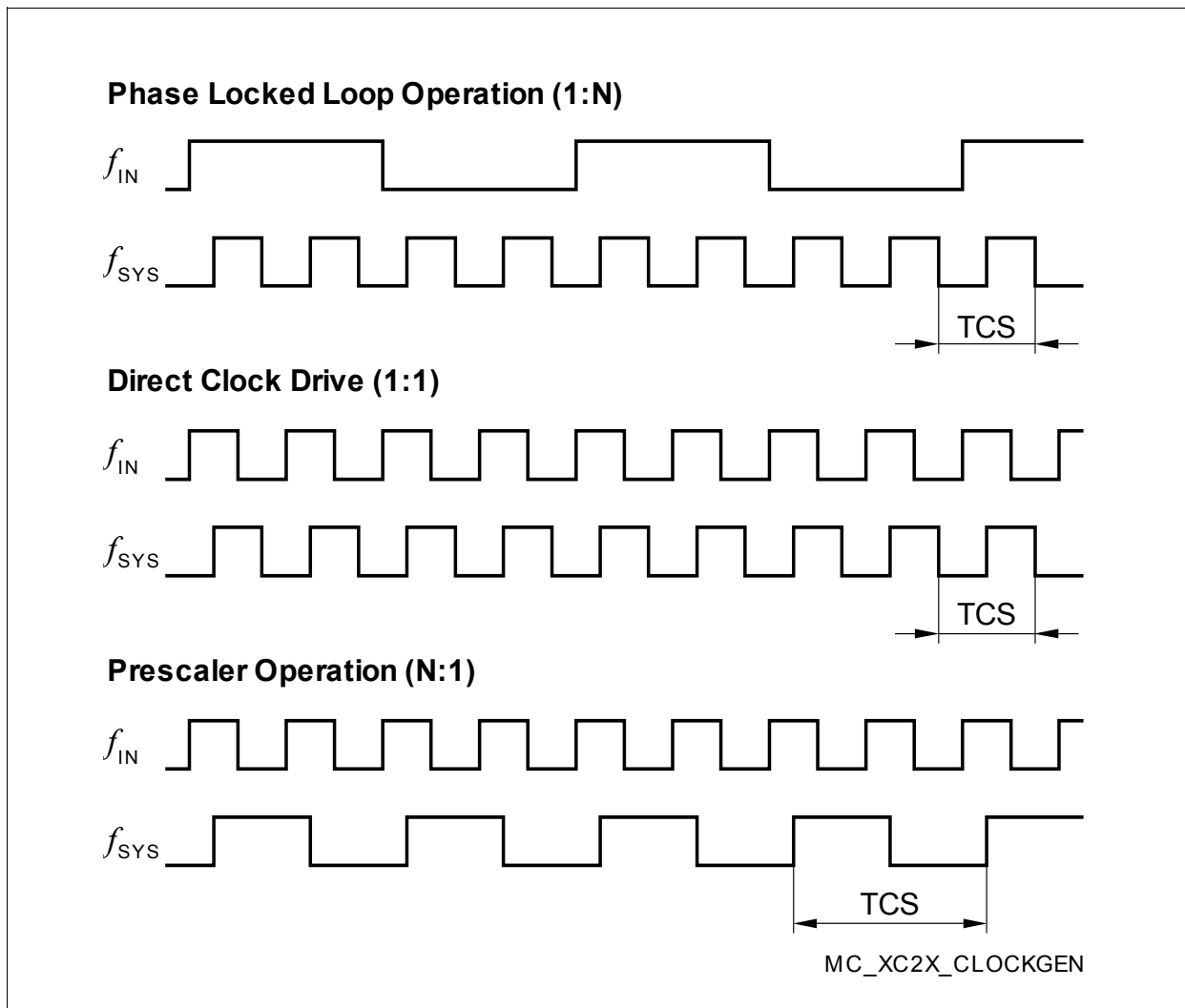


**Figure 17 Floating Waveforms**

#### 4.6.2 Definition of Internal Timing

The internal operation of the XE164 is controlled by the internal system clock  $f_{\text{SYS}}$ .

Because the system clock signal  $f_{\text{SYS}}$  can be generated from a number of internal and external sources using different mechanisms, the duration of the system clock periods (TCSs) and their variation (as well as the derived external timing) depend on the mechanism used to generate  $f_{\text{SYS}}$ . This must be considered when calculating the timing for the XE164.



**Figure 18 Generation Mechanisms for the System Clock**

*Note: The example of PLL operation shown in [Figure 18](#) uses a PLL factor of 1:4; the example of prescaler operation uses a divider factor of 2:1.*

The specification of the external timing (AC Characteristics) depends on the period of the system clock (TCS).

### Direct Drive

When direct drive operation is selected (SYSCON0.CLKSEL = 11<sub>B</sub>), the system clock is derived directly from the input clock signal CLKIN1:

$$f_{\text{SYS}} = f_{\text{IN}}$$

The frequency of  $f_{\text{SYS}}$  is the same as the frequency of  $f_{\text{IN}}$ . In this case the high and low times of  $f_{\text{SYS}}$  are determined by the duty cycle of the input clock  $f_{\text{IN}}$ .

Selecting Bypass Operation from the XTAL1<sup>1)</sup> input and using a divider factor of 1 results in a similar configuration.

### Prescaler Operation

When prescaler operation is selected (SYSCON0.CLKSEL = 10<sub>B</sub>, PLLCON0.VCOBY = 1<sub>B</sub>), the system clock is derived either from the crystal oscillator (input clock signal XTAL1) or from the internal clock source through the output prescaler K1 (= K1DIV+1):

$$f_{\text{SYS}} = f_{\text{OSC}} / K1.$$

If a divider factor of 1 is selected, the frequency of  $f_{\text{SYS}}$  equals the frequency of  $f_{\text{OSC}}$ . In this case the high and low times of  $f_{\text{SYS}}$  are determined by the duty cycle of the input clock  $f_{\text{OSC}}$  (external or internal).

The lowest system clock frequency results from selecting the maximum value for the divider factor K1:

$$f_{\text{SYS}} = f_{\text{OSC}} / 1024.$$

### Phase Locked Loop (PLL)

When PLL operation is selected (SYSCON0.CLKSEL = 10<sub>B</sub>, PLLCON0.VCOBY = 0<sub>B</sub>), the on-chip phase locked loop is enabled and provides the system clock. The PLL multiplies the input frequency by the factor **F** ( $f_{\text{SYS}} = f_{\text{IN}} \times \mathbf{F}$ ).

**F** is calculated from the input divider P (= PDIV+1), the multiplication factor N (= NDIV+1), and the output divider K2 (= K2DIV+1):

$$(\mathbf{F} = N / (P \times K2)).$$

The input clock can be derived either from an external source at XTAL1 or from the on-chip clock source.

The PLL circuit synchronizes the system clock to the input clock. This synchronization is performed smoothly so that the system clock frequency does not change abruptly.

Adjustment to the input clock continuously changes the frequency of  $f_{\text{SYS}}$  so that it is locked to  $f_{\text{IN}}$ . The slight variation causes a jitter of  $f_{\text{SYS}}$  which in turn affects the duration of individual TCSs.

1) Voltages on XTAL1 must comply to the core supply voltage  $V_{\text{DDI1}}$ .

## Electrical Parameters

The timing in the AC Characteristics refers to TCSs. Timing must be calculated using the minimum TCS possible under the given circumstances.

The actual minimum value for TCS depends on the jitter of the PLL. Because the PLL is constantly adjusting its output frequency to correspond to the input frequency (from crystal or oscillator), the accumulated jitter is limited. This means that the relative deviation for periods of more than one TCS is lower than for a single TCS (see formulas and [Figure 19](#)).

This is especially important for bus cycles using waitstates and for the operation of timers, serial interfaces, etc. For all slower operations and longer periods (e.g. pulse train generation or measurement, lower baudrates, etc.) the deviation caused by the PLL jitter is negligible.

The value of the accumulated PLL jitter depends on the number of consecutive VCO output cycles within the respective timeframe. The VCO output clock is divided by the output prescaler K2 to generate the system clock signal  $f_{SYS}$ . The number of VCO cycles is  $K2 \times T$ , where **T** is the number of consecutive  $f_{SYS}$  cycles (TCS).

The maximum accumulated jitter (long-term jitter)  $D_{Tmax}$  is defined by:

$$D_{Tmax} [ns] = \pm(220 / (K2 \times f_{SYS}) + 4.3)$$

This maximum value is applicable, if either the number of clock cycles  $T > (f_{SYS} / 1.2)$  or the prescaler value  $K2 > 17$ .

In all other cases for a timeframe of **T** × TCS the accumulated jitter  $D_T$  is determined by:

$$D_T [ns] = D_{Tmax} \times [(1 - 0.058 \times K2) \times (T - 1) / (0.83 \times f_{SYS} - 1) + 0.058 \times K2]$$

$f_{SYS}$  in [MHz] in all formulas.

Example, for a period of 3 TCSs @ 33 MHz and K2 = 4:

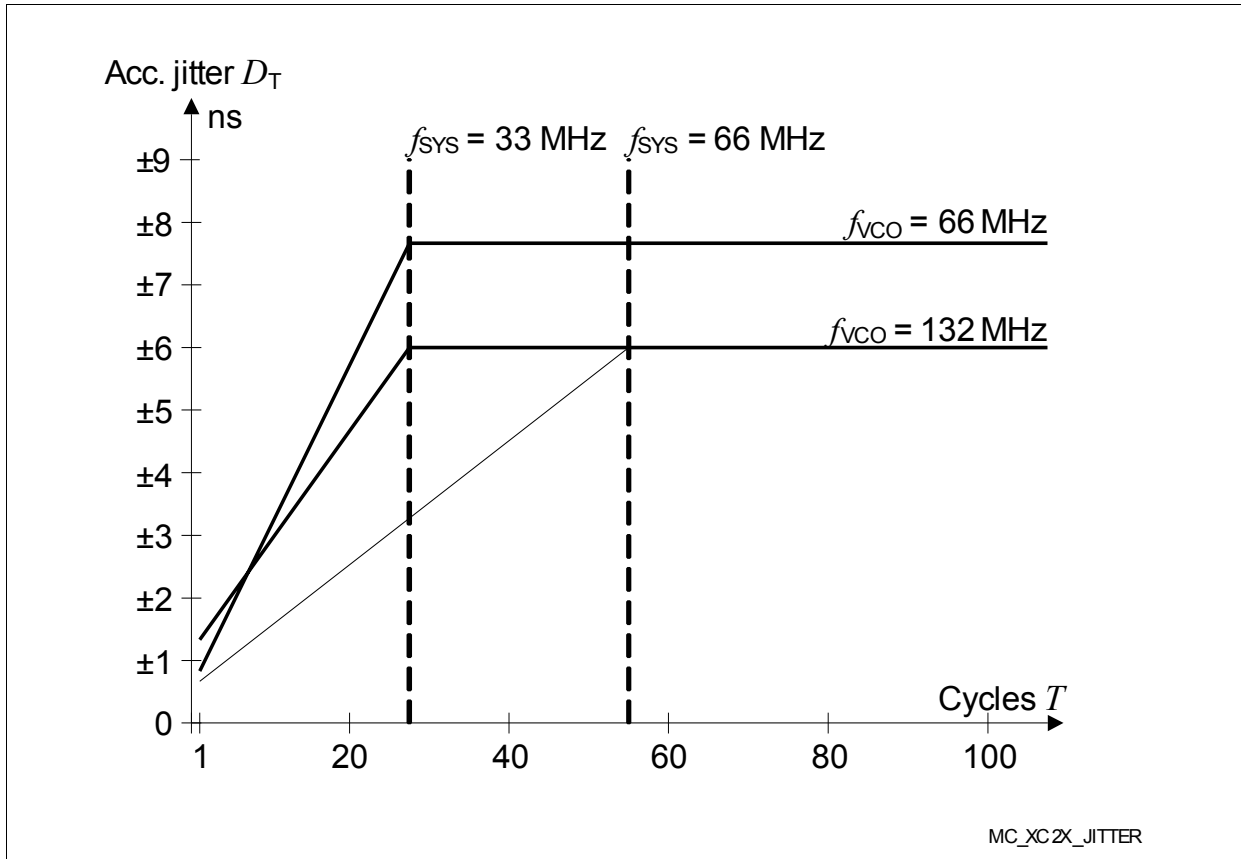
$$D_{max} = \pm(220 / (4 \times 33) + 4.3) = 5.97 \text{ ns (Not applicable directly in this case!)}$$

$$\begin{aligned} D_3 &= 5.97 \times [(1 - 0.058 \times 4) \times (3 - 1) / (0.83 \times 33 - 1) + 0.058 \times 4] \\ &= 5.97 \times [0.768 \times 2 / 26.39 + 0.232] \\ &= 1.7 \text{ ns} \end{aligned}$$

Example, for a period of 3 TCSs @ 33 MHz and K2 = 2:

$$D_{max} = \pm(220 / (2 \times 33) + 4.3) = 7.63 \text{ ns (Not applicable directly in this case!)}$$

$$\begin{aligned} D_3 &= 7.63 \times [(1 - 0.058 \times 2) \times (3 - 1) / (0.83 \times 33 - 1) + 0.058 \times 2] \\ &= 7.63 \times [0.884 \times 2 / 26.39 + 0.116] \\ &= 1.4 \text{ ns} \end{aligned}$$



**Figure 19**      **Approximated Accumulated PLL Jitter**

*Note: The specified PLL jitter values are valid if the capacitive load per pin does not exceed  $C_L = 20$  pF (see [Table 12](#)).*

*The maximum peak-to-peak noise on the pad supply voltage (measured between  $V_{DDPB}$  pin 100/144 and  $V_{SS}$  pin 1) is limited to a peak-to-peak voltage of  $V_{PP} = 50$  mV. This can be achieved by appropriate blocking of the supply voltage as close as possible to the supply pins and using PCB supply and ground planes.*

Different frequency bands can be selected for the VCO so that the operation of the PLL can be adjusted to a wide range of input and output frequencies:

**Table 25**      **VCO Bands for PLL Operation<sup>1)</sup>**

| PLLCON0.VCOSEL | VCO Frequency Range | Base Frequency Range |
|----------------|---------------------|----------------------|
| 00             | 50 ... 110 MHz      | 10 ... 40 MHz        |
| 01             | 100 ... 160 MHz     | 20 ... 80 MHz        |
| 1X             | Reserved            |                      |

<sup>1)</sup> Not subject to production test - verified by design/characterization.

### **Wakeup Clock**

When wakeup operation is selected ( $\text{SYSCON0.CLKSEL} = 00_{\text{B}}$ ), the system clock is derived from the low-frequency wakeup clock source:

$$f_{\text{SYS}} = f_{\text{WU}}$$

In this mode, a basic functionality can be maintained without requiring an external clock source and while minimizing the power consumption.

### **Selecting and Changing the Operating Frequency**

When selecting a clock source and the clock generation method, the required parameters must be carefully written to the respective bitfields, to avoid unintended intermediate states.

Many applications change the frequency of the system clock ( $f_{\text{SYS}}$ ) during operation in order to optimize system performance and power consumption. Changing the operating frequency also changes the switching currents, which influences the power supply.

To ensure proper operation of the on-chip EVRs while they generate the core voltage, the operating frequency shall only be changed in certain steps. This prevents overshoots and undershoots of the supply voltage.

To avoid the indicated problems, recommended sequences are provided which ensure the intended operation of the clock system interacting with the power system.

Please refer to the Programmer's Guide.

### 4.6.3 External Clock Input Parameters

These parameters specify the external clock generation for the XE164. The clock can be generated in two ways:

- By connecting a **crystal or ceramic resonator** to pins XTAL1/XTAL2.
- By supplying an **external clock signal**. This clock signal can be supplied either to pin XTAL1 (core voltage domain) or to pin CLKIN1 (IO voltage domain).

If connected to CLKIN1, the input signal must reach the defined input levels  $V_{IL}$  and  $V_{IH}$ . In connected to XTAL1, a minimum amplitude  $V_{AX1}$  (peak-to-peak voltage) is sufficient for the operation of the on-chip oscillator.

*Note: The given clock timing parameters ( $t_1 \dots t_4$ ) are only valid for an external clock input signal.*

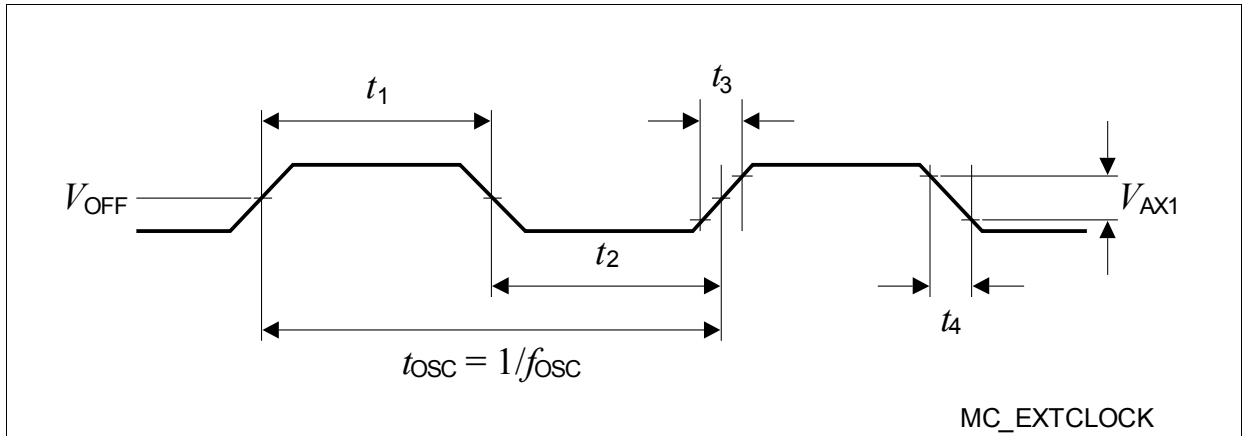
**Table 26 External Clock Input Characteristics**  
(Operating Conditions apply)

| Parameter                                      | Symbol       | Limit Values         |      |          | Unit    | Note / Test Condition              |
|--|--------------|----------------------|------|----------|---------|------------------------------------|
|  |              | Min.                 | Typ. | Max.     |         |                                    |
| Input voltage range limits for signal on XTAL1 | $V_{IX1}$ SR | $-1.7 + V_{DDI}$     | –    | 1.7      | V       | 1)                                 |
| Input voltage (amplitude) on XTAL1             | $V_{AX1}$ SR | $0.3 \times V_{DDI}$ | –    | –        | V       | Peak-to-peak voltage <sup>2)</sup> |
| XTAL1 input current                            | $I_{IL}$ CC  | –                    | –    | $\pm 20$ | $\mu A$ | $0 V < V_{IN} < V_{DDI}$           |
| Oscillator frequency                           | $f_{OSC}$ CC | 4                    | –    | 40       | MHz     | Clock signal                       |
|  |              | 4                    | –    | 16       | MHz     | Crystal or Resonator               |
| High time                                      | $t_1$ SR     | 6                    | –    | –        | ns      |                                    |
| Low time                                       | $t_2$ SR     | 6                    | –    | –        | ns      |                                    |
| Rise time                                      | $t_3$ SR     | –                    | 8    | 8        | ns      |                                    |
| Fall time                                      | $t_4$ SR     | –                    | 8    | 8        | ns      |                                    |

1) Overload conditions must not occur on pin XTAL1.

2) The amplitude voltage  $V_{AX1}$  refers to the offset voltage  $V_{OFF}$ . This offset voltage must be stable during the operation and the resulting voltage peaks must remain within the limits defined by  $V_{IX1}$ .





**Figure 20 External Clock Drive XTAL1**

*Note: For crystal/resonator operation, it is strongly recommended to measure the oscillation allowance (negative resistance) in the final target system (layout) to determine the optimum parameters for oscillator operation. Please refer to the limits specified by the crystal/resonator supplier.*

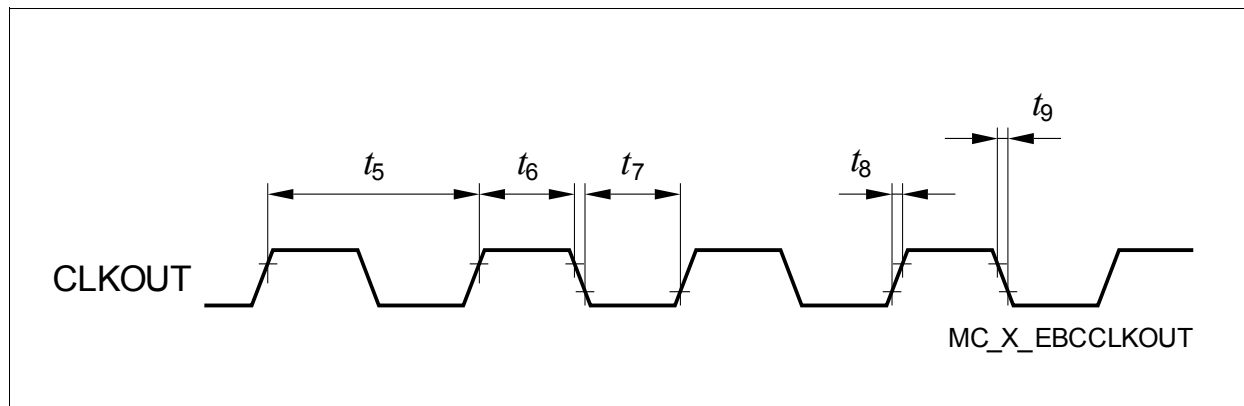
#### 4.6.4 External Bus Timing

The following parameters specify the behavior of the XE164 bus interface.

**Table 27 CLKOUT Reference Signal**

| Parameter         | Symbol |    | Limits                   |      | Unit | Note / Test Condition |
|-------------------|--------|----|--------------------------|------|------|-----------------------|
|                   |        |    | Min.                     | Max. |      |                       |
| CLKOUT cycle time | $t_5$  | CC | 40/25/12.5 <sup>1)</sup> |      | ns   |                       |
| CLKOUT high time  | $t_6$  | CC | 3                        | —    | ns   |                       |
| CLKOUT low time   | $t_7$  | CC | 3                        | —    | ns   |                       |
| CLKOUT rise time  | $t_8$  | CC | —                        | 3    | ns   |                       |
| CLKOUT fall time  | $t_9$  | CC | —                        | 3    | ns   |                       |

1) The CLKOUT cycle time is influenced by the PLL jitter (given values apply to  $f_{SYS} = 25/40/80$  MHz).  
For longer periods the relative deviation decreases (see PLL deviation formula).



**Figure 21 CLKOUT Signal Timing**

*Note: The term CLKOUT refers to the reference clock output signal which is generated by selecting  $f_{SYS}$  as the source signal for the clock output signal EXTCLK on pin P2.8 and by enabling the high-speed clock driver on this pin.*

### Variable Memory Cycles

External bus cycles of the XE164 are executed in five consecutive cycle phases (AB, C, D, E, F). The duration of each cycle phase is programmable (via the TCONCSx registers) to adapt the external bus cycles to the respective external module (memory, peripheral, etc.).

The duration of the access phase can optionally be controlled by the external module using the READY handshake input.

This table provides a summary of the phases and the ranges for their length.

**Table 28 Programmable Bus Cycle Phases (see timing diagrams)**

| Bus Cycle Phase  | Parameter | Valid Values | Unit |
|--|-----------|--------------|------|
| Address setup phase, the standard duration of this phase (1 ... 2 TCS) can be extended by 0 ... 3 TCS if the address window is changed | tpAB      | 1 ... 2 (5)  | TCS  |
| Command delay phase  | tpC       | 0 ... 3      | TCS  |
| Write Data setup/MUX Tristate phase  | tpD       | 0 ... 1      | TCS  |
| Access phase   | tpE       | 1 ... 32     | TCS  |
| Address/Write Data hold phase  | tpF       | 0 ... 3      | TCS  |

*Note: The bandwidth of a parameter (from minimum to maximum value) covers the whole operating range (temperature, voltage) as well as process variations. Within a given device, however, this bandwidth is smaller than the specified range. This is also due to interdependencies between certain parameters. Some of these interdependencies are described in additional notes (see standard timing).*

Timing values are listed in [Table 29](#) and [Table 30](#). The shaded parameters have been verified by characterization. They are not subject to production test.

**Table 29 External Bus Cycle Timing for Upper Voltage Range**  
(Operating Conditions apply)

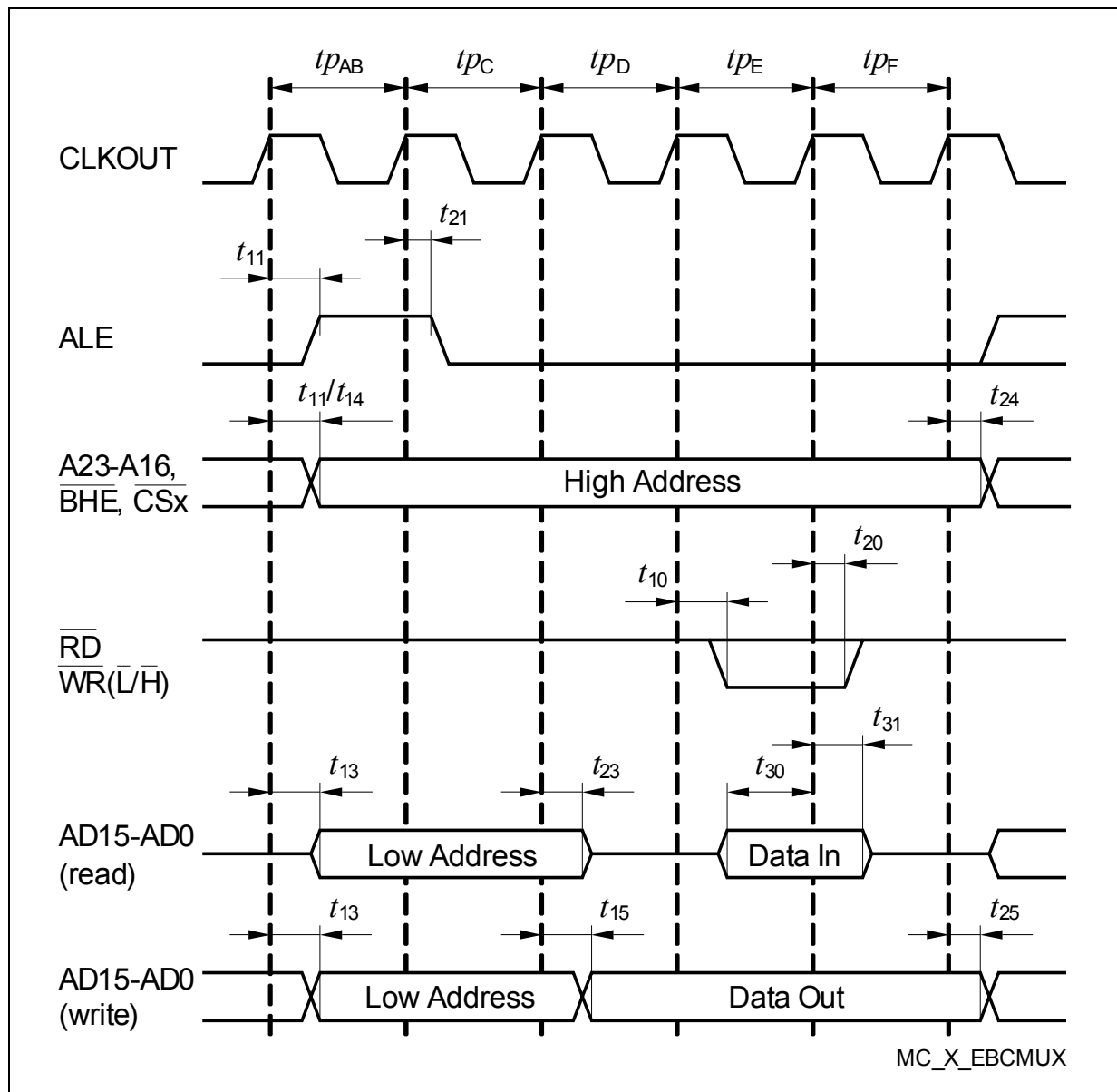
| Parameter   | Symbol      | Limits |      |      | Unit | Note |
|---|-------------|--------|------|------|------|------|
|   |             | Min.   | Typ. | Max. |      |      |
| Output valid delay for:<br>$\overline{\text{RD}}$ , $\overline{\text{WR}}(\text{L}/\text{H})$ | $t_{10}$ CC | –      |      | 13   | ns   |      |
| Output valid delay for:<br>$\overline{\text{BHE}}$ , ALE                                      | $t_{11}$ CC | –      |      | 13   | ns   |      |
| Output valid delay for:<br>A23 ... A16, A15 ... A0 (on P0/P1)                                 | $t_{12}$ CC | –      |      | 14   | ns   |      |
| Output valid delay for:<br>A15 ... A0 (on P2/P10)   | $t_{13}$ CC | –      |      | 14   | ns   |      |
| Output valid delay for:<br>$\overline{\text{CS}}$   | $t_{14}$ CC | –      |      | 13   | ns   |      |
| Output valid delay for:<br>D15 ... D0 (write data, MUX-mode)                                  | $t_{15}$ CC | –      |      | 14   | ns   |      |
| Output valid delay for:<br>D15 ... D0 (write data, DEMUX-mode)                                | $t_{16}$ CC | –      |      | 14   | ns   |      |
| Output hold time for:<br>$\overline{\text{RD}}$ , $\overline{\text{WR}}(\text{L}/\text{H})$   | $t_{20}$ CC | 0      |      | 8    | ns   |      |
| Output hold time for:<br>$\overline{\text{BHE}}$ , ALE  | $t_{21}$ CC | 0      |      | 8    | ns   |      |
| Output hold time for:<br>A23 ... A16, A15 ... A0 (on P2/P10)                                  | $t_{23}$ CC | 0      |      | 8    | ns   |      |
| Output hold time for:<br>$\overline{\text{CS}}$   | $t_{24}$ CC | 0      |      | 8    | ns   |      |
| Output hold time for:<br>D15 ... D0 (write data)  | $t_{25}$ CC | 0      |      | 8    | ns   |      |
| Input setup time for:<br>READY, D15 ... D0 (read data)  | $t_{30}$ SR | 18     |      | –    | ns   |      |
| Input hold time for:<br>READY, D15 ... D0 (read data) <sup>1)</sup>                           | $t_{31}$ SR | -4     |      | –    | ns   |      |

1) Read data are latched with the same internal clock edge that triggers the address change and the rising edge of  $\overline{\text{RD}}$ . Address changes before the end of  $\overline{\text{RD}}$  have no impact on (demultiplexed) read cycles. Read data can change after the rising edge of  $\overline{\text{RD}}$ .

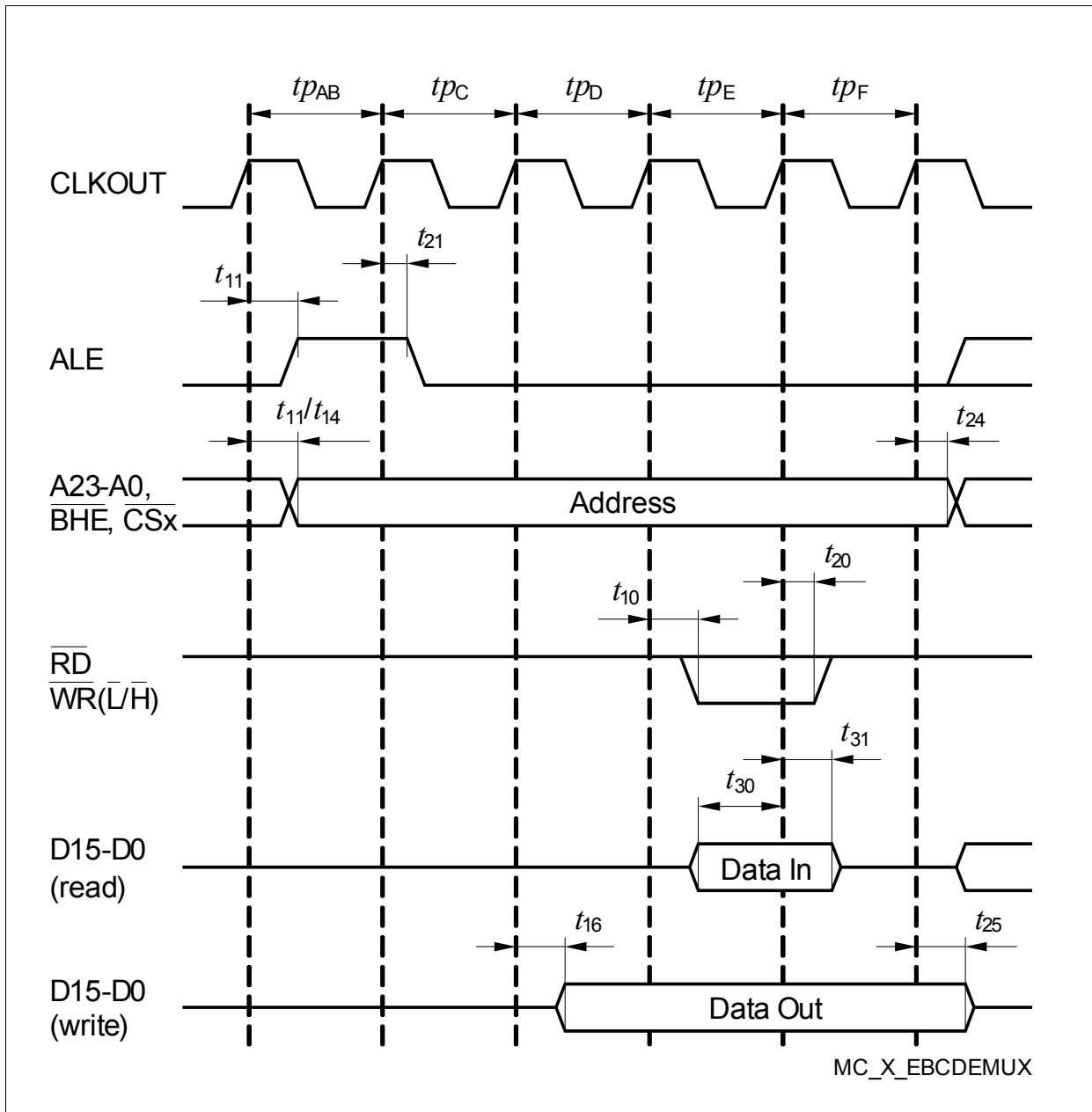
**Table 30 External Bus Cycle Timing for Lower Voltage Range  
(Operating Conditions apply)**

| Parameter   | Symbol      | Limits |      |      | Unit | Note |
|---|-------------|--------|------|------|------|------|
|   |             | Min.   | Typ. | Max. |      |      |
| Output valid delay for:<br>$\overline{\text{RD}}$ , $\overline{\text{WR}}(\overline{\text{L}}/\overline{\text{H}})$ | $t_{10}$ CC | –      |      | 20   | ns   |      |
| Output valid delay for:<br>$\overline{\text{BHE}}$ , ALE  | $t_{11}$ CC | –      |      | 20   | ns   |      |
| Output valid delay for:<br>A23 ... A16, A15 ... A0 (on P0/P1)   | $t_{12}$ CC | –      |      | 22   | ns   |      |
| Output valid delay for:<br>A15 ... A0 (on P2/P10)   | $t_{13}$ CC | –      |      | 22   | ns   |      |
| Output valid delay for:<br>$\overline{\text{CS}}$   | $t_{14}$ CC | –      |      | 20   | ns   |      |
| Output valid delay for:<br>D15 ... D0 (write data, MUX-mode)  | $t_{15}$ CC | –      |      | 21   | ns   |      |
| Output valid delay for:<br>D15 ... D0 (write data, DEMUX-mode)  | $t_{16}$ CC | –      |      | 21   | ns   |      |
| Output hold time for:<br>$\overline{\text{RD}}$ , $\overline{\text{WR}}(\overline{\text{L}}/\overline{\text{H}})$   | $t_{20}$ CC | 0      |      | 10   | ns   |      |
| Output hold time for:<br>$\overline{\text{BHE}}$ , ALE  | $t_{21}$ CC | 0      |      | 10   | ns   |      |
| Output hold time for:<br>A23 ... A16, A15 ... A0 (on P2/P10)  | $t_{23}$ CC | 0      |      | 10   | ns   |      |
| Output hold time for:<br>$\overline{\text{CS}}$   | $t_{24}$ CC | 0      |      | 10   | ns   |      |
| Output hold time for:<br>D15 ... D0 (write data)  | $t_{25}$ CC | 0      |      | 10   | ns   |      |
| Input setup time for:<br>READY, D15 ... D0 (read data)  | $t_{30}$ SR | 29     |      | –    | ns   |      |
| Input hold time for:<br>READY, D15 ... D0 (read data) <sup>1)</sup>   | $t_{31}$ SR | -6     |      | –    | ns   |      |

1) Read data are latched with the same internal clock edge that triggers the address change and the rising edge of  $\overline{\text{RD}}$ . Address changes before the end of  $\overline{\text{RD}}$  have no impact on (demultiplexed) read cycles. Read data can change after the rising edge of  $\overline{\text{RD}}$ .



**Figure 22 Multiplexed Bus Cycle**



**Figure 23 Demultiplexed Bus Cycle**

**Bus Cycle Control with the READY Input**

The duration of an external bus cycle can be controlled by the external circuit using the READY input signal. The polarity of this input signal can be selected.

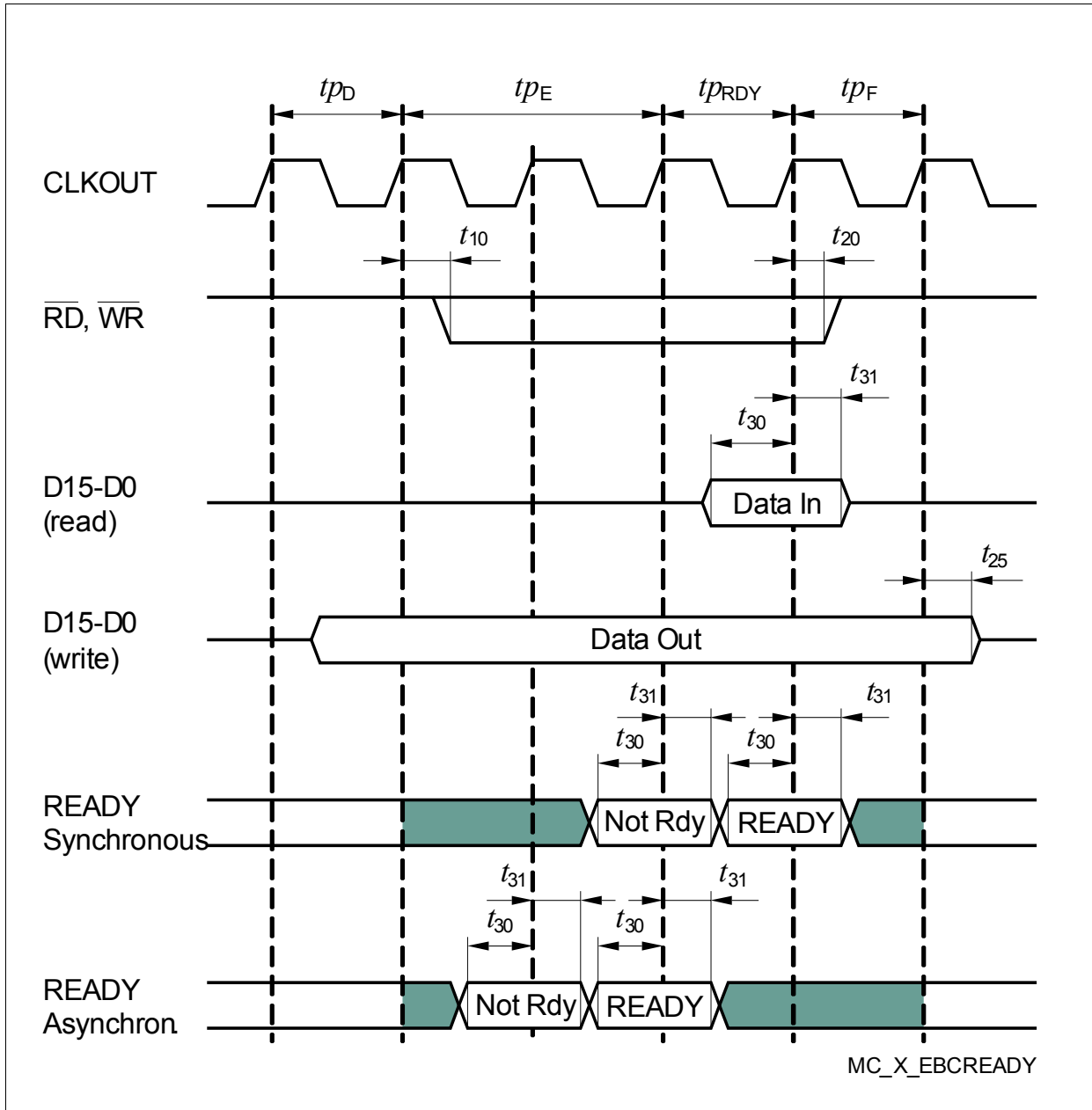
Synchronous READY permits the shortest possible bus cycle but requires the input signal to be synchronous to the reference signal CLKOUT.

An asynchronous READY signal puts no timing constraints on the input signal but incurs a minimum of one waitstate due to the additional synchronization stage. The minimum duration of an asynchronous READY signal for safe synchronization is one CLKOUT period plus the input setup time.

An active READY signal can be deactivated in response to the trailing (rising) edge of the corresponding command ( $\overline{RD}$  or  $\overline{WR}$ ).

If the next bus cycle is controlled by READY, an active READY signal must be disabled before the first valid sample point in the next bus cycle. This sample point depends on the programmed phases of the next cycle.





**Figure 24**    **READY Timing**

*Note: If the READY input is sampled inactive at the indicated sampling point ("Not Rdy") a READY-controlled waitstate is inserted ( $tp_{RDY}$ ), sampling the READY input active at the indicated sampling point ("Ready") terminates the currently running bus cycle.*

*Note the different sampling points for synchronous and asynchronous READY. This example uses one mandatory waitstate (see  $tp_E$ ) before the READY input value is used.*

## 4.6.5 Synchronous Serial Interface Timing

The following parameters are applicable for a USIC channel operated in SSC mode.

*Note: These parameters are not subject to production test but verified by design and/or characterization.*

**Table 31 SSC Master/Slave Mode Timing for Upper Voltage Range**  
(Operating Conditions apply),  $C_L = 50 \text{ pF}$

| Parameter   | Symbol      | Values                      |      |      | Unit | Note / Test Condition |
|---|-------------|-----------------------------|------|------|------|-----------------------|
|   |             | Min.                        | Typ. | Max. |      |                       |
| Master Mode Timing  |             |                             |      |      |      |                       |
| Slave select output SELO active to first SCLKOUT transmit edge    | $t_1$ CC    | 0                           | —    | 1)   | ns   | 2)                    |
| Slave select output SELO inactive after last SCLKOUT receive edge | $t_2$ CC    | $0.5 \times t_{\text{BIT}}$ | —    | 3)   | ns   |                       |
| Transmit data output valid time                                   | $t_3$ CC    | -6                          | —    | 13   | ns   |                       |
| Receive data input setup time to SCLKOUT receive edge             | $t_4$ SR    | 31                          | —    | —    | ns   |                       |
| Data input DX0 hold time from SCLKOUT receive edge                | $t_5$ SR    | -7                          | —    | —    | ns   |                       |
| Slave Mode Timing   |             |                             |      |      |      |                       |
| Select input DX2 setup to first clock input DX1 transmit edge     | $t_{10}$ SR | 7                           | —    | —    | ns   | 4)                    |
| Select input DX2 hold after last clock input DX1 receive edge     | $t_{11}$ SR | 5                           | —    | —    | ns   | 4)                    |
| Data input DX0 setup time to clock input DX1 receive edge         | $t_{12}$ SR | 7                           | —    | —    | ns   | 4)                    |
| Data input DX0 hold time from clock input DX1 receive edge        | $t_{13}$ SR | 5                           | —    | —    | ns   | 4)                    |
| Data output DOUT valid time                                       | $t_{14}$ CC | 8                           | —    | 29   | ns   | 4)                    |

1) The maximum value further depends on the settings for the slave select output leading delay.

2)  $t_{\text{SYS}} = 1/f_{\text{SYS}}$  (= 12.5ns @ 80 MHz)

3) The maximum value depends on the settings for the slave select output trailing delay and for the shift clock output delay.

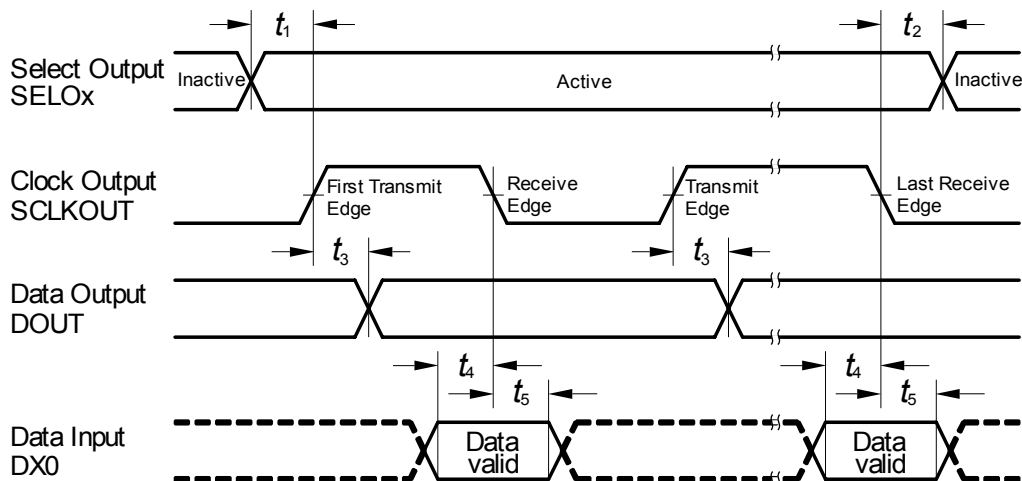
4) These input timings are valid for asynchronous input signal handling of slave select input, shift clock input, and receive data input (bits DXnCR.DSEN = 0).

**Table 32 SSC Master/Slave Mode Timing for Lower Voltage Range**  
(Operating Conditions apply),  $C_L = 50 \text{ pF}$

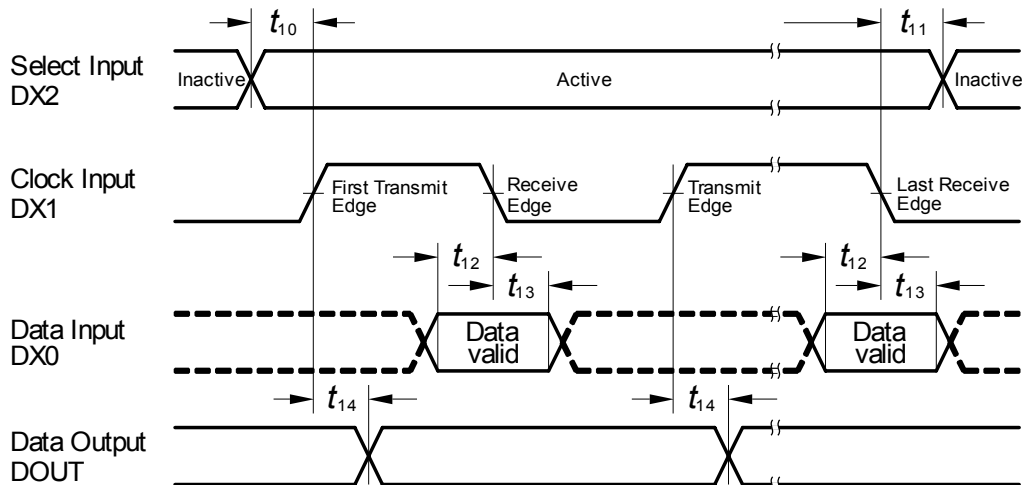
| Parameter   | Symbol      | Values                      |      |      | Unit | Note / Test Condition |
|---|-------------|-----------------------------|------|------|------|-----------------------|
|   |             | Min.                        | Typ. | Max. |      |                       |
| Master Mode Timing  |             |                             |      |      |      |                       |
| Slave select output SELO active to first SCLKOUT transmit edge    | $t_1$ CC    | 0                           | —    | 1)   | ns   | 2)                    |
| Slave select output SELO inactive after last SCLKOUT receive edge | $t_2$ CC    | $0.5 \times t_{\text{BIT}}$ | —    | 3)   | ns   | 2)                    |
| Transmit data output valid time                                   | $t_3$ CC    | -13                         | —    | 16   | ns   |                       |
| Receive data input setup time to SCLKOUT receive edge             | $t_4$ SR    | 48                          | —    | —    | ns   |                       |
| Data input DX0 hold time from SCLKOUT receive edge                | $t_5$ SR    | -11                         | —    | —    | ns   |                       |
| Slave Mode Timing   |             |                             |      |      |      |                       |
| Select input DX2 setup to first clock input DX1 transmit edge     | $t_{10}$ SR | 12                          | —    | —    | ns   | 4)                    |
| Select input DX2 hold after last clock input DX1 receive edge     | $t_{11}$ SR | 8                           | —    | —    | ns   | 4)                    |
| Data input DX0 setup time to clock input DX1 receive edge         | $t_{12}$ SR | 12                          | —    | —    | ns   | 4)                    |
| Data input DX0 hold time from clock input DX1 receive edge        | $t_{13}$ SR | 8                           | —    | —    | ns   | 4)                    |
| Data output DOUT valid time                                       | $t_{14}$ CC | 11                          | —    | 44   | ns   | 4)                    |

- 1) The maximum value further depends on the settings for the slave select output leading delay.
- 2)  $t_{\text{SYS}} = 1/f_{\text{SYS}} (= 12.5 \text{ ns @ } 80 \text{ MHz})$
- 3) The maximum value depends on the settings for the slave select output trailing delay and for the shift clock output delay.
- 4) These input timings are valid for asynchronous input signal handling of slave select input, shift clock input, and receive data input (bits DXnCR.DSEN = 0).

### Master Mode Timing



### Slave Mode Timing



Transmit Edge: with this clock edge transmit data is shifted to transmit data output

Receive Edge: with this clock edge receive data at receive data input is latched

Drawn for BRGH.SCLKCFG = 00<sub>B</sub>. Also valid for for SCLKCFG = 01<sub>B</sub> with inverted SCLKOUT signal

USIC\_SSC\_TMGX.VSD

**Figure 25 USIC - SSC Master/Slave Mode Timing**

*Note: This timing diagram shows a standard configuration where the slave select signal is low-active and the serial clock signal is not shifted and not inverted.*

### 4.6.6 JTAG Interface Timing

The following parameters are applicable for communication through the JTAG debug interface. The JTAG module is fully compliant with IEEE1149.1-2000.

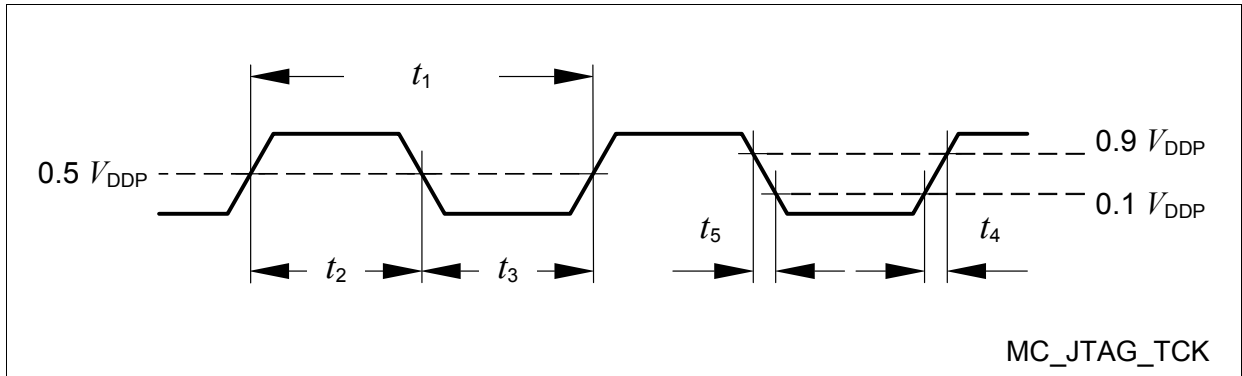
*Note: These parameters are not subject to production test but verified by design and/or characterization.*

**Table 33 JTAG Interface Timing Parameters**  
(Operating Conditions apply)

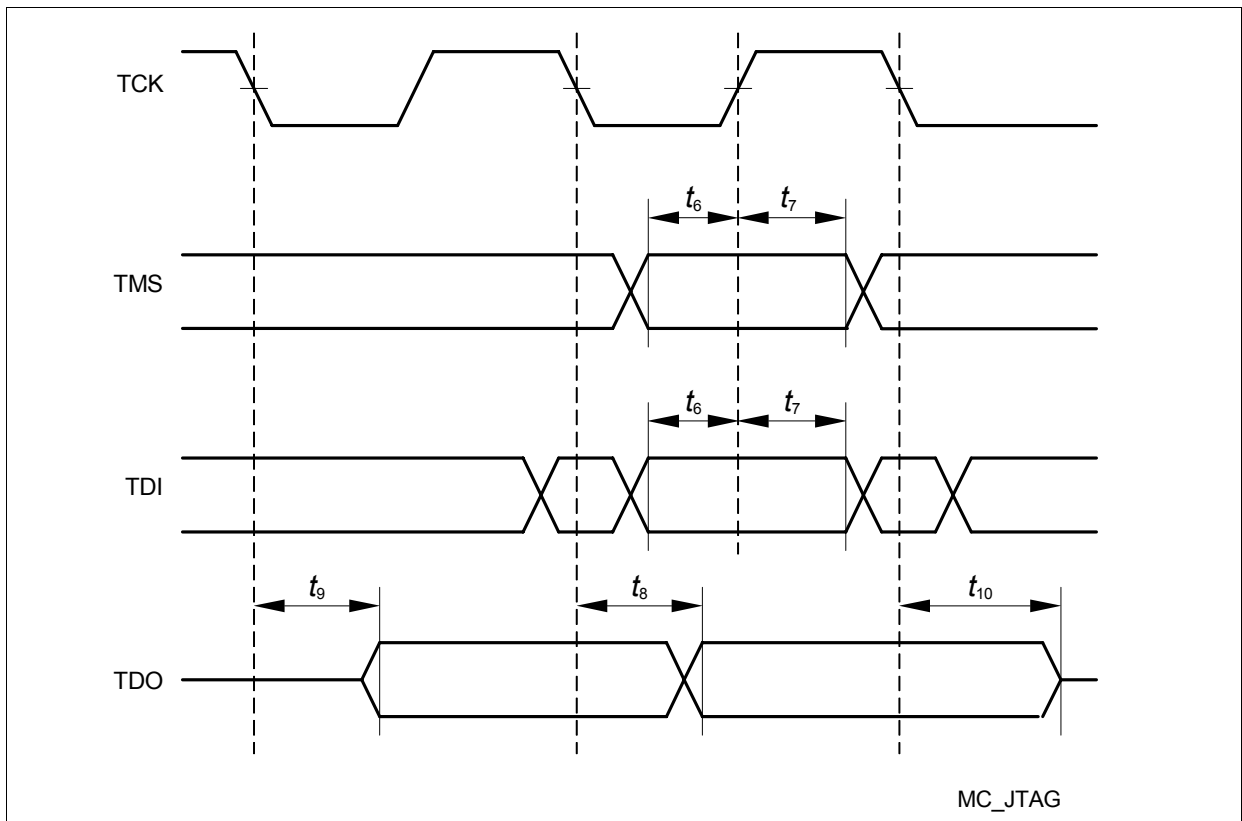
| Parameter  | Symbol      | Values |      |      | Unit | Note / Test Condition |
|--|-------------|--------|------|------|------|-----------------------|
|  |             | Min.   | Typ. | Max. |      |                       |
| TCK clock period   | $t_1$ SR    | 60     | 50   | —    | ns   | —                     |
| TCK high time  | $t_2$ SR    | 16     | —    | —    | ns   | —                     |
| TCK low time   | $t_3$ SR    | 16     | —    | —    | ns   | —                     |
| TCK clock rise time  | $t_4$ SR    | —      | —    | 8    | ns   | —                     |
| TCK clock fall time  | $t_5$ SR    | —      | —    | 8    | ns   | —                     |
| TDI/TMS setup to TCK rising edge                               | $t_6$ SR    | 6      | —    | —    | ns   | —                     |
| TDI/TMS hold after TCK rising edge                             | $t_7$ SR    | 6      | —    | —    | ns   | —                     |
| TDO valid after TCK falling edge <sup>1)</sup>                 | $t_8$ CC    | —      | —    | 30   | ns   | $C_L = 50$ pF         |
|  | $t_8$ CC    | 10     | —    | —    | ns   | $C_L = 20$ pF         |
| TDO high imped. to valid from TCK falling edge <sup>1)2)</sup> | $t_9$ CC    | —      | —    | 30   | ns   | $C_L = 50$ pF         |
| TDO valid to high imped. from TCK falling edge <sup>1)</sup>   | $t_{10}$ CC | —      | —    | 30   | ns   | $C_L = 50$ pF         |

1) The falling edge on TCK is used to generate the TDO timing.

2) The setup time for TDO is given implicitly by the TCK cycle time.



**Figure 26 Test Clock Timing (TCK)**



**Figure 27 JTAG Timing**

## 5 Package and Reliability

In addition to the electrical parameters, the following specifications ensure proper integration of the XE164 into the target system.

### 5.1 Packaging

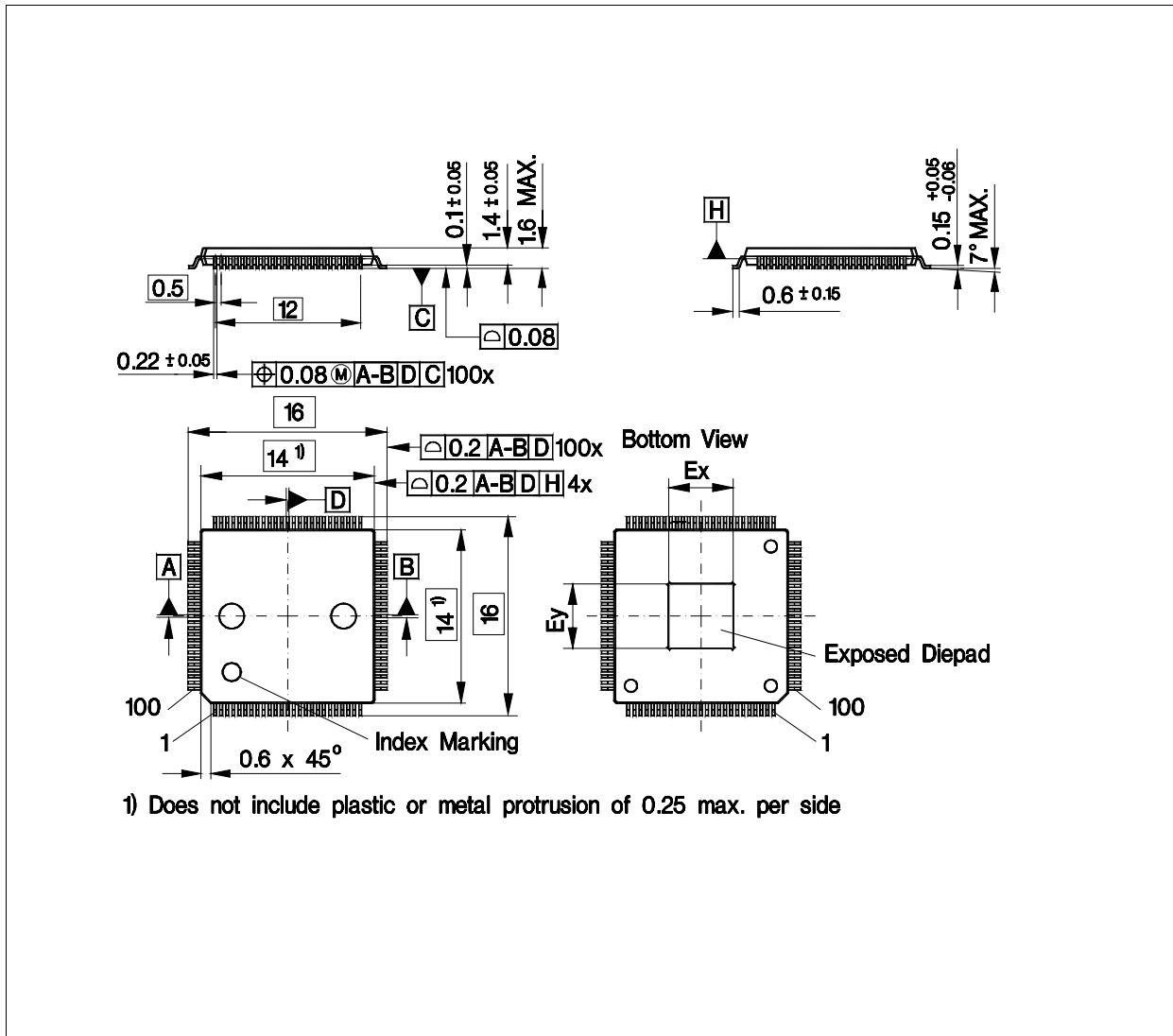
These parameters specify the packaging rather than the silicon.

**Table 34 Package Parameters (PG-LQFP-100-3)**

| Parameter                              | Symbol           | Limit Values |                  | Unit | Notes                         |
|--|------------------|--------------|------------------|------|-------------------------------|
|  |                  | Min.         | Max.             |      |                               |
| Exposed Pad Dimension                  | $E_x \times E_y$ | –            | $6.2 \times 6.2$ | mm   | –                             |
| Power Dissipation                      | $P_{DISS}$       | –            | 1.0              | W    | –                             |
| Thermal resistance<br>Junction-Ambient | $R_{\Theta JA}$  | –            | 49               | K/W  | No thermal via <sup>1)</sup>  |
|  |                  |              | 37               | K/W  | 4-layer, no pad <sup>2)</sup> |
|  |                  |              | 22               | K/W  | 4-layer, pad <sup>3)</sup>    |

- 1) Device mounted on a 2-layer JEDEC board (according to JESD 51-3) or a 4-layer board without thermal vias; exposed pad not soldered.
- 2) Device mounted on a 4-layer JEDEC board (according to JESD 51-7) with thermal vias; exposed pad not soldered.
- 3) Device mounted on a 4-layer JEDEC board (according to JESD 51-7) with thermal vias; exposed pad soldered to the board.

## Package Outlines



**Figure 28 PG-LQFP-100-3 (Plastic Green Thin Quad Flat Package)**

All dimensions in mm.

You can find complete information about Infineon packages, packing and marking in our Infineon Internet Page "Packages": <http://www.infineon.com/packages>



## 5.2 Thermal Considerations

When operating the XE164 in a system, the total heat generated in the chip must be dissipated to the ambient environment to prevent overheating and the resulting thermal damage.

The maximum heat that can be dissipated depends on the package and its integration into the target board. The “Thermal resistance  $R_{\Theta JA}$ ” quantifies these parameters. The power dissipation must be limited so that the average junction temperature does not exceed 125 °C.

The difference between junction temperature and ambient temperature is determined by  $\Delta T = (P_{INT} + P_{IOSTAT} + P_{IODYN}) \times R_{\Theta JA}$

The internal power consumption is defined as

$$P_{INT} = V_{DDP} \times I_{DDP} \text{ (see [Section 4.2.3](#)).$$

The static external power consumption caused by the output drivers is defined as

$$P_{IOSTAT} = \Sigma((V_{DDP} - V_{OH}) \times I_{OH}) + \Sigma(V_{OL} \times I_{OL})$$

The dynamic external power consumption caused by the output drivers ( $P_{IODYN}$ ) depends on the capacitive load connected to the respective pins and their switching frequencies.

If the total power dissipation for a given system configuration exceeds the defined limit, countermeasures must be taken to ensure proper system operation:

- Reduce  $V_{DDP}$ , if possible in the system
- Reduce the system frequency
- Reduce the number of output pins
- Reduce the load on active output drivers

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